

LMK04832-SP Space Grade Ultra-Low-Noise JESD204B Dual-Loop Clock Jitter Cleaner

1 Features

- SMD #5962R1723701VXC
 - Total ionizing dose 100 krad (ELDRS-free)
 - SEL immune >120 MeV × cm²/mg
 - SEFI immune >120 MeV × cm²/mg
- Maximum clock output frequency: 3255 MHz
- Multi-mode: dual PLL, single PLL, and clock distribution
- 6-GHz external VCO or distribution input
- Ultra-low noise, at 2500 MHz:
 - 54-fs RMS jitter (12 kHz to 20 MHz)
 - 64-fs RMS jitter (100 Hz to 20 MHz)
 - 157.6-dBc/Hz noise floor
- Ultra-low noise, at 3200 MHz:
 - 61-fs RMS jitter (12 kHz to 20 MHz)
 - 67-fs RMS jitter (100 Hz to 100 MHz)
 - 156.5-dBc/Hz noise floor
- PLL₂
 - PLL FOM of -230 dBc/Hz
 - PLL 1/f of –128 dBc/Hz
 - Phase detector rate up to 320 MHz
 - Two integrated VCOs: 2440 to 2600 MHz and 2945 to 3255 MHz
- Up to 14 differential device clocks
 - CML, LVPECL, LCPECL, HSDS, LVDS, and 2xLVCMOS programmable outputs
- Up to 1 buffered VCXO/XO output
 - LVPECL, LVDS, 2xLVCMOS programmable
- 1-1023 CLKout divider
- 1-8191 SYSREF divider
- 25-ps step analog delay for SYSREF clocks
- Digital delay and dynamic digital delay for device clock and SYSREF
- Holdover mode with PLL1
- 0-delay with PLL1 or PLL2
- Ambient temperature range: -55 °C to 125 °C

2 Applications

- Communications payloads
- Radar imaging payload
- Command and data handling

3 Description

The LMK04832-SP is a high performance clock conditioner with JEDEC JESD204B support for space applications.

The 14 clock outputs from PLL2 can be configured to drive seven JESD204B converters or other logic devices using device and SYSREF clocks. SYSREF can be provided using both DC and AC coupling. Not limited to JESD204B applications, each of the 14 outputs can be individually configured as highperformance outputs for traditional clocking systems.

The LMK04832-SP can be configured for operation in dual PLL, single PLL, or clock distribution modes with or without SYSREF generation or reclocking. PLL2 may operate with either internal or external VCO.

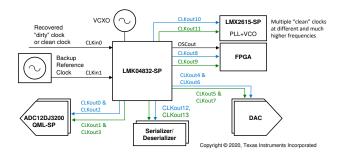
The high performance combined with features like the ability to trade off between power and performance, dual VCOs, dynamic digital delay, and holdover allows LMK04832-SP to provide performance clocking trees.

The LMK04832-SP comes in a 10.9-mm × 10.9-mm, 64-pin CFP package.

Device Information

| PART NUMBER | TYPE | PACKAGE ⁽¹⁾ |
|-----------------|------------------------------------|-----------------------------|
| SN0064HBE | Mechanical Sample ⁽²⁾ | 64-pin ceramic |
| LMK04832W/EM | Engineering Samples ⁽³⁾ | with non- conductive tie |
| 5962R1723701VXC | Radiation Hardness Assured | bar (HBE0064B) |

- For all available packages, see the orderable addendum at the end of the data sheet.
- These units are package only and contain no die; they are meant for evaluation purposes only
- These units are not suitable for production or flight use; they (3) are intended for engineering evaluation only.



Simplified Schematic



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4 Revision History

| С | hanges from Revision A (August 2020) to Revision B (December 2020) | Page |
|---|-----------------------------------------------------------------------------------------------------|------|
| • | Changed device status from Advanced Information to Production Data | 1 |
| С | hanges from Revision * (March 2017) to Revision A (August 2020) | Page |
| _ | I had stad the according forward for tables figures and areas references throughout the description | 4 |
| • | Updated the numbering format for tables, figures, and cross-references throughout the document | 1 |



5 Pin Configuration and Functions

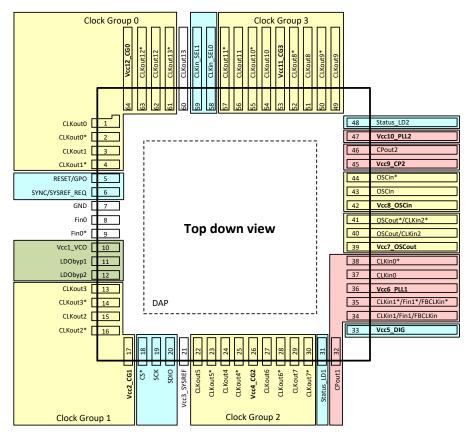


Figure 5-1. HBD CFP Package 64-Pin CFP Top View

Pin Functions

| | PIN | | TYPE | DESCRIPTION | | | |
|------|---------------------|-----|--------------|-----------------------------------------------------------------------------------------------------------|--|--|--|
| NO. | NAME | I/O | ITPE | DESCRIPTION | | | |
| 1 | CLKout0 | 0 | Programmable | Clock output 0. For JESD204B systems suggest Device Clock. (2) | | | |
| 2 | CLKout0* | | Fiogrammable | Programmable formats: CML, LVPECL, LCPECL, or LVDS. | | | |
| 3 | CLKout1 | 0 | Dragrammahla | Clock output 1. For JESD204B systems suggest SYSREF Clock.(2) | | | |
| 4 | CLKout1* | | Programmable | Programmable formats: CML, LVPECL, LCPECL, LVDS, or 2xLVCMOS. | | | |
| 5 | RESET/GPO | I | CMOS | Device reset input or GPO | | | |
| 6 | SYNC/ SYSREF_REQ | ı | CMOS | Synchronization input or SYSREF_REQ for requesting continuous SYSREF. | | | |
| 7 | GND | _ | GND | This pin should be grounded. | | | |
| 8, 9 | Fin0/Fin0* | ı | ANLG | High-speed input for external VCO or clock distribution. Supports /2 for frequency greater than 3250 MHz. | | | |
| 10 | Vcc1_VCO | _ | PWR | Power supply for VCO and clock distribution. | | | |
| 11 | LDObyp1 | _ | ANLG | LDO Bypass, bypassed to ground with 10-µF capacitor. | | | |
| 12 | LDObyp2 | _ | ANLG | LDO Bypass, bypassed to ground with a 0.1-µF capacitor. | | | |
| 13 | CLKout3 | 0 | Dragrammahla | Clock output 3. For JESD204B systems suggest SYSREF Clock.(2) | | | |
| 14 | CLKout3* | | Programmable | Programmable formats: CML, LVPECL, LCPECL, LVDS, or 2xLVCMOS. | | | |
| 15 | CLKout2 | 0 | Drogrammable | Clock output 2. For JESD204B systems suggest Device Clock. ⁽²⁾ | | | |
| 16 | CLKout2* | | Programmable | Programmable formats: CML, LVPECL, LCPECL, or LVDS. | | | |
| 17 | Vcc2_CG1 | _ | PWR | Power supply for clock outputs 2 and 3. | | | |



| | PIN | | | | | |
|-------------------|-------------|-------|---------------|-------------------------------------------------------------------------------------------------------------------------------|--|--|
| NO. | NAME | · I/O | TYPE | DESCRIPTION | | |
| 18 | CS* | ı | CMOS | Chip Select | | |
| 19 | SCK | ı | CMOS | SPI Clock | | |
| 20 | SDIO | I/O | CMOS | SPI Data | | |
| 21 | Vcc3_SYSREF | _ | PWR | Power supply for SYSREF divider and SYNC. | | |
| 22 | CLKout5 | _ | | Clock output 5. For JESD204B systems suggest SYSREF Clock. ⁽²⁾ | | |
| 23 | CLKout5* | 0 | Programmable | Programmable formats: CML, LVPECL, LCPECL, LVDS, or 2xLVCMOS. | | |
| 24 | CLKout4 | _ | | Clock output 4. For JESD204B systems suggest Device Clock. (2) | | |
| 25 | CLKout4* | 0 | Programmable | Programmable formats: CML, LVPECL, LCPECL, or LVDS. | | |
| 26 | Vcc4_CG2 | _ | PWR | Power supply for clock outputs 4, 5, 6 and 7. | | |
| 27 | CLKout6 | | | Clock output 6. For JESD204B systems suggest Device Clock. (2) | | |
| 28 | CLKout6* | 0 | Programmable | Programmable formats: CML, LVPECL, LCPECL, or LVDS. | | |
| 29 | CLKout7 | | | Clock output 7. For JESD204B systems suggest SYSREF Clock. (2) | | |
| 30 | CLKout7* | 0 | Programmable | Programmable formats: CML, LVPECL, LCPECL, LVDS, or 2xLVCMOS. | | |
| 31 | Status_LD1 | I/O | Programmable | Programmable status pin. | | |
| 32 | CPout1 | 0 | ANLG | Charge pump 1 output. | | |
| 33 | Vcc5 DIG | _ | PWR | Power supply for the digital circuitry. | | |
| | CLKin1 | | | Reference Clock Input Port 1 for PLL1. | | |
| 34 | FBCLKin | - | ANLG | Feedback input for external clock feedback input (0–delay mode). | | |
| | Fin1 | | | External VCO Input or clock distribution input. | | |
| | CLKin1* | | | Reference Clock Input Port 1 for PLL1. | | |
| 35 | | 1 | ANLG | Feedback input for external clock feedback input (0–delay mode). | | |
| 35 FBCLKin* Fin1* | | 1 | ANLO | | | |
| 36 | Vcc6_PLL1 | _ | PWR | External VCO Input or clock distribution input. Power supply for PLL1, charge pump 1, holdover DAC | | |
| 37 | CLKin0 | | | Torrest cappy for the EET, orange partiple, floration Brice | | |
| 38 | CLKin0* | - 1 | ANLG | Reference Clock Input Port 0 for PLL1. | | |
| 39 | Vcc7_OSCout | _ | PWR | Power supply for OSCout port. | | |
| | OSCout | | | Buffered output of OSCin port. | | |
| 40 | CLKin2 | I/O | Programmable | Reference Clock Input Port 2 for PLL1. | | |
| | OSCout* | | | Buffered output of OSCin port. | | |
| 41 | CLKin2* | I/O | Programmable | Reference Clock Input Port 2 for PLL1. | | |
| 42 | Vcc8_OSCin | _ | PWR | Power supply for OSCin | | |
| 43 | OSCin | | | i one cappy to coom | | |
| 44 | OSCin* | - 1 | ANLG | Feedback to PLL1 and reference input to PLL2. AC-coupled. | | |
| 45 | Vcc9_CP2 | _ | PWR | Power supply for PLL2 Charge Pump. | | |
| 46 | CPout2 | 0 | ANLG | Charge pump 2 output. | | |
| 47 | Vcc10_PLL2 | | PWR | Power supply for PLL2. | | |
| 48 | Status_LD2 | I/O | Programmable | Programmable status pin. | | |
| 49 | CLKout9 | ",0 | 1 Togrammable | | | |
| 50 | CLKout9* | 0 | Programmable | | | |
| 51 | CLKout8 | | | Programmable formats: CML, LVPECL, LCPECL, LVDS, or 2xLVCMOS. | | |
| 52 | CLKout8* | 0 | Programmable | Programmable formats: CML, LVPECL, LCPECL, LVDS, or 2xLVCMOS. Clock output 8, For JESD204B systems suggest Device Clock (2) | | |
| 53 | Vcc11_CG3 | _ | PWR | Programmable formats: CML, LVPECL, LCPECL, LVDS, or 2xLVCMOS. Power supply for clock outputs 8, 9, 10, and 11. | | |
| 54 | CLKout10 | _ | I VVIX | | | |
| | CLKout10* | 0 | Programmable | Clock output 10. For JESD204B systems suggest Device Clock. (2) Programmable formats: CML, LVPECL, LCPECL, LVDS, or 2xLVCMOS. | | |
| 55 | CLROULIU | | | | | |



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| | PIN | I/O | TYPE | DESCRIPTION | | |
|-----|------------|----------------|---------------------------------------|----------------------------------------------------------------------------|--|--|
| NO. | NAME | "0 | ITPE | DESCRIPTION | | |
| 56 | CLKout11 | 0 | Programmable | Clock output 11. For JESD204B systems suggest SYSREF Clock. (2) | | |
| 57 | CLKout11* | | Programmable | Programmable formats: CML, LVPECL, LCPECL, LVDS, or 2xLVCMOS. | | |
| 58 | CLKin_SEL0 | I/O | Programmable | Programmable status pin. | | |
| 59 | CLKin_SEL1 | I/O | Programmable Programmable status pin. | | | |
| 60 | CLKout13 | O Programmable | 0 Day was a black | Clock output 13. For JESD204B systems suggest SYSREF Clock. (2) | | |
| 61 | CLKout13* | | Programmable | Programmable formats: CML, LVPECL, LCPECL, LVDS, or 2xLVCMOS. | | |
| 62 | CLKout12 | 0 | Drogrammable | Clock output 12. For JESD204B systems suggest Device Clock. ⁽²⁾ | | |
| 63 | CLKout12* | | Programmable | Programmable formats: CML, LVPECL, LCPECL, or LVDS. | | |
| 64 | Vcc12_CG0 | _ | PWR | PWR Power supply for clock outputs 0, 1, 12, and 13. | | |
| DAP | DAP | _ | GND | DIE ATTACH PAD, connect to GND. ⁽¹⁾ | | |

- (1) The metal lid is internally grounded and attached to the DAP.
- (2) Actual best allocation of device clocks and SYSREF depends upon frequency planning to group common frequencies.



6 Specifications

6.1 Absolute Maximum Ratings

over operating free-air temperature range (unless otherwise noted)(1)

| SYMBOL | PARAMETER | MIN | MAX | UNIT |
|--------------------|----------------------------------------------------------|------|-----------------------|------|
| $V_{DD,}V_{DD_A}$ | Power supply voltage | -0.3 | 3.6 | V |
| V _{IN} | Input voltage | GND | V _{DD} + 0.3 | V |
| I _{IN} | Differential input current (CLKinX/X*, OSCin/OSCin*,Fin) | | 5 | mA |
| T _J | Junction Temperature | | 150 | °C |
| T _{stg} | Storage temperature | -65 | 150 | °C |

⁽¹⁾ Stresses beyond those listed under Absolute Maximum Rating may cause permanent damage to the device. These are stress ratings only, which do not imply functional operation of the device at these or any other conditions beyond those indicated under Recommended Operating Condition. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

6.2 ESD Ratings

| SYMBOL | PARAMETER | CONDITION | VALUE | UNIT |
|--------------------|---------------------------|------------------------------------------------------------------------------------------|-------|------|
| V | N. Flackastatis disabases | Human body model (HBM), per ANSI/ESDA/JEDEC JS-001, all pins ⁽¹⁾ | ±2000 | |
| V _(ESD) | Electrostatic discharge | Charged device model (CDM), per JEDEC specification JESD22-C101, all pins ⁽²⁾ | ±250 | V |

- (1) JEDEC document JEP155 states that 500-V HBM allows safe manufacturing with a standard ESD control process.
- (2) JEDEC document JEP157 states that 250-V CDM allows safe manufacturing with a standard ESD control process.

6.3 Recommended Operating Conditions

over case temperature range (unless otherwise noted)

| SYMBOL | PARAMETER | MIN | NOM | MAX | UNIT |
|-------------------|---------------------|-------|-----|-------|------|
| V_{DD} | IO supply voltage | 3.135 | 3.3 | 3.465 | V |
| V _{DD_A} | Core supply voltage | 3.135 | 3.3 | 3.465 | V |
| T _A | Ambient Temperature | -55 | | 125 | °C |

6.4 Thermal Information

| | | LMK04832-SP | |
|----------------------|----------------------------------------------|-----------------|------|
| SYMBOL | THERMAL METRIC(1) | Ceramic Package | UNIT |
| | | 64 Pins | |
| $R_{\theta JA}$ | Junction-to-ambient thermal resistance | 21.8 | °C/W |
| $R_{\theta JC(top)}$ | Junction-to-case (top) thermal resistance | 6.7 | °C/W |
| $R_{\theta JB}$ | Junction-to-board thermal resistance | 7.4 | °C/W |
| Ψ_{JT} | Junction-to-top characterization parameter | 1.3 | °C/W |
| Ψ_{JB} | Junction-to-board characterization parameter | 7.1 | °C/W |
| $R_{\theta JC(bot)}$ | Junction-to-case (bottom) thermal resistance | 0.5 | °C/W |

⁽¹⁾ For more information about traditional and new thermal metrics, see the Semiconductor and IC Package Thermal Metrics application report.

Product Folder Links: LMK04832-SP



6.5 Electrical Characteristics

VDD, VDD_A = $3.3 \text{ V} \pm 5 \text{ %}$, $-55 \text{ °C} \leq \text{TA} \leq 125 \text{ °C}$. Typical values are at VDD = VDD_A = 3.3 V, 25 °C (unless otherwise noted)

| SYMBOL | PARAMETER | TEST C | ONDITIONS | MIN | TYP | MAX | UNIT | |
|----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|----------------------------------------------------------------|-----------------------------------------------------------------------|-----------------------------------------------------------------------------------------------------------------------------|-------|------|------|---------|--|
| Current Con | sumption | | | | | | | |
| | Power Down Supply Current | Device Powered Dowr | 1 | | 3.3 | 5 | | |
| CLKin Specifi fCLKin Specifi fCLKinX SLEWCLKin VCLKinX/Fin1 VIDCLKinX/Fin1 VSSCLKinX/Fin1 VCLKinX-offset VCLKinVIH VCLKinVIL Fin0 Input Pin fFin0 | | | 4 CML 32 mA clocks in bypass 3 LVDS clock /12 4 SYSREF as LCPECL 3 SYSREF as LVDS | | 1010 | | | |
| | Supply Current ⁽¹⁾ | PLL1 locked to external VCXO and PLL2 locked to internal VCO | 4 CML 32 mA clocks in bypass 3 LVDS clock /12 4 SYSREF as LCPECL (low state) 3 SYSREF as LVDS (low state) | | 780 | | mA | |
| | | | 4 CML 32 mA clocks in bypass 3 LVDS clock /12 7 SYSREF outputs powered down | | 675 | 675 | | |
| CLKin Spec | ifications | | | | | | | |
| f _{CLKinX} F O SLEW _{CLKin} Ir V _{CLKinX/Fin1} S V _{ID} CLKinX/ Fin1 V _{SS} CLKinX/ Fin1 IVCLKinX- IVCLKINX- | LOS Circuitry | LOS_EN = 1 | _ | 0.001 | | 125 | | |
| | PLL1 | CLKinX- TYPE=1(MOS) | AC Coupled Input | 0.001 | | 250 | | |
| | | CLKinX-TYPE=0 (Bipolar) | AC Coupled Input | 0.001 | | 750 | | |
| | PLL2 | CLKinX_TYPE=0 (Bipolar) | AC Coupled Input | 0.001 | | 500 | IVII IZ | |
| | 0-delay | 0-delay with external feedback (CLKin1) | AC Coupled Input | 0.001 | | 750 | | |
| | Distribution Mode | CLKin1/Fin1 Pin only | AC Coupled Input 0.001 | | | 3250 | | |
| SLEW _{CLKin} | Input Slew Rate ⁽²⁾ | | | 0.15 | 0.5 | | V/ns | |
| V _{CLKinX/Fin1} | Single-ended clock input voltage | Input pin AC coupled; coupled to GND | complementary pin AC | 0.5 | | 2.4 | Vpp | |
| | Differential clock input voltage ⁽³⁾ | AC coupled | | 0.125 | | 1.55 | V | |
| | - Differential clock input voltage | Ac coupled | | 0.25 | | 3.1 | Vpp | |
| IV (OLIV) | DO official control to the body of Olivina V. | CLKin0/1/2 (Bipolar) | | | 0 | | | |
| | DC offset voltage between CLKinX / CLKinX* Each Pin AC Coupled | CLKin0/1 (MOS) | | | 55 | | mV | |
| Oliseti | • | CLKin2 (MOS) | | | 20 | | | |
| VCLKinVIH | High Input Voltage | V _{CLKin} -V _{IH} | DC Coupled Input | 2 | | Vcc | V | |
| VCLKinVIL | Low Input Voltage | V _{CLKin} -V _{IL} | DC Coupled Input | 0 | | 0.4 | V | |
| | in | 1 | | | | | | |
| | External Input Frequency | AC Coupled Slew | FIN0_DIV2_EN=1 | 1 | | 3250 | MHz | |
| f _{Fin0} | , ,, | Rate > 150 V/us | FIN0_DIV2_EN=2 | 1 | | 6400 | MHz | |
| V _{ID} Fin0 | - Differential Input Voltage | AC Coupled | | 0.125 | | 1.55 | Vpp | |
| V _{SS} Fin0 | | | | 0.25 | | 3.1 | Vpp | |



VDD, VDD_A = $3.3 \text{ V} \pm 5 \%$, $-55 ^{\circ}\text{C} \leq \text{TA} \leq 125 ^{\circ}\text{C}$. Typical values are at VDD = VDD_A = 3.3 V, $25 ^{\circ}\text{C}$ (unless otherwise noted)

| SYMBOL | PARAMETER | TEST C | ONDITIONS | MIN | TYP | MAX | UNIT |
|---------------------------------------|-----------------------------------------------------------------------|---------------------------------------------------------------------------------|------------------------------------------------------------------------------|-------|--------|------|-------------|
| PLL 1 Specif | ications | | | | | | |
| f _{PD1} | Phase Detector Frequency | | | | | 40 | MHz |
| DNI40141- | DI I Nama di a di Alfa Naja a (4) | PLL1_CP_GAIN = 350 | μΑ | | -117 | | |
| PN10kHz | PLL Normalized 1/f Noise ⁽⁴⁾ | PLL1_CP_GAIN = 155 | 0 μΑ | | -118 | | -ID - /I I- |
| DNIFOM | DLL Figure of Marit(5) | PLL1_CP_GAIN = 350 | μΑ | | -221.5 | | dBc/Hz |
| PN FOM | PLL Figure of Merit ⁽⁵⁾ | PLL1_CP_GAIN = 155 | 0 μΑ | | -223 | | |
| | | | PLL1_CP_GAIN=0 | | 50 | | |
| | | VCPout=Vcc/2 (note | PLL1_CP_GAIN=1 | | 150 | | |
| I _{CPOUT1} | Charge Pump Current ⁽⁶⁾ | to tell customer that | PLL1_CP_GAIN=2 | | 250 | | μΑ |
| | | part works for 0-15) | PLL1_CP_GAIN=4 | | 450 | | |
| | | | PLL1_CP_GAIN=8 | | 850 | | |
| I _{CPout1} %MIS | Charge Pump Sink / Source Mismatch | V _{CPout1} = Vcc/2, T = 25 °C | V _{CPout1} = Vcc/2, T = 25 °C | | 1 | 10 | % |
| I _{CPout1} V _{TUNE} | Magnitude of Charge Pump Current Variation vs. Charge Pump Voltage | 0.5 V < V _{CPout1} < V _{CC} - 0.5 V T _A = 25 °C | 0.5 V < V _{CPout1} < V _{CC} - 0.5 V T _A = 25 °C | | 4 | 10 | % |
| I _{CPout1} %TEM P | Charge Pump Current vs. Temperature Varation | | | | 4 | 10 | % |
| I _{CPOUT1} TRI | Charge Pump TRI_STATE Leakage Current | | | | | 10 | nA |
| OSCin Input | | | | | | | |
| foscin - | EN_PLL2_REF_2X=0 | | | 0.001 | | 500 | NAL 1- |
| | EN_PLL2_REF_2X=1 | | 0.001 | | 320 | MHz | |
| SLEW _{OSCin} | Input Slew Rate | | | 0.15 | 0.5 | | V/ns |
| V _{OSCin} | Input voltage for OSCin or OSCin* | AC coupled; single-end coupled to GND | ded; unused pin AC | 0.2 | | 2.4 | Vpp |
| V _{ID} OSCin | D:ff | · | | 0.2 | | 1.55 | V |
| V _{SS} OSCin | Differential voltage swing ⁽³⁾ | AC coupled | | 0.4 | | 3.1 | Vpp |
| V _{CLKinX} Offse t | DC offset voltage between CLKinX / CLKinX* Each Pin AC Coupled | | | | 20 | | mV |
| PLL 2 Specif | ications | | ' | | | | |
| f _{PD} | Phase Detector Frequency | | | | | 320 | MHz |
| DNI40LL- | DI I Name di e di 4 f Naia (4) | PLL2_CP_GAIN = 160 | 0 uA | | -123 | | |
| PN10kHz | PLL Normalized 1/f Noise ⁽⁴⁾ | PLL2_CP_GAIN = 320 | 0 uA | | -128 | | -ID - /I I- |
| DN 5014 | 511 5: (514 ://5) | PLL2_CP_GAIN = 160 | 0 uA | | -226.5 | | dBc/Hz |
| PN FOM | PLL Figure of Merit ⁽⁵⁾ | PLL2_CP_GAIN = 320 | 0 uA | | -230 | | |
| | | VOD 1 1/ /0 | PLL2_CP_GAIN=2 | | 1600 | | |
| ICPOUT | Charge Pump Current Magnitude ⁽⁶⁾ | VCPout=Vcc/2 | PLL2_CP_GAIN=3 | | 3200 | | μA |
| I _{CPout1} %MIS | Charge Pump Sink / Source Mismatch | V _{CPout1} = Vcc/2, T = 25 °C | V _{CPout1} = Vcc/2, T = 25 °C | | 1 | 10 | % |
| I _{CPout1} V _{TUNE} | Magnitude of Charge Pump Current Variation vs. Charge Pump Voltage | 0.5 V < V _{CPout1} < V _{CC} - 0.5 V T _A = 25 °C | 0.5 V < V _{CPout1} < V _{CC} - 0.5 V T _A = 25 °C | | 4 | 10 | % |
| I _{CPout1} %TEM P | Charge Pump Current vs. Temperature Varation | | | | 4 | 10 | % |
| I _{CPOUT1} TRI | Charge Pump TRI_STATE Leakage Current | | | | | 10 | nA |

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VDD, VDD_A = 3.3 V \pm 5 %, –55 °C \leq TA \leq 125 °C. Typical values are at VDD = VDD_A = 3.3 V, 25 °C (unless otherwise noted)

| SYMBOL | PARAMETER | TEST C | ONDITIONS | MIN | TYP | MAX | UNIT |
|------------------------------------|---------------------------------------------------|--------------------------------------------|-------------------|----------|----------|------|--------|
| Internal VCC | Specifications | | | | | | |
| | | | VCO0 | 2440 | | | |
| f _{VCO} | VCO Frequency Range | | VCO1 | | | 3255 | MHz |
| | | | VCO0 | | 8 to 11 | | |
| K _{VCO} | VCO Tuning Sensitivity | | VCO1 | | 17 to 23 | | MHz/V |
| | Allowable temperature Drift for Contin | nous Lock ⁽⁷⁾ | VCO0 | | | 150 | °C |
| ΔT _{CL} | Allowable temperature Drift for Contir | | VCO1 | | | 180 | οС |
| | · | | 10 kHz | | -88.4 | | |
| | | | 100 kHz | | -117 | | |
| | | VCO0 at 2500 MHz | 800 kHz | | -137.5 | | |
| | | | 1 MHz | | -139.7 | | |
| | | | 10 MHz | | -152.6 | | |
| L(f)VCO | Open Loop VCO Phase Noise | | 10 kHz | | -85.7 | | dBc/Hz |
| | | | 100 kHz | | -115.8 | | |
| | | VCO0 at 2590 MHz | 800 kHz | | -137 | | |
| | | V 000 ut 2000 Wii i2 | 1 MHz | | -138.6 | | |
| | | | 10 MHz | | -151.8 | | |
| | | | 10 kHz | | -82.6 | | |
| | | | 100 kHz | -112.3 | | | |
| | Open Loop VCO Phase Noise | VCO1 at 2700 MHz | 800 kHz | | -134.9 | | |
| | | | 1 MHz | | -137.2 | | |
| | | | 10 MHz | | -151.1 | | |
| L(f)VCO | | VCO1 at 3200 MHz | 10 kHz | | -131.1 | | dBc/Hz |
| | | | | | | | |
| | | | 100 kHz | | -110.4 | | |
| | | | 800 kHz | | -134.3 | | |
| | | | 1 MHz | | -135.6 | | |
| | le Oleane and Timber | | 10 MHz | | -149.3 | | |
| Output Cloci | k Skew and Timing | 0 0: (0 : | | | | | |
| 01/51/101/1/ | | Same Pair of Device clocks and same format | | | 50 | | |
| SKEWCLKin X | Output to Output Skew | Even to Even or Odd to Odd, Same Format | | | 50 | | ps |
| | | Even clock to Odd Clock | | | 50 | | |
| Additive Jitte | │ er in Distribution Mode from Fin Pin | | | | | | |
| | | | LVCMOS | | 50 | | |
| | | | LVDS | | 50 | | + |
| | Additive litter Dietribution made with | 245.76 MHz Output | LVPECL | | 40 | | |
| L(f)CLKout | Additive jitter, Distribution mode with no divide | Frequency, 12k-20MHz | LCPECL | | 35 | | fs |
| | | integration bandwidth | HSDS | | 40 | | |
| | | | CML | | 35 | | 1 |
| LVCMOS Ou | touts | <u> </u> | JL | | | | |
| f) _{CLKout} | Frequency | | 5 pF Load | | | 250 | MHz |
| L(f) _{CLKout} | Noise Floor | 245.76 MHz | 20 MHz Offset | | -160 | | dBc/Hz |
| V _{OH} | Output High Voltage | 1 mA load | 23 1111 12 011001 | Vcc-0.1 | 100 | | V |
| v _{oн} V _{ol} | Output Low Voltage | 1 mA load | | V 00-0.1 | | 0.1 | V |
| ▼ UL | Jacpar Low Vollage | i ilin load | | 1 | | U. I | v |



VDD, VDD_A = $3.3 \text{ V} \pm 5 \%$, $-55 ^{\circ}\text{C} \leq \text{TA} \leq 125 ^{\circ}\text{C}$. Typical values are at VDD = VDD_A = 3.3 V, $25 ^{\circ}\text{C}$ (unless otherwise noted)

| SYMBOL | PARAMETER | TEST CO | ONDITIONS | MIN | TYP | MAX | UNIT |
|---------------------------------|-----------------------------------------------------------|-----------------------------------------------------------------------------|--------------------------------------------------------------------------------|------|--------------|-------|--------|
| I _{OL} | Output Low Current | Vd=1.65V | | | 28 | | mA |
| DUTY | Output Duty Cycle | | | | 50 | | % |
| LVDS Clock | Outputs | | | | | | |
| L(f)CLKout | Noise Floor | 245.76 MHz output | 20 MHz Offset | | -159.5 | | dBc/Hz |
| T _R /T _F | 20% to 80% Rise/Fall Time | | | | 175 | | ps |
| V _{OD} | Differential Output Voltage | | | | 400 | | mV |
| ΔV_{OD} | Change in V _{OD} for complimentary output states | DC Measurement, AC | DC Measurement, AC coupled to receiver input $R_L = 100 \ \Omega$ differential | | | 60 | mV |
| V _{OS} | Output Offset Voltage | | | | | 1.375 | V |
| ΔV _{OS} | Change on VOS for complimentary Output states | | | | | 35 | mV |
| I _{SA} I _{SB} | Short circuit Output Current | | | -24 | | 24 | mA |
| LCPECL CI | ock Outputs | | | | | | |
| L(f)CLKout | Noise Floor | 245.76 MHz output | 20 MHz Offset | | -162.5 | | dBc/Hz |
| T _R /T _F | 20% to 80% Rise/Fall Time | | | | 135 | | ps |
| V _{OH} | Output High Voltage | DC Measurement with | | | 1.4 | | V |
| V _{OL} | Output Low Voltage | 50-Ω to 0.5V | | | 0.6 | | V |
| V _{OD} | Differential Output Voltage | DC Measurement with 50-Ω to 0.5V | | | 870 | | mV |
| LVPECL CIO | ock Outputs | | | | | | |
| L(f)CLKout | Noise Floor | 245.76 MHz output, LVPECL 2.0 V | 20 MHz Offset | | -163 | | dBc/Hz |
| T _R /T _F | 20% to 80% Rise/Fall Time | | | | 135 | | ps |
| V | Output High Voltage | | LVPECL 1.6 V | | Vcc-1 | | V |
| V _{OH} Output | Output Flight Voltage | DC Measurement termination 50 Ω to Vcc-2 V | LVPECL 2.0 V | | Vcc-1 | | V |
| V _{OL} | Output Low Voltage | | LVPECL 1.6 V | V | /cc-1.8 | | V |
| VOL | Output Low Voltage | | LVPECL 2.0 V | | Vcc-2 | | V |
| V_{OD} | Differential Output Voltage | 2.5 GHz, Em = 120 Ω to GND, R _L = AC coupled 100 Ω | LVPECL 1.6 V LVPECL 2.0 V | | 0.8 | | V |
| HSDS Clock | C Outputs | 1 | | | | | |
| L(f)CLKout | Noise Floor | 245.76 MHz output | 20 MHz Offset | | -162 | | dBc/Hz |
| T _R /T _F | 20% to 80% Rise/Fall Time | | | | 170 | | ps |
| | | | HSDS 6 mA | V | /cc-0.9 | | • |
| V _{OH} | Output High Voltage | DC Measurement with | HSDS 8 mA | | Vcc- 0.95 | | V |
| | | 50 Ω to 0.5V | HSDS 6 mA | V | /cc–1.5 | | |
| V_{OL} | Output Low Voltage | | HSDS 8 mA | V | /cc-1.7 | | V |
| | | | HSDS 6 mA | | 0.6 | | ., |
| V_{OD} | Output Voltage | DC Measurement with | HSDS 8 mA | | 0.75 | | V |
| | Change on VOS for complimentary | 50Ω to 0.5V | HSDS 6 mA | -80 | | 80 | |
| ΔV_{OD} | Output states | | HSDS 8 mA | -115 | | 115 | mV |
| CML Output | ts | 1 | | | | | |
| L(f)CLKout | Noise Floor | 20 MHz Offset | | | -163 | | dBc/Hz |
| | | CML 16 mA | | | 120 | | |
| T_R/T_F | 20% to 80% Rise/Fall Time | CML 24 mA | | | 125 | | ps |
| 1 4 1 | | CML 32 mA | | | 135 | | † |



VDD, VDD_A = $3.3 \text{ V} \pm 5 \text{ %}$, $-55 ^{\circ}\text{C} \leq \text{TA} \leq 125 ^{\circ}\text{C}$. Typical values are at VDD = VDD_A = 3.3 V, $25 ^{\circ}\text{C}$ (unless otherwise noted)

| SYMBOL | PARAMETER | TEST C | ONDITIONS | MIN TY | P MAX | UNIT | |
|-----------------|-------------------------------|-----------------------------------------------------------|-------------------------------------------|------------|-------|------|--|
| V _{OH} | Output High Voltage | 50 Ω pull up to Vcc, Do | C Measurement | V | cc | V | |
| | | | CML 16 mA | Vcc 0.8 | | | |
| V _{OL} | Output Low Voltage | 50 Ω pull up to Vcc, DC Measurement | CML 24 mA | Vcc 1.2 | = | V | |
| | | | CML 32 mA | Vcc 1.6 | = | | |
| | | | CML 16 mA | 84 | 10 | mV | |
| | | 50 Ω pull up to Vcc, DC Measurement | CML 24 mA | 126 | 60 | | |
| | Outside Valle in | | CML 32 mA | 166 | 60 | | |
| V_{OD} | Output Voltage | 50 Ω pull up to Vcc, | CML 16 mA | 55 | 50 | mV | |
| | | DC Measurement, R_L = AC coupled 100 Ω , 250 MHz | CML 24 mA | 8. | 15 | | |
| | | | CML 32 mA | 107 | 70 | | |
| Digital Outp | uts (CLKin_SELX,STATUS_LDX, a | nd RESET/GPO,SDIO) | | | | | |
| V _{OH} | Output High Voltage | | | Vcc-0.4 | | V | |
| V _{OL} | Output Low Voltage | | | | 0.4 | V | |
| Digital Input | ts | | | | | | |
| V _{IH} | High-level input voltage | | | 1.2 | | V | |
| V _{IL} | Low-level input voltage | | | | 0.5 | V | |
| I _{IH} | High-level input current | CLKinX_SEL,RESET/CS* | CLKinX_SEL,RESET/GPO,SYNC,SCK,SDIO,CS* | | 80 | uA | |
| | | SYNC | V _{IH} = V _{CC} | | 25 | | |
| I _{IL} | Low-level input current | CLKinX_SEL,RESET/CS* | CLKinX_SEL,RESET/GPO,SYNC,SCK,SDIO,CS* -5 | | | uA | |
| I _{IL} | Low-level input current | SYNC | V _{IL} = 0 V | -5 | 5 | + | |
| | | 1 | 1 | | | 1 | |

- (1) Use the TICS Pro tool to calculate Icc for a specific configuration
- (2) Device will function with slew rate as low as 0.15 V/ns, however a slew rate of 0.5 V/ns or higher is recommended to get the best phase noise performance.
- (3) See Differential Voltage Measurement Terminology for definition of VID and VOD voltages.
- (4) A specification in modeling PLL in-band phase noise is the 1/f flicker noise, LPLL_flicker(f), which is dominant close to the carrier. Flicker noise has a 10 dB/decade slope. PN10 kHz is normalized to a 10 kHz offset and a 1 GHz carrier frequency. PN10 kHz = LPLL_flicker(10 kHz) 20 log(Fout / 1 GHz), where LPLL_flicker(f) is the single side band phase noise of only the flicker noise's contribution to total noise, L(f). To measure LPLL_flicker(f) it is important to be on the 10 dB/decade slope close to the carrier. A high compare frequency and a clean crystal are important to isolating this noise source from the total phase noise, L(f). LPLL_flicker(f) can be masked by the reference oscillator performance if a low-power or noisy source is used. The total PLL in-band phase noise performance is the sum of LPLL_flicker(f) and LPLL_flat(f)
- (5) A specification modeling PLL in-band phase noise. The normalized phase noise contribution of the PLL, LPLL_flat(f), is defined as: PN1 HZ = LPLL_flat(f) 20 log(N) 10 log(fPDX). LPLL_flat(f) is the single side band phase noise measured at an offset frequency, f, in a 1 Hz bandwidth and fPDX is the phase detector frequency of the synthesizer. LPLL_flat(f) contributes to the total noise, L(f).
- (6) This parameter is programmable to more states than are shown in the electrical specifications
- (7) Maximum Allowable Temperature Drift for Continuous Lock is how far the temperature can drift in either direction from the value it was at the time that the 0x168 register was last programmed with PLL2_FCAL_DIS = 0, and still have the part stay in lock. The action of programming the 0x168 register, even to the same value, activates a frequency calibration routine. This implies the part will work over the entire frequency range, but if the temperature drifts more than the maximum allowable drift for continuous lock, then it will be necessary to reload the appropriate register to ensure it stays in lock. This parameter is indirectly tested.



6.6 Timing Requirements

VDD, VDD_A = 3.3 V \pm 5 %, -55 °C \leq TA \leq 125 °C. Typical values are at VDD = VDD_A = 3.3 V, 25 °C (unless otherwise noted)

| PARAMETER | MIN | NOM | MAX | UNIT |
|----------------------------------------------------|---------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|--------------------------------------------|--------------------------------------------|---------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| irements | | | | |
| Setup time for SDI edge to SCK rising edge | 40 | | | ns |
| Hold time for SDI edge to SCK rising edge 20 | | | ns | |
| Period of SCK | 400 | | | ns |
| High width of SCK | 120 | | | ns |
| Low width of SCK | 120 | | | ns |
| Setup time for CS* falling edge to SCK rising edge | 40 | | | ns |
| Hold time for CS* rising edge from SCK rising edge | 40 | | | ns |
| SCK falling edge to valid read back data | | , | 120 | ns |
| | Setup time for SDI edge to SCK rising edge Hold time for SDI edge to SCK rising edge Period of SCK High width of SCK Low width of SCK Setup time for CS* falling edge to SCK rising edge Hold time for CS* rising edge from SCK rising edge | Setup time for SDI edge to SCK rising edge | Setup time for SDI edge to SCK rising edge | Setup time for SDI edge to SCK rising edge 40 Hold time for SDI edge to SCK rising edge 20 Period of SCK 400 High width of SCK 120 Low width of SCK 120 Setup time for CS* falling edge to SCK rising edge 40 Hold time for CS* rising edge from SCK rising edge 40 |

6.7 Timing Diagram

Register programming information on the SDIO pin is clocked into a shift register on each rising edge of the SCK signal. On the rising edge of the CS* signal, the register is sent from the shift register to the register addressed. A slew rate of at least 30 V/µs is recommended for these signals. After programming is complete the CS* signal should be returned to a high state. If the SCK or SDIO lines are toggled while the VCO is in lock, as is sometimes the case when these lines are shared with other parts, the phase noise may be degraded during this programming.

4-wire mode read back has same timing as SDIO pin.

R/W bit = 0 is for SPI write. R/W bit = 1 is for SPI read.

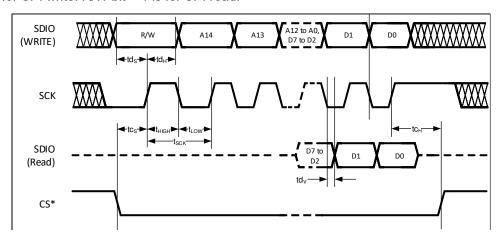
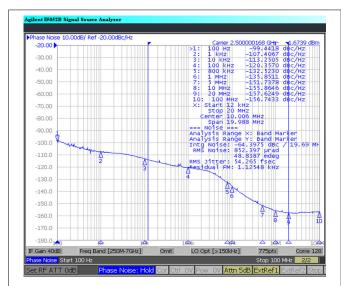


Figure 6-1. SPI Timing Diagram

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6.8 Typical Characteristics



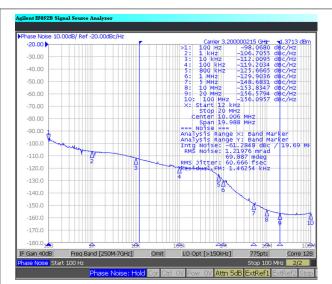
Jitter from 100 Hz to 100 MHz = 63.6 fs rms.

Output is CLKout4 as CML 32 mA with 68-nH to $20-\Omega$ DC bias. Other settings are CLKout4_5_IDL = 1 and CLKout4_5_BYP = 1.

PLL2 Loop Filter R2 = 470 $\Omega,$ C2 = 150 nF, Charge Pump = 3200 $\mu A.$

Reference is R&S SMA100B Signal Generator with option SMAB - B711 through Prodyn BIB-100G Balun to OSCin.

Figure 6-2. PLL2 With VCO1 Performance at 2500 MHz With 312.5-MHz OSCin/Phase Detector Frequency



Jitter from 100 Hz to 100 MHz = 67 fs rms.

Output is CLKout4 as CML 32 mA with 68-nH to $20-\Omega$ DC bias.

Other settings are CLKout4_5_IDL = 1 and CLKout4_5_BYP = 1

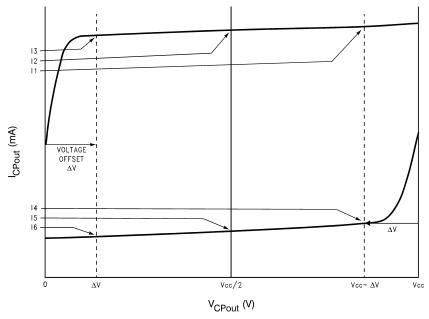
PLL2 Loop Filter R2 = 470 $\Omega,$ C2 = 150 nF, Charge Pump = 3200 $\mu A.$

Reference is R&S SMA100B Signal Generator with option SMAB - B711 through Prodyn BIB-100G Balun to OSCin.

Figure 6-3. PLL2 With VCO1 Performance at 3200 MHz With 320-MHz OSCin/Phase Detector Frequency

7 Parameter Measurement Information

7.1 Charge Pump Current Specification Definitions



I1 = Charge Pump Sink Current at $V_{CPout} = V_{CC} - \Delta V$

I2 = Charge Pump Sink Current at V_{CPout} = V_{CC}/2

I3 = Charge Pump Sink Current at $V_{CPout} = \Delta V$

I4 = Charge Pump Source Current at $V_{CPout} = V_{CC} - \Delta V$

I5 = Charge Pump Source Current at $V_{CPout} = V_{CC}/2$

I6 = Charge Pump Source Current at $V_{CPout} = \Delta V$

 ΔV = Voltage offset from the positive and negative supply rails. Defined to be 0.5 V for this device.

7.1.1 Charge Pump Output Current Magnitude Variation vs Charge Pump Output Voltage

$$I_{CPout} \ Vs \ V_{CPout} = \frac{|I1| - |I3|}{|I1| + |I3|} \times 100\%$$
$$= \frac{|I4| - |I6|}{|I4| + |I6|} \times 100\%$$

7.1.2 Charge Pump Sink Current vs Charge Pump Output Source Current Mismatch

$$I_{CPout}$$
 Sink Vs I_{CPout} Source =
$$\frac{||2| - ||5||}{||2| + ||5||} \times 100\%$$

7.1.3 Charge Pump Output Current Magnitude Variation vs Ambient Temperature

$$I_{CPout} \text{ Vs } T_{A} = \frac{|I_{2}||_{T_{A}} - |I_{2}||_{T_{A} = 25^{\circ}C}}{|I_{2}||_{T_{A} = 25^{\circ}C}} \times 100\%$$

$$= \frac{|I_{S}||_{T_{A}} - |I_{S}||_{T_{A} = 25^{\circ}C}}{|I_{S}||_{T_{A} = 25^{\circ}C}} \times 100\%$$

7.2 Differential Voltage Measurement Terminology

The differential voltage of a differential signal can be described by two different definitions causing confusion when reading data sheets or communicating with other engineers. This section will address the measurement and description of a differential signal so that the reader will be able to understand and distinguish between the two different definitions when used.

The first definition used to describe a differential signal is the absolute value of the voltage potential between the inverting and noninverting signal. The symbol for this first measurement is typically V_{ID} or V_{OD} depending on if an input or output voltage is being described.

The second definition used to describe a differential signal is to measure the potential of the noninverting signal with respect to the inverting signal. The symbol for this second measurement is V_{SS} and is a calculated parameter. Nowhere in the IC does this signal exist with respect to ground, it only exists in reference to its differential pair. V_{SS} can be measured directly by oscilloscopes with floating references, otherwise this value can be calculated as twice the value of V_{OD} as described in the first description.

Figure 7-1 illustrates the two different definitions side-by-side for inputs and Figure 7-2 illustrates the two different definitions side-by-side for outputs. The V_{ID} and V_{OD} definitions show V_A and V_B DC levels that the noninverting and inverting signals toggle between with respect to ground. V_{SS} input and output definitions show that if the inverting signal is considered the voltage potential reference, the noninverting signal voltage potential is now increasing and decreasing above and below the noninverting reference. Thus the peak-to-peak voltage of the differential signal can be measured.

 V_{ID} and V_{OD} are often defined as volts (V) and V_{SS} is often defined as volts peak-to-peak (V_{PP}).

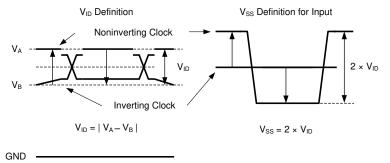


Figure 7-1. Two Different Definitions for Differential Input Signals

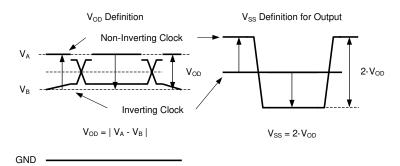


Figure 7-2. Two Different Definitions for Differential Output Signals

Refer to application note *AN-912 Common Data Transmission Parameters and their Definitions* (SNLA036) for more information.

8 Detailed Description

8.1 Overview

The LMK04832-SP device is very flexible to meet many application requirements. Use cases include dual loop, dual loop 0-delay nested, dual loop 0-delay cascaded, single loop, single loop 0-delay, and clock distribution.

The device may be used in JESD204B systems by providing a device clock and SYSREF to target devices, however traditional (non-JESD204B) systems are possible by programming pairs of outputs to share the clock divider or any mix of JESD204B and traditional.

8.1.1 Differences Between LMK04832-SP and LMK04832

The LMK04832-SP is very similar to the LMK04832 commercial device, but it does have a few differences.

Attribute LMK04832 LMK04832-SP Radiation Hardened Nο Yes Temperature -40 °C to +85 °C -55 °C to +125 °C 11 × 11 mm² (Disregarding Leads) $9 \times 9 \text{ mm}^2$ Package Size 30 × 30 mm² (Including Leads) Package Composition Plastic Ceramic Pins 8/9 NC Fin0/Fin0* Input NC **GND** Pin 7 **Programming Speed** 5 MHz 2.5 MHz

Table 8-1. LMK04832-SP vs. LMK04832

8.1.1.1 Jitter Cleaning

The dual loop PLL architecture provides the lowest jitter performance over a wide range of output frequencies and phase noise integration bandwidths. The first stage PLL (PLL1) is driven by an external reference clock and uses an external VCXO to provide a frequency accurate, low phase noise reference clock for the second stage frequency multiplication PLL (PLL2).

PLL1 typically uses a narrow loop bandwidth (typically 10 Hz to 200 Hz) to retain the frequency accuracy of the reference clock input signal while at the same time suppressing the higher offset frequency phase noise that the reference clock may have accumulated along its path or from other circuits. This cleaned reference clock provides the reference input to PLL2.

The low phase noise reference provided to PLL2 allows PLL2 to operate with a wide loop bandwidth (typically 50 kHz to 200 kHz). The loop bandwidth for PLL2 is chosen to take advantage of the superior high offset frequency phase noise profile of the internal VCO and the good low offset frequency phase noise of the reference VCXO.

Ultra-low jitter is achieved by allowing the phase noise of the external VCXO to dominate the final output phase noise at low offset frequencies and the phase noise of the internal VCO to dominate the final output phase noise at high offset frequencies. This results in best overall phase noise and jitter performance.

8.1.1.2 JEDEC JESD204B Support

This device clocks up to 7 JESD204B targets using 7 device clocks and 7 SYSREF clocks and allows every clock output to be configured as a device clock or SYSREF clock.

8.1.2 Clock Inputs

Note

CLKin1 can be used as a reference for dual loop, single loop, or clock distribution mode, providing flexibility configuring the device for different operation modes from one clock input.

8.1.2.1 Inputs for PLL1

CLKin0, CLKin1, and CLKin2 are the three redundant inputs with their own PLL1 R dividers that can be used as a reference input to PLL1. The switching between these inputs can either be automatic or manual. For manual switching, CLKin_SEL0 and CLKin_SEL1 pins can be used for faster speed. These input pins are also shared for other functions.

- CLKin1 is shared for use as an external 0-delay feedback (FBCLKin), or for use with an external VCO (Fin).
- CLKin2 is shared for use as OSCout. To use CLKin2 as an input power down OSCout, see Section 8.6.2.3.1.

8.1.2.2 Inputs for PLL2

In dual loop configurations, the PLL2 reference is from OSCin. However, in single PLL2 loop operation, it is also possible to use any of the three CLKins of PLL1 as a reference to PLL2.

8.1.2.3 Inputs When Using Clock Distribution Mode

For clock distribution mode, a reference signal is may be applied to the Fin0 or Fin1 pins. CLKin0 can be used to distribute a SYSREF signal through the device. In this use case, CLKin0 is re-clocked by CLKin1. The Fin0 pins are generally recommended over the Fin1 pins because they allow higher frequency, use a lower noise path, and cannot be used for other functions (like redundant input).

8.1.3 PLL1

PLL1 allows low offset jitter cleaning as well as the use of redundant inputs and frequency holdover.

8.1.3.1 Frequency Holdover

Frequency holdover keeps the clock outputs on frequency with minimum drift when the reference is lost until a valid reference clock signal is re-established. This can only be used if PLL1 is used.

8.1.3.2 External VCXO for PLL1

When PLL1 is used, an external VCXO is required. The close-in noise performance of this VCXO is critcal for good jitter cleaning performance. The LMK04832-SP also provides OSCout, which by power-on default is a buffered copy of the PLL1 feedback and PLL2 reference input at OSCin. This reference input is typically a low noise VCXO or XO. This output can be used to clock external devices such as microcontrollers, FPGAs, CPLDs, and so forth, before the LMK04832-SP is programmed.

- The OSCout buffer output type is programmable to LVDS, LVPECL, or LVCMOS.
- The VCXO buffered output can be synchronized to the VCO clock distribution outputs by using Cascaded 0-Delay Mode.

8.1.4 PLL2

8.1.4.1 Internal VCOs for PLL2

PLL2 has two internal VCOs. The output of the selected VCO is routed to the Clock Distribution Path. This same selection is also fed back to the PLL2 phase detector through a prescaler and N-divider.

8.1.4.2 External VCO Mode

An external VCO can be used with PLL2 with the input for the external VCO coming through Fin0 or Fin1, although Fin0 is generally preferred.

• Fin0/Fin0* input is generally recommended because it is lower noise, supports higher input frequency (up to 6 GHz if the div2 is used), and it leaves CLKin1 available for redundant inputs.

Fin1/Fin1* inputs are generally NOT recommended, for the reasons stated above, although they can be used.

8.1.5 Clock Distribution

The LMK04832-SP features a total of 14 PLL2 clock outputs driven from the internal or external VCO.

All clock outputs have programmable output types. They can be programmed to CML, LVPECL, LVDS, HSDS, or LCPECL. All odd clock outputs plus CLKout8 and CLKout10 may be programmed to LVCMOS.

If OSCout is included in the total number of clock outputs the LMK04832-SP is able to distribute up to 15 differential clocks. OSCout may be a buffered version of OSCin, DCLKout6, DCLKout8, or SYSREF. Its output format is programmable to LVDS, LVPECL, or LVCMOS.

The following sections discuss specific features of the clock distribution channels that allow the user to control various aspects of the output clocks.

8.1.5.1 Clock Divider

There are 7 clock dividers. In a traditional clocking system each divider can drive two outputs. The divider range is 1 to 1023. Duty cycle correction may be enabled for the output. When the divider is used even clocks may not output CML.

In a JESD204B system, one clock output is a device clock driven from the clock divider and the other paired clock is from the SYSREF divider. For connectivity flexibility, either the even or odd clock output may be driven by the clock divider or be the SYSREF output.

8.1.5.2 High Performance Divider Bypass Mode

Even clock outputs (CLKoutX) of the LMK04832-SP may bypass the clock divider to achieve the best possible noise floor and output swing. In this mode, the only usable output format is CML.

8.1.5.3 SYSREF Clock Divider

The SYSREF divider supports a divide range of 8 to 8191 (even and odd). There is no duty cycle correction for the SYSREF divider. The SYSREF output may be routed to all clock outputs.

8.1.5.4 Device Clock Delay

The device clocks support digital delay for phase adjustment of the clock outputs.

The digital delay allows outputs to be delayed from 8 to 1023 VCO cycles. The delay step can be as small as half the period of the clock distribution path. For example, a 3.2-GHz VCO frequency results in 156.25-ps steps.

The digital delay value takes effect on the clock output phase after a SYNC event.

8.1.5.5 Dynamic Digital Delay

The device clock dividers support a dynamic digital delay feature which allows the clock to be delayed by one full device clock cycle. With a single programming, an adjustment of up to 255 one cycle delays may occur. When making a multi-step adjustment, the adjustments are periodically applied to reduce impact to the clock.

Dynamic phase adjustments of half a clock distribution cycle are possible by half step.

The SYSREF digital delay value is reused for dynamic digital delay. To achieve a one cycle delay program the SYSREF digital delay value to one greater than half the SYSREF divide value.

8.1.5.6 SYSREF Delay: Global and Local

The SYSREF divider includes a digital delay block which allows a global phase shift with respect to the device clocks.

Each clock output pair includes a local SYSREF analog and digital delay for unique phase adjustment of each SYSREF clock.

The local analog delay allows for approximately 21-ps steps. Turning-on analog delay adds an additional 124 ps of delay in the clock path. The digital delay step can be as small as half the period of the clock distribution path. For example, a 3.2-GHz VCO frequency results in 156.25-ps steps.

The local digital delay and half step allows a SYSREF output to be delayed from 1.5 to 11 clock distribution path cycles.

8.1.5.7 Programmable Output Formats

All clock outputs can be programmed to an LVDS, HSDS, LVPECL, or LCPECL output type. Odd clock outputs in addition to CLKout8 and CLKout10 may also be programmed to LVCMOS. All odd clock outputs can also be programmed to CML. When in bypass mode the even clock output may only be CML.

The OSCout can be programmed to an LVDS, LVPECL, or LVCMOS output type.

Any HSDS output type can be programmed to 6-mA or 8-mA amplitude levels.

Any LVPECL output type can be programmed to 1600-mVpp or 2000-mVpp amplitude levels. The 2000-mVpp LVPECL output type is a Texas Instruments proprietary configuration that produces a 2000-mVpp differential swing for compatibility with many data converters and is also known as 2VPECL.

LCPECL allows for DC-coupling SYSREF to low voltage JESD204B targets.

8.1.5.8 Clock Output Synchronization

Using the SYNC input causes all active clock outputs to share a rising edge as programmed by fixed digital delay.

The SYNC event must occur for digital delay values to take effect.

8.1.6 0-Delay

Two types of 0-delay mode are supported.

- 1. Cascaded 0-delay
- 2. Nested 0-delay

Cascaded 0-delay mode establishes a fixed deterministic phase relationship of the phase of the PLL2 input clock (OSCin) to the phase of a clock selected by the feedback mux. The 0-delay feedback uses internal feedback from the CLKout6, CLKout8, or SYSREF. The 0-delay feedback can also be from an external feedback through the FBCLKin port. The FB_MUX selects the feedback source. Because OSCin has a fixed deterministic phase relationship to the feedback clock, OSCout will also have a fixed deterministic phase relationship to the feedback clock. In this mode, PLL1 input clock (CLKinX) also has a fixed deterministic phase relationship to PLL2 input clock (OSCin); this results in a fixed deterministic phase relationship between all clocks from CLKinX to the clock outputs.

Nested 0-delay mode establishes a fixed deterministic phase relationship of the phase of the PLL1 input clock (CLKinX) to the phase of a clock selected by the feedback mux. The 0-delay feedback uses internal feedback from the CLKout6, CLKout8, or SYSREF. The 0-delay feedback can also be from an external feedback through the FBCLKin port. The FB MUX selects the feedback source.

Without using 0-delay mode, there will be n possible fixed phase relationships from clock input to clock output depending on the clock output divide value.

Using an external 0-delay feedback reduces the number of available clock inputs by one.

8.1.7 Status Pins

The status pins can be monitored for feedback or in some cases used for input depending upon device programming. For example:

- The CLKin SEL0 pin may indicate the LOS (loss-of-signal) for CLKin0.
- The CLKin SEL1 pin may be an input for selecting the active clock input.
- The Status_LD1 pin may indicate if the device is locked.
- The Status LD2 pin may indicate if PLL2 is locked.

The status pins can be programmed to a variety of other outputs including PLL divider outputs, combined PLL lock detect signals, PLL1 Vtune railing, readback, and so forth. Refer to Section 8.6 for more information.



8.2 Functional Block Diagram

Figure 8-1 illustrates the high level LMK04832-SP block diagram.

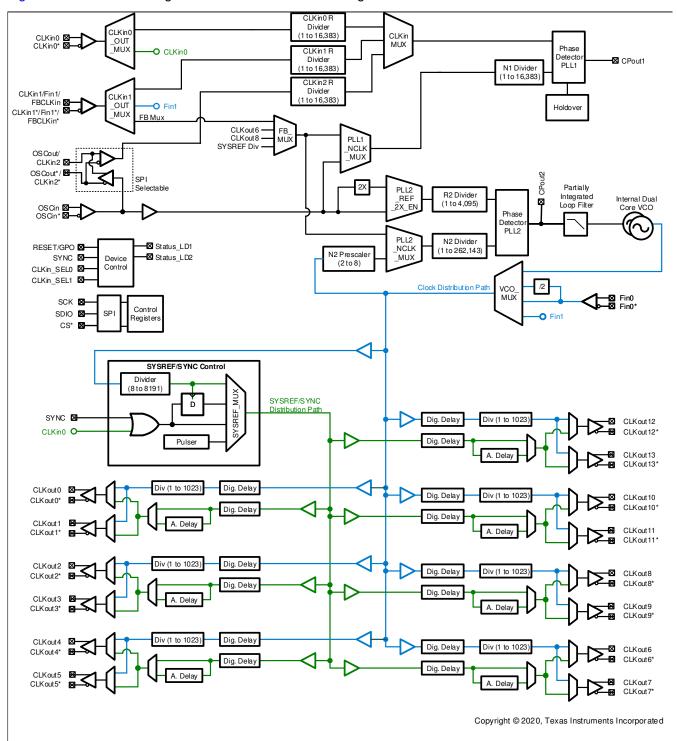
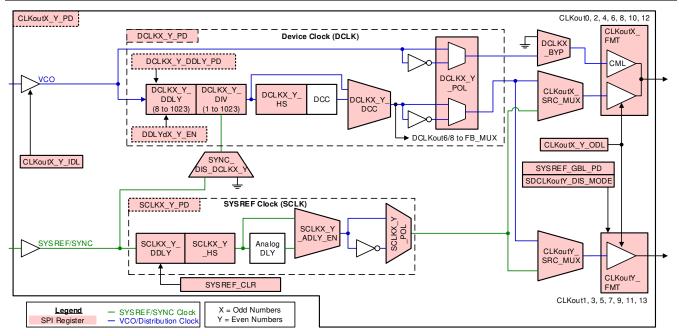


Figure 8-1. High Level LMK04832-SP Block Diagram

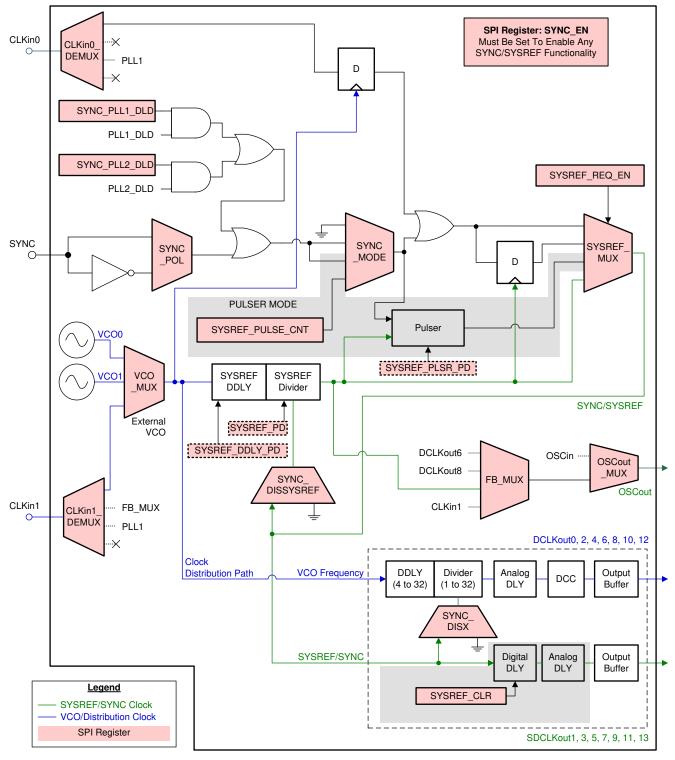




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Figure 8-2. Device and SYSREF Clock Output Block





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Figure 8-3. SYNC/SYSREF Clocking Paths

8.3 Feature Description

8.3.1 Synchronizing PLL R Dividers

In some cases, it is necessary to synchronize PLL R dividers to enable determinism of clocks outputs to inputs. This typically is required when the fraction Total PLL N divide / Total PLL R divide does not reduce to N / 1.

8.3.1.1 PLL1 R Divider Synchronization

It is possible to use the CLKin0 or SYNC pin to synchronize the PLL1 R divider. In either case, the PLL1 R divider is armed for reset, then the rising sync edge arrives from either SYNC pin or CLKin0. After the PLL1 R divider is armed, PLL1 is unlocked until the synchronization edge arrives and allows the divider to operate and the PLL to lock. The procedure to synchronize PLL1 R is as follows:

- 1. Setup device for synchronizing PLL1 R:
 - PLL1R_SYNC_EN = 0x1
 - PLL1R SYNC SRC = 0x1 (SYNC pin) or 0x2 (CLKin0)
 - CLKin0 DEMUX = 0x2 (PLL1)
 - CLKin1_DEMUX = 0x2 (PLL1)
 - CLKin0_TYPE = 0x1 (MOS) for DC-coupled or CLKin0_TYPE = 0x0 (Bipolar) for AC-coupled
- 2. Arm PLL1 R divider for synchronization
 - PLL1R RST = 1, then 0.
 - PLL1 is unlocked.
- 3. Send rising edge on SYNC pin or CLKin0.
 - PLL1 R divider is released from reset and PLL1 relocks.

It is necessary to meet a setup and hold time when CLKin0 or SYNC pin goes high to ensure deterministic reset of the PLL1 R divider.

The SYNC POL bit has no effect on SYNC polarity for PLL1 R synchronization.

8.3.1.2 PLL2 R Divider Synchronization

The SYNC pin must be used to synchronized the PLL2 R divider. When PLL2R_SYNC_EN = 1, as long as the SYNC pin is held high, the PLL2 R divider is held in reset. When the SYNC pin is returned low, the divider is allowed to continue dividing. While PLL2R_SYNC_EN = 1 and SYNC pin is high PLL2 is unlocked.

It is necessary to meet a setup and hold time when SYNC pin goes low to ensure deterministic reset of the PLL2 R divider.

The SYNC POL bit has no effect on SYNC polarity for PLL2 R synchronization.



8.3.2 SYNC/SYSREF

The SYNC and SYSREF signals share the same SYNC/SYSREF Clock Distribution path. To properly use SYNC and/or SYSREF for JESD204B it is important to understand the SYNC/SYSREF system. Figure 8-2 illustrates the detailed diagram of a clock output block with SYNC circuitry included. Figure 8-3 illustrates the interconnects and highlights some important registers used in controlling the device for SYNC/SYSREF purposes.

To reset or synchronize a divider, the following conditions must be met:

- 1. SYNC_EN must be set. This ensures proper operation of the SYNC circuitry.
- SYSREF_MUX and SYNC_MODE must be set to a proper combination to provide a valid SYNC/SYSREF signal.
 - If SYSREF block is being used, the SYSREF PD bit must be clear.
 - If the SYSREF Pulser is being used, the SYSREF PLSR PD bit must be clear.
 - For each CLKoutX or CLKoutY being used for SYSREF, the respective SCLKX_Y_PD bit must be cleared.
- 3. DCLKX_Y_DDLY_PD and SYSREF_DDLY_PD bits must be clear to power up the digital delay circuitry used during SYNC to cause deterministic phase between the device clock dividers and the global SYSREF divider.
- 4. The SYNC_DISX bit must be clear to allow SYNC/SYSREF signal to divider circuit. The SYSREF_MUX register selects the SYNC source which resets the SYSREF/CLKoutX dividers provided the corresponding SYNC DISX bit is clear.
- 5. Other bits which impact the operation of SYNC such as SYNC_1SHOT_EN may be set as desired.
- 6. After these dividers are synchronized, the DCLKX_Y_DDLY_PD and SYSREF_DDLY_PD bits may be set to save current. Clearing them to power up may disrupt the output clock phase.

Table 8-2 illustrates the some possible combinations of SYSREF MUX and SYNC MODE.

Table 8-2. Some Possible SYNC Configurations

| NAME | SYNC_MODE | SYSREF_MUX | OTHER | DESCRIPTION |
|-------------------------------------|-----------|------------|----------------------------------------------------------------------------------|--------------------------------------------------------------------------------------------------------------------------------------------------------------|
| SYNC Disabled | 0 | 0 | CLKin0_DEMUX ≠ 0 | No SYNC will occur. |
| Pin or SPI SYNC | 1 | 0 | CLKin0_DEMUX ≠ 0 | Basic SYNC functionality, SYNC pin polarity is selected by SYNC_POL. To achieve SYNC through SPI, toggle the SYNC_POL bit. |
| Differential input SYNC | X | 0 or 1 | CLKin0_DEMUX = 0 | Differential CLKin0 now operates as SYNC input. |
| JESD204B Pulser on pin transition. | 2 | 2 | SYSREF_PULSE_CNT sets pulse count | Produce SYSREF_PULSE_CNT programmed number of pulses on pin transition. SYNC_POL can be used to cause SYNC through SPI. |
| JESD204B Pulser on SPI programming. | 3 | 2 | SYSREF_PULSE_CNT sets pulse count | Programming SYSREF_PULSE_CNT register starts sending the number of pulses. |
| Re-clocked SYNC | 1 | 1 | SYSREF operational, SYSREF Divider as required for training frame size. | Allows precise SYNC for n-bit frame training patterns for non-JESD converters such as LM97600. |
| External SYSREF request | 0 | 2 | SYSREF_REQ_EN = 1 Pulser powered up | When SYNC pin is asserted, continuous SYSERF pulses occur. Turning on and off of the pulses is synchronized to prevent runt pulses from occurring on SYSREF. |
| Continuous SYSREF | x | 3 | SYSREF_PD = 0 SYSREF_DDLY_PD = 0 SYSREF_PLSR_PD = 1 (1) | Continuous SYSREF signal. |

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Table 8-2. Some Possible SYNC Configurations (continued)

| NAME | SYNC_MODE | SYSREF_MUX | OTHER | DESCRIPTION |
|--------------------------------------|-----------|------------|--------------------|-------------------------------------------------------------|
| Re-clocked SYSREF distribution | 0 | 0 | SYSREE PLSR PD = 1 | Fan-out of CLKin0 reclocked to the clock distribution path. |

(1) SCLKX_Y_PD = 0 as required per SYSREF output. This applies to any SYNC or SYSREF output on SCLKX_Y when SCLKX_Y_MUX = 1 (SYSREF output)

Note

Because the SYNC/SYSREF signal is reclocked by the Clock Distribution Path, an active clock must be present on the Clock Distribution Path (either from VCO or Fin0/Fin1 pins in distribution mode) for SYNC to take effect.

Note

Any device clock divider or the SYSREF divider which does not have the SYNC_DISX bit or SYNC_DISSYSREF bit set will reset while SYNC/SYSREF Distribution Path is high. This is especially important for the SYSREF divider which has the ability to reset itself if the SYNC_DISSYSREF = 0! Be sure to set SYNC_DISX/SYNC_DISSYSREF bits as required.

Note

While using Divide-by-2 or Divide-by-3 for DCLK_X_Y_DIV, SYNC procedure requires to first program Divide-by-4 and then back to Divide-by-2 or Divide-by-3 before doing SYNC.

8.3.3 JEDEC JESD204B

8.3.3.1 How to Enable SYSREF

Table 8-3 summarizes the bits needed to make SYSREF functionality operational.

Table 8-3. SYSREF Bits

| REGISTER | FIELD | VALUE | DESCRIPTION |
|----------|--------------------|-------|------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| 0x140 | SYSREF_PD | 0 | Must be clear, power-up SYSREF circuitry including the SYSREF divider. |
| 0x140 | SYSREF_DDLY _PD | 0 | Must be clear to power-up digital delay circuitry. Must be powered up during initial SYNC to ensure deterministic timing to other clock dividers. |
| 0x143 | SYNC_EN | 1 | Must be set, enable SYNC. |
| 0x143 | SYSREF_CLR | 1 0 | Do not hold local SYSREF DDLY block in reset except at start. Anytime SYSREF_PD = 1 because of user programming or device RESET, it is necessary to set SYSREF_CLR for 15 VCO clock cycles to clear the local SYSREF digital delay. Once cleared, SYSREF_CLR must be cleared to allow SYSREF to operate. |

Enabling JESD204B operation involves synchronizing all the clock dividers with the SYSREF divider, then configuring the actual SYSREF functionality.

8.3.3.1.1 Setup of SYSREF Example

The following procedure is a programming example for a system which is to operate with a 3000-MHz VCO frequency. Use CLKout0 and CLKout2 to drive converters at 1500 MHz. Use CLKout4 to drive an FPGA at 150 MHz. Synchronize the converters and FPGA using a two SYSREF pulses at 10 MHz.

- 1. Program registers 0x000 to 0x555 (refer to Section 8.5.1). Key to prepare for SYSREF operations:
 - a. Prepare for manual SYNC: SYNC_POL = 0, SYNC_MODE = 1, SYSREF_MUX = 0
 - b. Setup output dividers as per example: DCLK0_1_DIV and DCLK2_3_DIV = 2 for frequency of 1500 MHz. DCLK4 5 DIV = 20 for frequency of 150 MHz.
 - c. Setup output dividers as per example: SYSREF DIV = 300 for 10-MHz SYSREF.



- d. Setup SYSREF: SYSREF_PD = 0, SYSREF_DDLY_PD = 0, DCLK0_1_DDLY_PD = 0, DCLK2_3_DDLY_PD = 0, DCLK4_5_DDLY_PD = 0, SYNC_EN = 1, SYSREF_PLSR_PD = 0, SYSREF_PULSE_CNT = 1 (2 pulses). SCLK0_1_PD = 0, SCLK2_3_PD = 0, SCLK4_5_PD = 0.
- e. Clear Local SYSREF DDLY: SYSREF CLR = 1.

2. Establish deterministic phase relationships between SYSREF and Device Clock for JESD204B:

- a. Set device clock and SYSREF divider digital delays: DCLK0_1_DDLY, DCLK2_3_DDLY, DCLK4_5_DDLY, and SYSREF_DDLY.
- b. Set device clock digital delay half steps: DCLK0_1_HS, DCLK2_3_HS, DCLK4_5_HS.
- c. Set SYSREF clock digital delay as required to achieve known phase relationships: SCLK0_1_DDLY, SCLK2_3_DDLY, and SCLK4_5_DDLY. If half step adjustments are required SCLK0_1_HS, SCLK2_3_HS, and SCLK4_5_HS.
- d. To allow SYNC to affect dividers: SYNC_DIS0 = 0, SYNC_DIS2 = 0, SYNC_DIS4 = 0, SYNC_DISSYSREF = 0.
- e. Perform SYNC by toggling SYNC_POL = 1 then SYNC_POL = 0.
- 3. Now that dividers are synchronized, **disable SYNC from resetting these dividers.** It is not desired for SYSREF to reset it's own divider or the dividers of the output clocks.
 - a. Prevent SYNC (SYSREF) from affecting dividers: SYNC_DIS0 = 1, SYNC_DIS2 = 1, SYNC_DIS4 = 1, SYNC_DISSYSREF = 1.

4. Release reset of local SYSREF digital delay.

 a. SYSREF_CLR = 0. Note this bit needs to be set for only 15 clock distribution path clocks after SYSREF PD = 0.

5. Set SYSREF operation.

- a. Allow pin SYNC event to start pulser: SYNC_MODE = 2.
- b. Select pulser as SYSREF signal: SYSREF MUX = 2.
- 6. Complete! Now asserting the SYNC pin, or toggling SYNC_POL will result in a series of 2 SYSREF pulses.

8.3.3.1.2 SYSREF_CLR

The local digital delay of the SCLKX_Y_DDLY is implemented as a shift buffer. To ensure no unwanted pulses occur at this SYSREF output at start-up, when using SYSREF, requires clearing the buffers by setting SYSREF_CLR = 1 for 15 VCO clock cycles. After a reset, this bit is set, so it must be cleared before SYSREF output is used.

If the SYSREF pulser is used. It is also required to set SYSREF_CLR = 1 for 15 VCO clock cycles after the SYSREF pulser is powered up.

8.3.3.2 SYSREF Modes

8.3.3.2.1 SYSREF Pulser

This mode allows for the output of 1, 2, 4, or 8 SYSREF pulses for every SYNC pin event or SPI programming. This implements the gapped periodic functionality of the JEDEC JESD204B specification.

When in SYSREF Pulser mode, programming the field SYSREF_PULSE_CNT in register 0x13E will result in the pulser sending the programmed number of pulses.

8.3.3.2.2 Continuous SYSREF

This mode allows for continuous output of the SYSREF clock.

Note

Continuous operation of SYSREF is not recommended due to crosstalk from the SYSREF clock to device clock. JESD204B is designed to operate with a single burst of pulses to initialize the system at start-up, after which it is theoretically not required to send another SYSREF because the system will continue to operate with deterministic phases.

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8.3.3.2.3 SYSREF Request

This mode allows an external source to synchronously turn on or off a continuous stream of SYSREF pulses using the SYNC/SYSREF REQ pin.

Setup the mode by programming SYSREF_REQ_EN = 1 and SYSREF_MUX = 2 (Pulser). The pulser does not need to be powered for this mode of operation.

When the SYSREF_REQ pin is asserted, the SYSREF_MUX will synchronously be set to continuous mode providing continuous pulses at the SYSREF frequency until the SYSREF_REQ pin is unasserted and the final SYSREF pulse will complete sending synchronously.

8.3.4 Digital Delay

Digital (coarse) delay allows a group of outputs to be delayed by 8 to 1023 clock distribution path cycles. The delay step can be as small as half the period of the clock distribution path cycle by using the DCLKX_Y_HS bit. There are two different ways to use the digital delay:

- 1. Fixed digital delay
- 2. Dynamic digital delay

In both delay modes, the regular clock divider is substituted with an alternative divide value.

8.3.4.1 Fixed Digital Delay

Fixed digital delay value takes effect on the clock outputs after a SYNC event. As such, the outputs will be LOW for a while during the SYNC event. Applications that cannot accept clock breakup when adjusting digital delay during application run time should use dynamic digital delay to adjust phase.

8.3.4.1.1 Fixed Digital Delay Example

Assuming the device already has the following initial configurations, and the application should delay CLKout2 by one VCO cycle compared to CLKout0.

- VCO frequency = 2949.12 MHz
- CLKout0 = 368.64 MHz (DCLK0_1_DIV = 8, CLKout0_SRC_MUX = 0 (Device Clock))
- CLKout2 = 368.64 MHz (DCLK2 3 DIV = 8, CLKout2 SRC MUX = 0 (Device Clock))

The following steps should be followed

- 1. Set DCLK0_1_DDLY = 8 and DCLK2_3_DDLY = 9. Static delay for each clock.
- 2. Set DCLK0 1 DDLY PD = 0 and DCLK2 3 DDLY PD = 0. Power up the digital delay circuit.
- 3. Set SYNC_DIS0 = 0 and SYNC_DIS2 = 0. Allow the outputs to be synchronized.
- 4. Perform SYNC by asserting, then unasserting SYNC. Either by using SYNC_POL bit or the SYNC pin.
- 5. Now that the SYNC is complete, to save power it is allowable to power down DCLK0_1_DDLY_PD = 1 and/or DCLK2_3_DDLY_PD = 1.
- 6. Set SYNC_DIS0 = 1 and SYNC_DIS2 = 1. Prevent the output from being synchronized, very important for steady-state operation when using JESD204B.

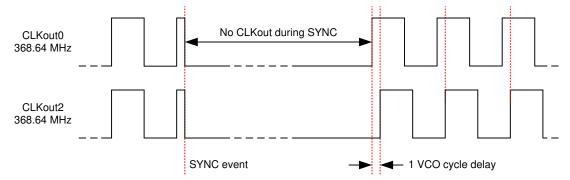


Figure 8-4. Fixed Digital Delay Example

8.3.4.2 Dynamic Digital Delay

Dynamic digital delay allows the phase of clocks to be changed with respect to each other with little impact to the clock signal.

For the device clock dividers this is accomplished by substituting the regular clock divider with an alternate divide value of one larger than the regular divider for one cycle. This substitution will occur a number of times equal to the value programmed into the DDLYd_STEP_CNT field for all outputs with DDLYdX_EN = 1.

For the SYSREF divider an alternate divide value will be substituted for the regular divide value. This substitution will occur a number of times equal to the value programmed into the DDLYd_STEP_CNT if DDLYd_SYSREF_EN = 1. To achieve one cycle delay as is done for the device clock dividers, set the SYSREF_DDLY value to one greater than SYSREF_DIV+SYSREF_DIV/2. For example, for a SYSREF divider of 100, to achieve 1 cycle delay, SYSREF DIV = 100 + 50 + 1 = 151.

While using the Dynamic Digital Delay feature, CLKin_OVERRIDE must be set to 0.

- By programming a larger alternate divider (delay) value, the phase of the adjusted outputs are delayed with respect to the other clocks.
- By programming a smaller alternate divider (delay) value, the phase of the adjusted outputs are advanced with respect to the other clocks.

8.3.4.3 Single and Multiple Dynamic Digital Delay Example

In this example, two separate adjustments are made to the device clocks. In the first adjustment, a single delay of 1 VCO cycle occurs between CLKout2 and CLKout0. In the second adjustment, two delays of 1 VCO cycle occur between CLKout2 and CLKout0. At this point in the example, CLKout2 is delayed 3 VCO cycles behind CLKout0.

Assuming the device already has the following initial configurations:

- VCO frequency: 2949.12 MHz
- CLKout0 = 368.64 MHz, DCLK0 1 DIV = 8
- CLKout2 = 368.64 MHz, DCLK2 3 DIV = 8

The following steps illustrate the example above:

- 1. Set DCLK2_3_DDLY = 4. First part of delay for CLKout2.
- 2. Set DCLK2 3 DDLY PD = 0. Enable the digital delay for CLKout2.
- 3. Set DDLYd0 EN = 0 and DDLYd2 EN = 1. Enable dynamic digital delay for CLKout2 but not CLKout0.
- 4. Set DDLYd_STEP_CNT = 1. This begins the **first adjustment**.

Before step 4, CLKout2 clock edge is aligned with CLKout0.

After step 4, CLKout2 counts nine clock distribution path cycles to the next rising edge, one greater than the divider value, effectively delaying CLKout2 by one VCO cycle with respect to CLKout0. **This is the first adjustment.**

5. Set DDLYd_STEP_CNT = 2. This begins the **second adjustment**.

Before step 5, CLKout2 clock edge was delayed 1 clock distribution path cycle from DCLKout0.

After step 5, CLKout2 counts nine clock distribution path cycles twice, each time one greater than the divide value, effectively delaying CLKout2 by two clock distribution path cycles with respect to CLKout0. **This is the second adjustment.**

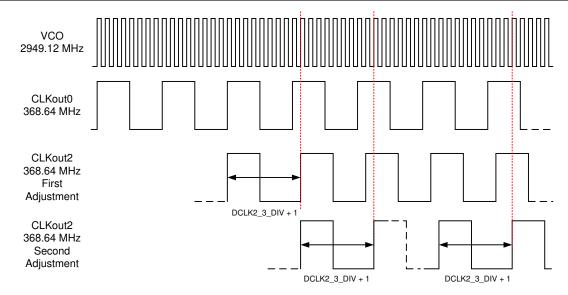


Figure 8-5. Single and Multiple Adjustment Dynamic Digital Delay Example

8.3.5 SYSREF to Device Clock Alignment

To ensure proper JESD204B operation, the timing relationship between the SYSREF and the Device clock must be adjusted for optimum setup and hold time as shown in Figure 8-6. The global SYSREF digital delay (SYSREF_DDLY), local SYSREF digital delay (SCLKX_Y_DDLY), local SYSREF half step (SCLKX_Y_HS), and local SYSREF analog delay (SCLKX_Y_ADLY, SCLK2_3_ADLY_EN) can be adjusted to provide the required setup and hold time between SYSREF and Device Clock. It is also possible to adjust the device clock digital delay (DCLKX_Y_DDLY) and half step (DCLK0_1_HS, DCLK0_1_DCC) to adjust phase with respect to SYSREF.

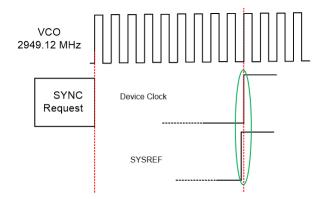


Figure 8-6. SYSREF to Device Clock Timing alignment

Depending on the DCLKout_X path settings, local SCLK_X_Y_DDLY might need adjustment factor. Following equation can be used to calculate the required Digital Delay Values to align SYSREF to the corresponding DCLKout:

SYSREF_DDLY > 7; SCLK_X_Y_DDLY > 1.

Table 8-4. DCLK_DIV_ADJUST

| DCLKX_Y_DIV | DCLK_DIV_ADJUST |
|-------------|-----------------|
| >6 | 0 |
| 6 | -1 |

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Table 8-4. DCLK_DIV_ADJUST (continued)

| DCLKX_Y_DIV | DCLK_DIV_ADJUST |
|-------------|-----------------|
| 5 | 3 |
| 4 | 0 |
| 3 (1) | -2 |
| 2 (1) | -2 |

(1) Refer to the SYNC requirement Section 8.3.2

Table 8-5. DCLK_HS_ADJUST

| DCLK & HS | DCLK_HS_ADJUST |
|-----------|----------------|
| 0 | 0 |
| 1 | 1 |

For example: DCLKX_Y_DIV = 32, DCLKX_Y_DDLY = 10, DCC&HS = 1;

SYSREF_DDLY=10 - 1 + 0 + 1 - 2 = 8

8.3.6 Input Clock Switching

Manual, pin select, and automatic are three different kinds clock input switching modes can be selected according to the combination of bits as illustrated in Figure 8-7.

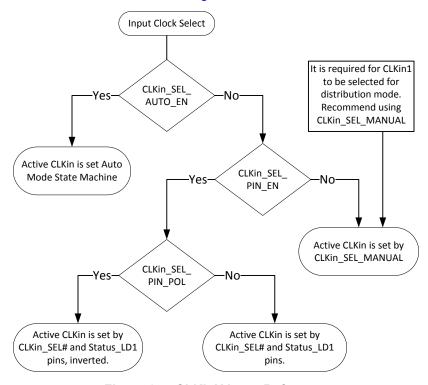


Figure 8-7. CLKinX Input Reference

The following sections provide information about how the active input clock is selected and what causes a switching event in the various clock input selection modes.

8.3.6.1 Input Clock Switching - Manual Mode

When CLKin_SEL_AUTO_EN = 0 and CLKin_SEL_PIN_EN = 0, the active CLKin is selected by CLKin_SEL_MANUAL. Programming a value of 0, 1, or 2 to CLKin_SEL_MANUAL causes CLKin0, CLKin1, or CLKin2, respectively, to be the selected active input clock. In this mode, the EN_CLKinX bits are overriden such that the CLKinX buffer operates even if CLKinX is disabled with EN_CLKinX = 0.

If holdover is entered in this mode by setting CLKin_SEL_MANUAL = 3, then the device will re-lock to the selected CLKin upon holdover exit.

8.3.6.2 Input Clock Switching - Pin Select Mode

When CLKin_SEL_AUTO_EN = 0 and CLKin_SEL_PIN_EN = 1, the active CLKin is selected by the CLKin SEL# and Status LD1 pins.

Configuring Pin Select Mode

The CLKin_SEL0_TYPE must be programmed to an input value for the CLKin_SEL0 pin to function as an input for pin select mode.

The CLKin_SEL1_TYPE must be programmed to an input value for the CLKin_SEL1 pin to function as an input for pin select mode.

The polarity of the clock input select pins can be inverted with the CLKin SEL PIN POL bit.

The pin select mode overrides the EN_CLKinX bits such that the CLKinX buffer operates even if CLKinX is disabled with EN_CLKinX = 0. To switch as fast as possible, keep the clock input buffers enabled (EN_CLKinX = 1) that could be switched to.

8.3.6.3 Input Clock Switching - Automatic Mode

When CLKin_SEL_AUTO_EN = 1, LOS_EN = 1, and HOLDOVER_EXIT_MODE = 0 (Exit based on LOS), the active clock is selected in priority order with CLKin0 being the highest priority, CLKin1 second, and CLKin2 third.

For a clock input to be eligible to be switched to, it must be enabled using EN_CLKinX. The LOS_TIMEOUT should also be set to a frequency below the input frequency.

To ensure LOS is valid for AC-coupled inputs, the MOS mode must be set for the CLKin and no termination is allowed to be between the pins unless the pins are DC.blocked. For example, no $100-\Omega$ termination across CLKin0 and CLKin0* pins on IC side of AC-coupling capacitors.

8.3.7 Digital Lock Detect

Both PLL1 and PLL2 support digital lock detect. Digital lock detect compares the phase between the reference path (R) and the feedback path (N) of the PLL. When the time error, which is phase error, between the two signals is less than a specified window size (ε) a lock detect count increments. When the lock detect count reaches a user specified value, PLL1_DLD_CNT or PLL2_DLD_CNT, lock detect is asserted true. Once digital lock detect is true, a single phase comparison outside the specified window will cause digital lock detect to be asserted false. This is illustrated in Figure 8-8.

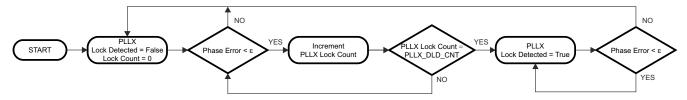


Figure 8-8. Digital Lock Detect Flowchart

This incremental lock detect count feature functions as a digital filter to ensure that lock detect is not asserted for only a brief time when the phases of R and N are within the specified tolerance for only a brief time during initial phase lock.

See Section 9.1.2 for more detailed information on programming the registers to achieve a specified frequency accuracy in ppm with lock detect.

The digital lock detect signal can be monitored on the Status_LD1 or Status_LD2 pin. The pin may be programmed to output the status of lock detect for PLL1, PLL2, or both PLL1 and PLL2.

8.3.7.1 Calculating Digital Lock Detect Frequency Accuracy

See Section 9.1.2 for more detailed information on programming the registers to achieve a specified frequency accuracy in ppm with lock detect.

The digital lock detect feature can also be used with holdover to automatically exit holdover mode. See Section 8.3.8.3 for more information.

8.3.8 Holdover

Holdover mode causes PLL2 to stay locked on frequency with minimal frequency drift when an input clock reference to PLL1 becomes invalid. While in holdover mode, the PLL1 charge pump is TRI-STATED and a fixed tuning voltage is set on CPout1 to operate PLL1 in open loop.

8.3.8.1 Enable Holdover

Program HOLDOVER EN = 1 to enable holdover mode.

Holdover mode can be configured to set the CPout1 voltage upon holdover entry to a fixed user defined voltage (EN MAN DAC = 1) or a tracked voltage (EN MAN DAC = 0).

8.3.8.1.1 Fixed (Manual) CPout1 Holdover Mode

By programming MAN DAC EN = 1, then the MAN DAC value will be set on the CPout1 pin during holdover.

The user can optionally enable CPout1 voltage tracking (TRACK_EN = 1), read back the tracked DAC value, then re-program MAN_DAC value to a user desired value based on information from previous DAC read backs. This allows the most user control over the holdover CPout1 voltage, but also requires more user intervention.

8.3.8.1.2 Tracked CPout1 Holdover Mode

By programming MAN_DAC_EN = 0 and TRACK_EN = 1, the tracked voltage of CPout1 is set on the CPout1 pin during holdover. When the DAC has acquired the current CPout1 voltage, the *DAC_Locked* signal is set, which may be observed on Status_LD1 or Status_LD2 pins by programming PLL1_LD_MUX or PLL2_LD_MUX, respectively.

Updates to the DAC value for the Tracked CPout1 sub-mode occurs at the rate of the PLL1 phase detector frequency divided by (DAC_CLK_MULT × DAC_CLK_CNTR).

The DAC update rate should be programmed for ≤ 100 kHz to ensure DAC holdover accuracy.

The ability to program slow DAC update rates, for example one DAC update per 4.08 seconds when using 1024-kHz PLL1 phase detector frequency with DAC_CLK_MULT = 16,384 and DAC_CLK_CNTR = 255, allows the device to *look-back* and set CPout1 at a previous *good* CPout1 tuning voltage values before the event which caused holdover to occur.

The current voltage of DAC value can be read back using RB DAC VALUE, see Section 8.6.2.9.6.

8.3.8.2 During Holdover

PLL1 is run in open-loop mode.

- PLL1 charge pump is set to TRI-STATE.
- PLL1 DLD is unasserted.
- · The HOLDOVER status is asserted
- During holdover, if PLL2 was locked prior to entry of holdover mode, PLL2 DLD continues to be asserted.
- CPout1 voltage is set to:
 - a voltage set in the MAN_DAC register (MAN_DAC_EN = 1).
 - a voltage determined to be the last valid CPout1 voltage (MAN DAC EN = 0).
- PLL1 attempts to lock with the active clock input.

The HOLDOVER status signal can be monitored on the Status_LD1 or Status_LD2 pin by programming the PLL1 DLD MUX or PLL2 DLD MUX register to *Holdover Status*.

8.3.8.3 Exiting Holdover

Holdover mode can be exited in one of two ways.

- Manually, by programming the device from the host.
- Automatically, when the LOS signal unasserts for a clock that provides a valid input to PLL1.

8.3.8.4 Holdover Frequency Accuracy and DAC Performance

When in holdover mode, PLL1 runs in open loop and the DAC sets the CPout1 voltage. If *fixed CPout1* mode is used, then the output of the DAC is dependant upon the MAN_DAC register. If *tracked CPout1* mode is used, then the output of the DAC is approximately the same voltage at the CPout1 pin before holdover mode was entered. When using Tracked mode and MAN_DAC_EN = 1, the DAC value during holdover is loaded with the programmed value in MAN_DAC and not the tracked value.

When in Tracked CPout1 mode, the DAC has a worst-case tracking error of ± 2 LSBs once PLL1 tuning voltage is acquired. The step size is approximately 3.2 mV, therefore the VCXO frequency error during holdover mode caused by the DAC tracking accuracy is ± 6.4 mV × Kv, where Kv is the tuning sensitivity of the VCXO in use. Therefore, the accuracy of the system when in holdover mode in ppm is:

Holdover accuracy (ppm) =
$$\frac{\pm 6.4 \text{ mV} \times \text{Kv} \times 1e6}{\text{VCXO Frequency}}$$
 (2)

As an example, consider a system with a 19.2-MHz clock input, a 153.6-MHz VCXO with a Kv of 17 kHz/V. The accuracy of the system in holdover in ppm is:

$$\pm 0.71 \text{ ppm} = \pm 6.4 \text{ mV} \times 17 \text{ kHz/V} \times 166 / 153.6 \text{ MHz}$$
 (3)

It is important to account for this frequency error when determining the allowable frequency error window to cause holdover mode to exit.

8.3.9 PLL2 Loop Filter

PLL2 has an integrated loop filter of C1i = 60 pF, R3 = 2400 Ω , C3 = 50 pF, R4 = 200 Ω and C4 = 10 pF as shown in Figure 8-9. Loop filter components C1, C2, and R2 can be solved using TI software. See Section 12.1 for more information.

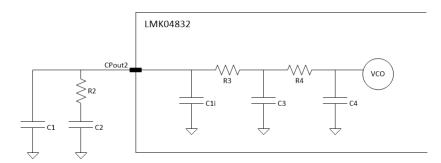


Figure 8-9. PLL2 On-Chip Loop Filter

8.4 Device Functional Modes

The LMK04832-SP is a flexible device that can be configured for many different use cases. The following simplified block diagrams help show the user the different use cases of the device.

8.4.1 DUAL PLL

8.4.1.1 Dual Loop

Figure 8-10 illustrates the typical use case of dual loop mode. In dual loop mode, the reference to PLL1 is from CLKin0, CLKin1, or CLKin2. An external VCXO is used to provide feedback for the first PLL and a reference to the second PLL. This first PLL cleans the jitter with the VCXO by using a narrow loop bandwidth. The VCXO may be buffered through the OSCout port. The VCXO is used as the reference to PLL2 and may be doubled using the frequency doubler. The internal VCO drives up to seven divide/delay blocks which drive up to 14 clock outputs.

Hitless switching and holdover functionality are optionally available when the input reference clock is lost. Holdover works by forcing a DAC voltage to the tuning voltage of the VCXO.

It is also possible to use an external VCO in place of PLL2's internal VCO. In this case one less CLKin is available as a reference as CLKin1 is used for external input.

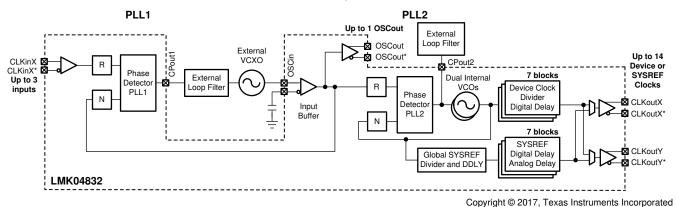


Figure 8-10. Simplified Functional Block Diagram for Dual Loop Mode

8.4.1.2 Dual Loop With Cascaded 0-Delay

Figure 8-11 illustrates the use case of cascaded 0-delay dual loop mode. This configuration differs from dual loop mode Figure 8-10 in that the feedback for PLL2 is driven by a clock output instead of the VCO output directly.

It is also possible to use an external VCO in place of the internal VCO of the PLL2, but one less CLKin is available as a reference and the external 0-delay feedback is not available.

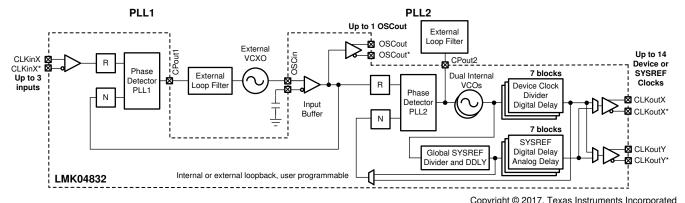


Figure 8-11. Simplified Functional Block Diagram for Cascaded 0-Delay Dual Loop Mode

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8.4.1.3 Dual Loop With Nested 0-Delay

Figure 8-12 illustrates the use case of nested 0-delay dual loop mode. This configuration is similar to the dual PLL in Figure 8-10 except that the feedback to the first PLL is driven by a clock output. The PLL2 reference OSCin is not deterministic to the CLKin or feedback clock.

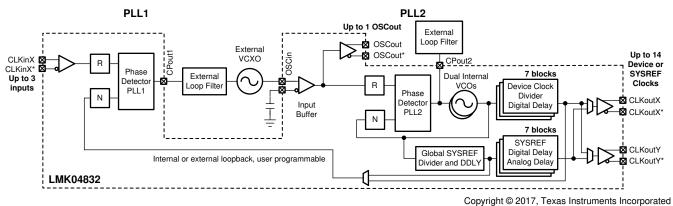


Figure 8-12. Simplified Functional Block Diagram for Nested 0-Delay Dual Loop Mode

8.4.2 Single PLL

8.4.2.1 PLL2 Single Loop

Figure 8-13 illustrates the use case of PLL2 single loop mode. When used with a high-frequency clean reference performance as good as dual loop mode may be achieved. Traditionally the OSCin is used as a reference to PLL2, but it is also possible to use CLKinX as a reference to PLL2.

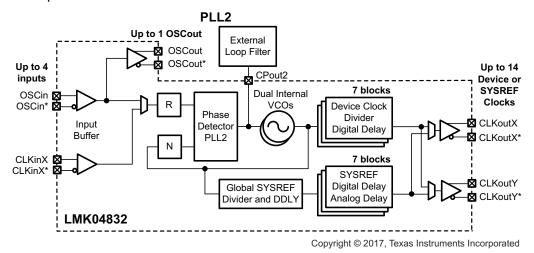


Figure 8-13. Simplified Functional Block Diagram for Single Loop Mode

8.4.2.2 PLL2 With External VCO

Adding an external VCO is possible using the Fin0/Fin1 input pins. The input may be single-ended or differential. At high frequency the input impedance to Fin0/Fin1 is low, a resistive pad is recommended for matching.

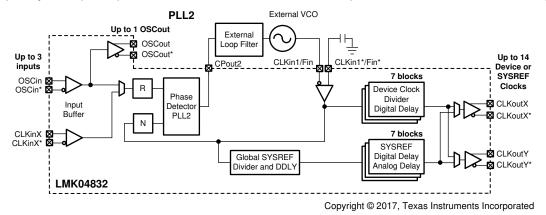


Figure 8-14. Simplified Functional Block Diagram for Single Loop Mode With External VCO

8.4.3 Distribution Mode

Figure 8-15 illustrates the use case of distribution mode. As in all the other use cases, OSCin to OSCout can be used as a buffer to OSCin or from clock distribution path through CLKout6, CLKout8, or the SYSREF divider.

At high frequency, the input impedance to Fin0/Fin1 is low and a resistive pad is recommended for matching.

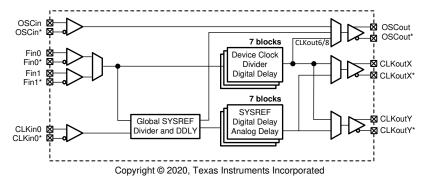


Figure 8-15. Simplified Functional Block Diagram for Distribution Mode

8.5 Programming

The LMK04832 device is programmed using 24-bit registers. Each register consists of a 1-bit command field (R/W), a 15-bit address field (A14 to A0) and a 8-bit data field (D7 to D0). The contents of each register is clocked in MSB first (R/W), and the LSB (D0) last. During programming, the CS* signal is held low. The serial data is clocked in on the rising edge of the SCK signal. After the LSB is clocked in, the CS* signal goes *high* to latch the contents into the shift register. TI recommends to program registers in numeric order (for example, 0x000 to 0x555 with exceptions noted in the Section 8.5.1). Each register consists of one or more fields which control the device functionality. See the Section 6.5 section and Figure 6-1 for timing details.

8.5.1 Recommended Programming Sequence

Registers are generally programmed in numeric order with 0x000 being the first and 0x555 being the last register programmed. The recommended programming sequence from POR involves:

- 1. Program register 0x000 with RESET = 1.
- 2. Program defined registers from 0x000 to 0x165.
- 3. If PLL2 is used, program 0x173 with PLL2_PD and PLL2_PRE_PD clear to allow PLL2 to lock after PLL2_N is programmed.
- 4. Continue programming defined registers from 0x166 to 0x555.

Note

When using the internal VCO, PLL2_N registers 0x166, 0x167, and 0x168 must be programmed after other PLL2 dividers are programed to ensure proper VCO frequency calibration. This is also true for PLL2_N_CAL registers 0x163, 0x164, 0x165 when PLL2_NCLK_MUX = 1. So if any divider such as PLL2_R is altered to change the VCO frequency, the VCO calibration must be run again by programming PLL2_N.

Power up PLL2 by setting PLL2_PRE_PD = 0 and PLL2_PD = 0 in register 0x173 before programming PLL2_N.



8.6 Register Maps

8.6.1 Register Map for Device Programming

Table 8-6 provides the register map for device programming. Any register can be read from the same data address it is written to.

Table 8-6. Register Map

| | | | Tab | le 8-6. Regis | ter map | | | |
|-------------------|--------------|-------------------|---------------------|---------------------|-------------|--------------|-------------|---------------|
| ADDRESS [14:0] | | | | DATA | A[7:0] | | | |
| 23:8 | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
| 0x000 | RESET | 0 | 0 | SPI_3WIRE _DIS | 0 | 0 | 0 | 0 |
| 0x002 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | POWER DOWN |
| 0x003 | | | • | ID_DEVI | CE_TYPE | • | | |
| 0x004 | | | | ID_PRO | DD[15:8] | | | |
| 0x005 | | | | ID_PR | OD[7:0] | | | |
| 0x006 | | | | ID_MA | SKREV | | | |
| 0x00C | | | | ID_VNE | DR[15:8] | | | |
| 0x00D | | | | ID_VN | DR[7:0] | | | |
| 0x100 | | | | DCLK0_1 | _DIV[7:0] | | | |
| 0x101 | | | | DCLK0_1_ | _DDLY[7:0] | | | |
| 0x102 | CLKout0_1_PD | CLKout0_1_OD L | CLKout0_1_IDL | DCLK0_1_DDLY _PD | DCLK0_1_ | _DDLY[9:8] | DCLK0_1 | _DIV[9:8] |
| 0x103 | 0 | 1 | CLKout0_SRC_ MUX | DCLK0_1_PD | DCLK0_1_BYP | DCLK0_1_DCC | DCLK0_1_POL | DCLK0_1_HS |
| 0x104 | 0 | 0 | CLKout1_SRC_ MUX | SCLK0_1_PD | SCLK0_1_I | DIS_MODE | SCLK0_1_POL | SCLK0_1_HS |
| 0x105 | 0 | 0 | SCLK0_1_ADLY _EN | | | SCLK0_1_ADLY | | |
| 0x106 | 0 | 0 | 0 | 0 | | SCLK0_ | _1_DDLY | |
| 0x107 | | CLKou | t1_FMT | 1 | | CLKou | t0_FMT | |
| 0x108 | | | | DCLK2_3 | B_DIV[7:0] | | | |
| 0x109 | | | | DCLK2_3_ | _DDLY[7:0] | | | |
| 0x10A | CLKout2_3_PD | CLKout2_3_OD L | CLKout2_3_IDL | DCLK2_3_DDLY _PD | DCLK2_3_ | _DDLY[9:8] | DCLK2_3 | _DIV[9:8] |
| 0x10B | 0 | 1 | CLKout2_SRC_ MUX | DCLK2_3_PD | DCLK2_3_BYP | DCLK2_3_DCC | DCLK2_3_POL | DCLK2_3_HS |
| 0x10C | 0 | 0 | CLKout3_SRC_ MUX | SCLK2_3_PD | SCLK2_3_I | DIS_MODE | SCLK2_3_POL | SCLK2_3_HS |
| 0x10D | 0 | 0 | SCLK2_3_ADLY _EN | | | SCLK2_3_ADLY | | |
| 0x10E | 0 | 0 | 0 | 0 | | SCLK2_ | 3_DDLY | |
| 0x10F | | CLKou | 3_FMT | | | CLKou | t2_FMT | |
| 0x110 | | | | DCLK4_5 | 5_DIV[7:0] | | | |
| 0x111 | | | | DCLK4_5_ | _DDLY[7:0] | | | |
| 0x112 | CLKout4_5_PD | CLKout4_5_OD L | CLKout4_5_IDL | DCLK4_5_DDLY _PD | DCLK4_5_ | _DDLY[9:8] | DCLK4_5 | 5_DIV[9:8] |
| 0x113 | 0 | 1 | CLKout4_SRC_ MUX | DCLK4_5_PD | DCLK4_5_BYP | DCLK4_5_DCC | DCLK4_5_POL | DCLK4_5_HS |
| 0x114 | 0 | 0 | CLKout5_SRC_ MUX | SCLK4_5_PD | SCLK4_5_I | DIS_MODE | SCLK4_5_POL | SCLK4_5_HS |
| 0x115 | 0 | 0 | SCLK4_5_ADLY _EN | | | SCLK4_5_ADLY | | |
| 0x116 | 0 | 0 | 0 | 0 | | SCLK4_ | 5_DDLY | |
| 0x117 | | CLKou | t5_FMT | | | CLKou | t4_FMT | |
| 0x118 | | | | DCLK6_7 | Z_DIV[7:0] | | | |
| 0x119 | | | | DCLK6_7 | _DDLY[7:0] | | | |



Table 8-6. Register Map (continued)

| ADDRESS [14:0] | | | 14515 5 5. | Register Ma | A[7:0] | <i>~</i> , | | |
|-------------------|--------------------|---------------------|-----------------------|-----------------------|-------------------|-------------------|-------------------|--------------|
| 23:8 | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
| 0x11A | CLKout6_7_PD | CLKout6_7_OD L | CLKout6_7_IDL | DCLK6_7_DDLY _PD | DCLK6_7_ | _DDLY[9:8] | DCLK6_7 | |
| 0x11B | 0 | 1 | CLKout6_SRC_ MUX | DCLK6_7_PD | DCLK6_7_BYP | DCLK6_7_DCC | DCLK6_7_POL | DCLK6_7_HS |
| 0x11C | 0 | 0 | CLKout7_SRC_ MUX | SCLK6_7_PD | SCLK6_7_I | DIS_MODE | SCLK6_7_POL | SCLK6_7_HS |
| 0x11D | 0 | 0 | SCLK6_7_ADLY _EN | | | SCLK6_7_ADLY | | |
| 0x11E | 0 | 0 | 0 | 0 | | SCLK6_ | 7_DDLY | |
| 0x11F | | CLKout | 7_FMT | | | CLKou | t6_FMT | |
| 0x120 | | | | DCLK8_9 |)_DIV[7:0] | | | |
| 0x121 | | | | DCLK8_9 | _DDLY[7:0] | | | |
| 0x122 | CLKout8_9_PD | CLKout8_9_OD L | CLKout8_9_IDL | DCLK8_9_DDLY _PD | DCLK8_9_ | _DDLY[9:8] | DCLK8_9 | 0_DIV[9:8] |
| 0x123 | 0 | 1 | CLKout8_SRC_ MUX | DCLK8_9_PD | DCLK8_9_BYP | DCLK8_9_DCC | DCLK8_9_POL | DCLK8_9_HS |
| 0x124 | 0 | 0 | CLKout9_SRC_ MUX | SCLK8_9_PD | SCLK8_9_I | DIS_MODE | SCLK8_9_POL | SCLK8_9_HS |
| 0x125 | 0 | 0 | SCLK8_9_ADLY _EN | | | SCLK8_9_ADLY | | |
| 0x126 | 0 | 0 | 0 | 0 | | SCLK8_ | 9_DDLY | |
| 0x127 | | CLKout | 9_FMT | | | CLKou | t8_FMT | |
| 0x128 | | | | DCLK10_1 | 11_DIV[7:0] | | | |
| 0x129 | | | | DCLK10_11 | I_DDLY[7:0] | | | |
| 0x12A | CLKout10_11_P D | CLKout10_11_O DL | CLKout10_11_I DL | DCLK10_11_DD LY_PD | DCLK10_11 | _DDLY[9:8] | DCLK10_1 | 1_DIV[9:8] |
| 0x12B | 0 | 1 | CLKout10_SRC _MUX | DCLK10_11_PD | DCLK10_11_BY P | DCLK10_11_DC C | DCLK10_11_PO L | DCLK10_11_HS |
| 0x12C | 0 | 0 | CLKout11_SRC _MUX | SCLK10_11_PD | SCLK10_11 | _DIS_MODE | SCLK10_11_PO L | SCLK10_11_HS |
| 0x12D | 0 | 0 | SCLK10_11_AD LY_EN | | | SCLK10_11_ADLY | , | |
| 0x12E | 0 | 0 | 0 | 0 | | SCLK10_ | 11_DDLY | |
| 0x12F | | CLKout ² | 11_FMT | | | CLKout | 10_FMT | |
| 0x130 | | | | DCLK12_1 | 3_DIV[7:0] | | | |
| 0x131 | | | | DCLK12_13 | 3_DDLY[7:0] | | | |
| 0x132 | CLKout12_13_P D | CLKout12_13_O DL | CLKout12_13_I DL | DCLK12_13_DD LY_PD | DCLK12_13 | 3_DDLY[9:8] | DCLK12_1 | 3_DIV[9:8] |
| 0x133 | 0 | 1 | CLKout12_SRC _MUX | DCLK12_13_PD | DCLK12_13_BY P | DCLK12_13_DC C | DCLK12_13_PO L | DCLK12_13_HS |
| 0x134 | 0 | 0 | CLKout13_SRC _MUX | SCLK12_13_PD | SCLK12_13 | _DIS_MODE | SCLK12_13_PO L | SCLK12_13_HS |
| 0x135 | 0 | 0 | SCLK12_13_AD LY_EN | | SCLK12_13_ADLY | | | |
| 0x136 | 0 | 0 | 0 | 0 | | SCLK12_ | 13_DDLY | |
| 0x137 | | CLKout ² | 13_FMT | | | CLKout | 12_FMT | |
| 0x138 | 0 | VCO_ | MUX | OSCout_MUX | | OSCou | ut_FMT | |
| 0x139 | 0 | 0 | 0 | SYSREF_REQ_ EN | SYNC_BYPASS | 0 | SYSRE | F_MUX |
| 0x13A | 0 | 0 | 0 | | | SYSREF_DIV[12:8 | i] | |
| 0x13B | | | | SYSREF | _DIV[7:0] | | | |
| 0x13C | 0 | 0 | 0 | | S | YSREF_DDLY[12: | 8] | |
| 0x13D | | | | SYSREF_ | DDLY[7:0] | | | |
| 0x13E | 0 | 0 | 0 | 0 | 0 | SY | /SREF_PULSE_C | NT |

Table 8-6. Register Map (continued)

| | | | Table 8-6. | Register Ma | ap (continue | a) | | |
|-------------------|----------------------------------|-----------------------|------------------------|-----------------------|------------------------|------------------------|-------------------------|--------------------|
| ADDRESS [14:0] | | | | DATA | A [7:0] | | | |
| 23:8 | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
| 0x13F | PLL2_RCLK_ MUX | 0 | PLL2_NCLK_ MUX | PLL1_NO | CLK_MUX | FB_ | MUX | FB_MUX_EN |
| 0x140 | PLL1_PD | VCO_LDO_PD | VCO_PD | OSCin_PD | SYSREF_GBL_ PD | SYSREF_PD | SYSREF_DDLY _PD | SYSREF_PLSR _PD |
| 0x141 | DDLYd_ SYSREF_EN | DDLYd12_EN | DDLYd10_EN | DDLYd8_EN | DDLYd6_EN | DDLYd4_EN | DDLYd2_EN | DDLYd0_EN |
| 0x142 | | | | DDLYd_S | TEP_CNT | | | |
| 0x143 | SYSREF_CLR | SYNC_1SHOT_ EN | SYNC_POL | SYNC_EN | SYNC_PLL2_ DLD | SYNC_PLL1_ DLD | SYNC_ | MODE |
| 0x144 | SYNC_DISSYS REF | SYNC_DIS12 | SYNC_DIS10 | SYNC_DIS8 | SYNC_DIS6 | SYNC_DIS4 | SYNC_DIS2 | SYNC_DIS0 |
| 0x145 | 2 | PLL1R_SYNC_ EN | PLL1R_S\ | YNC_SRC | PLL2R_SYNC_ EN | FIN0_DIV2_EN | FIN0_INP | UT_TYPE |
| 0x146 | CLKin_SEL_PIN _EN | CLKin_SEL_PIN _POL | CLKin2_EN | CLKin1_EN | CLKin0_EN | CLKin2_TYPE | CLKin1_TYPE | CLKin0_TYPE |
| 0x147 | CLKin_SEL_ AUTO_ REVERT_EN | CLKin_SEL_ AUTO_EN | CLKin_SEL | _MANUAL | CLKin1_ | _DEMUX | CLKin0_ | DEMUX |
| 0x148 | 0 | 0 | (| CLKin_SEL0_MU | < | (| CLKin_SEL0_TYPE | Ξ |
| 0x149 | 0 | SDIO_RDBK_ TYPE | | CLKin_SEL1_MUX | < | (| CLKin_SEL1_TYPE | <u> </u> |
| 0x14A | 0 | 0 | | RESET_MUX | | | RESET_TYPE | |
| 0x14B | LOS_TI | MEOUT | LOS_EN | TRACK_EN | HOLDOVER_ FORCE | MAN_DAC_EN | MAN_D | AC[9:8] |
| 0x14C | | | | MAN_DAC[7:0] | | | | |
| 0x14D | 0 | 0 | | | DAC_TF | RIP_LOW | | |
| 0x14E | DAC_CL | K_MULT | DAC_TRIP_HIGH | | | | | |
| 0x14F | | | | DAC_CL | K_CNTR | | | |
| 0x150 | 0 | CLKin_OVERRI DE | HOLDOVER_ EXIT_MODE | HOLDOVER_ PLL1_DET | LOS_EXTERNA L_INPUT | HOLDOVER_ VTUNE_DET | CLKin_SWITCH _CP_TRI | HOLDOVER_ EN |
| 0x151 | 0 | 0 | | | HOLDOVER_[| DLD_CNT[13:8] | | |
| 0x152 | | | | HOLDOVER_ | DLD_CNT[7:0] | | | |
| 0x153 | 0 | 0 | | | CLKin0 | _R[13:8] | | |
| 0x154 | | | | CLKin(|)_R[7:0] | | | |
| 0x155 | 0 | 0 | | | CLKin1 | _R[13:8] | | |
| 0x156 | | | | CLKin1 | L_R[7:0] | | | |
| 0x157 | 0 | 0 | | | CLKin2 | _R[13:8] | | |
| 0x158 | | | | CLKin2 | 2_R[7:0] | | | |
| 0x159 | 0 | 0 | | | PLL1_ | N[13:8] | | |
| 0x15A | | | PLL1_N[7:0] | | | | | |
| 0x15B | PLL1_W | ND_SIZE | PLL1_CP_TRI | PLL1_CP_POL | | PLL1_C | P_GAIN | |
| 0x15C | 0 | 0 | | | PLL1_DLD | _CNT[13:8] | | |
| 0x15D | | | | PLL1_DL | D_CNT[7:0] | | | |
| 0x15E | 0 | 0 | 0 | | НО | LDOVER_EXIT_N | | |
| 0x15F | | | PLL1_LD_MUX | | | | PLL1_LD_TYPE | |
| 0x160 | 0 | 0 | 0 | 0 | | PLL | .2_R | |
| 0x161 | | | | PLL | .2_R | | | |
| 0x162 | | PLL2_P | | 0 | OSCin | _FREQ | PLL2_XTAL_EN | PLL2_REF_2X_ EN |
| 0x163 | 0 | 0 | 0 | 0 | 0 | 0 | PLL2_N_C | CAL[17:16] |
| 0x164 | | | | PLL2_N_ | CAL[15:8] | | | |
| 0x165 | | | | PLL2_N | _CAL[7:0] | | | |
| 0x166 | 0 | 0 | 0 | 0 | 0 | 0 | PLL2_N | N[17:16] |



Table 8-6. Register Map (continued)

| ADDRESS [14:0] | | | | DATA | A[7:0] | | | |
|-------------------|-------------------|-------------|-------------------|-------------------|----------------------|-------------------|----------------------|----------------------|
| 23:8 | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
| 0x167 | | | | PLL2_ | N[15:8] | | | |
| 0x168 | | | | PLL2 | _N[7:0] | | | |
| 0x169 | 0 | PLL2_WI | ND_SIZE | PLL2_C | P_GAIN | PLL2_CP_POL | PLL2_CP_TRI | PLL2_DLD_EN |
| 0x16A | 0 | 0 | | | PLL2_DLD | _CNT[13:8] | | |
| 0x16B | | | | PLL2_DL | D_CNT[7:0] | | | |
| 0x16C | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| 0x173 | 0 | PLL2_PRE_PD | PLL2_PD | FIN0_PD | 0 | 0 | 0 | 0 |
| 0x177 | | | PLL1R_RST | | | | | |
| 0x182 | 0 | 0 | 0 | 0 | 0 | 0 | CLR_PLL1_LD_ LOST | CLR_PLL2_LD_ LOST |
| 0x183 | 0 | 0 | 0 | 0 | RB_PLL1_DLD_ LOST | RB_PLL1_DLD | RB_PLL2_DLD_ LOST | RB_PLL2_DLD |
| 0x184 | RB_DAC_VALUE[9:8] | | RB_CLKin2_ SEL | RB_CLKin1_ SEL | RB_CLKin0_ SEL | RB_CLKin2_ LOS | RB_CLKin1_ LOS | RB_CLKin0_ LOS |
| 0x185 | ' | | | RB_DAC_ | VALUE[7:0] | | • | |
| 0x188 | 0 | х | RB_ HOLDOVER | х | RB_DAC_RAIL | RB_DAC_HIGH | RB_DAC_LOW | RB_DAC_ LOCKED |
| 0x555 | | | | SPI_ | LOCK | | | |

8.6.2 Device Register Descriptions

The following section details the fields of each register, the Power-On-Reset Defaults, and specific descriptions of each bit.

In some cases similar fields are located in multiple registers. In this case specific outputs may be designated as X or Y. In these cases, the X represents even numbers from 0 to 12 and the Y represents odd numbers from 1 to 13. In the case where X and Y are both used in a bit name, then Y = X + 1.

8.6.2.1 System Functions

8.6.2.1.1 RESET, SPI_3WIRE_DIS

This register contains the RESET function and the ability to turn off 3-wire SPI mode. To use a 4-wire SPI mode, selecting SPI Read back in one of the output MUX settings. For example CLKin0_SEL_MUX or RESET_MUX. It is possible to have 3-wire and 4-wire readback at the same time.

Table 8-7. Register 0x000

| BIT | NAME | POR DEFAULT | DESCRIPTION |
|-----|----------------------------------------------|-------------|-------------------------------------------------------------------------|
| 7 | 7 RESET 0 1: 6:5 NA 0 R 4 SPI_3WIRE_DIS 0 0: | | 0: Normal operation 1: Reset (automatically cleared) |
| 6:5 | | | Reserved |
| 4 | | | Disable 3-wire SPI mode. 0: 3 Wire Mode enabled 1: 3 Wire Mode disabled |
| 3:0 | NA | NA | Reserved |

8.6.2.1.2 **POWERDOWN**

This register contains the POWERDOWN function.

Table 8-8. Register 0x002

| E | ЗІТ | NAME | POR DEFAULT | DESCRIPTION |
|---|-----|-----------|-------------|-------------------------------------------|
| | 7:1 | NA | 0 | Reserved |
| | 0 | POWERDOWN | () | 0: Normal operation 1: Power down device. |

8.6.2.1.3 ID_DEVICE_TYPE

This register contains the product device type. This is read only register.

Table 8-9. Register 0x003

| BIT | NAME | POR DEFAULT | DESCRIPTION |
|-----|----------------|-------------|--------------------------|
| 7:0 | ID_DEVICE_TYPE | 6 | PLL product device type. |



8.6.2.1.4 ID_PROD

These registers contain the product identifier. This is a read only register.

Table 8-10. ID_PROD Field Registers

| MSB | LSB |
|----------------------------|---------------------------|
| 0x004[7:0] / ID_PROD[15:8] | 0x005[7:0] / ID_PROD[7:0] |

Table 8-11. Registers 0x004 and 0x005

| | REGISTER | BIT | FIELD NAME | POR DEFAULT | DESCRIPTION |
|---|----------|-----|---------------|-------------|--------------------------------|
| | 0x004 | 7:0 | ID_PROD[15:8] | 209 (0xD1) | MSB of the product identifier. |
| Ī | 0x005 | 7:0 | ID_PROD[7:0] | 99 (0x63) | LSB of the product identifier. |

8.6.2.1.5 ID_MASKREV

This register contains the IC version identifier. This is a read only register.

Table 8-12. Register 0x006

| BIT | NAME | POR DEFAULT | DESCRIPTION | | |
|-----|------------|-------------|-----------------------|--|--|
| 7:0 | ID_MASKREV | 112 (0x70) | IC version identifier | | |

8.6.2.1.6 ID_VNDR

These registers contain the vendor identifier. This is a read only register.

Table 8-13. ID_VNDR Field Registers

| MSB | LSB |
|----------------------------|---------------------------|
| 0x00C[7:0] / ID_VNDR[15:8] | 0x00D[7:0] / ID_VNDR[7:0] |

Table 8-14. Registers 0x00C, 0x00D

| REGISTER | BIT | NAME | POR DEFAULT | DESCRIPTION |
|----------|-----|---------------|-------------|-------------------------------|
| 0x00C | 7:0 | ID_VNDR[15:8] | 81 (0x51) | MSB of the vendor identifier. |
| 0x00D | 7:0 | ID_VNDR[7:0] | 4 (0x04) | LSB of the vendor identifier. |

8.6.2.2 (0x100 - 0x138) Device Clock and SYSREF Clock Output Controls 8.6.2.2.1 DCLKX_Y_DIV

The device clock divider can drive up to two outputs, an even (X) and an odd (Y) clock output. Divide is a 10 bit number and split across two registers.

Table 8-15. DCLKX_Y_DIV Field Registers

| MSB | LSB |
|----------------------------------|---------------------------------|
| 0x0102[1:0] = DCLK0_1_DIV[9:8] | 0x100[7:0] = DCLK0_1_DIV[7:0] |
| 0x010A[1:0] = DCLK2_3_DIV[9:8] | 0x108[7:0] = DCLK2_3_DIV[7:0] |
| 0x0112[1:0] = DCLK4_5_DIV[9:8] | 0x110[7:0] = DCLK4_5_DIV[7:0] |
| 0x011A[1:0] = DCLK6_7_DIV[9:8] | 0x118[7:0] = DCLK6_7_DIV[7:0] |
| 0x0122[1:0] = DCLK8_9_DIV[9:8] | 0x120[7:0] = DCLK8_9_DIV[7:0] |
| 0x012A[1:0] = DCLK10_11_DIV[9:8] | 0x128[7:0] = DCLK10_11_DIV[7:0] |
| 0x0132[1:0] = DCLK12_13_DIV[9:8] | 0x130[7:0] = DCLK12_13_DIV[7:0] |

Table 8-16. Registers 0x100, 0x108, 0x110, 0x118, 0x120, 0x128, and 0x130 0x102, 0x10A, 0x112, 0x11A, 0x122, 0x12A, 0x132

| REGISTER | BIT | NAME | POR DEFAULT | DESCRIPTION | |
|----------------------------|-----|----------------------|------------------------------------------------------------|-------------------------------------------------------------------------------------------------------------------------------------------------------|---------------|
| 0x102, 0x10A, 0x112, | 1:0 | DCLKX Y DIV[9:8] | | DCLKX_Y_DIV sets the divide value for the clo may be even or odd. Both even or odd divides of cycle clock if duty cycle correction (DCC) is ena | |
| 0x11A, 0x122, | 1.0 | DOLIVI_1_DIV[0:0] | $X_Y = 0_1 \rightarrow 2$ $X_Y = 2 \rightarrow 4$ | Field Value | Divider Value |
| 0x12A, 0x132 | | | $X_1 = 2_5 \rightarrow 4$ $X_2 = 4_5 \rightarrow 8$ | 0 (0x00) | Reserved |
| 0x100, | | 7:0 DCLKX_Y_DIV[7:0] | $X_Y = 6_7 \rightarrow 8$ | 1 (0x01) | 1 (1) |
| 0x108, | | | $X_Y = 8_9 \rightarrow 8$ $X_Y = 10 \ 11 \rightarrow 8$ | 2 (0x02) | 2 |
| 0x110, 0x118, 0x120, | 7:0 | | $X_Y = 12_{13} \rightarrow 2$ | | |
| 0x128, and | | | | 1022 (0x3FE) | 1022 |
| 0x130 | | | | 1023 (0x3FF) | 1023 |

⁽¹⁾ Duty cycle correction must also be enabled, DCLKX_Y_DCC = 1.



8.6.2.2.2 DCLKX_Y_DDLY

This register controls the digital delay for the device clock outputs.

Table 8-17. DCLKX_Y_DDLY Field Registers

| | - |
|-----------------------------------|----------------------------------|
| MSB | LSB |
| 0x0102[2:3] = DCLK0_1_DDLY[9:8] | 0x101[7:0] = DCLK0_1_DDLY[7:0] |
| 0x010A[2:3] = DCLK2_3_DDLY[9:8] | 0x109[7:0] = DCLK2_3_DDLY[7:0] |
| 0x0112[2:3] = DCLK4_5_DDLY[9:8] | 0x111[7:0] = DCLK4_5_DDLY[7:0] |
| 0x011A[2:3] = DCLK6_7_DDLY[9:8] | 0x119[7:0] = DCLK6_7_DDLY[7:0] |
| 0x0122[2:3] = DCLK8_9_DDLY[9:8] | 0x121[7:0] = DCLK8_9_DDLY[7:0] |
| 0x012A[2:3] = DCLK10_11_DDLY[9:8] | 0x129[7:0] = DCLK10_11_DDLY[7:0] |
| 0x0132[2:3] = DCLK12_13_DDLY[9:8] | 0x131[7:0] = DCLK12_13_DDLY[7:0] |

Table 8-18. Registers 0x101, 0x109, 0x111, 0x119, 0x121, 0x129, 0x131 0x102, 0x10A, 0x112, 0x11A, 0x122, 0x12A, 0x132

| REGISTER | BIT | NAME | POR DEFAULT | DESCRIPTION | |
|-------------------------|-----|---------------------|------------------------------------|--------------|-----------------|
| 0x102, | | | Static digital delay which takes e | | t after a SYNC. |
| 0x10A, 0x112, | | | | Field Value | Delay Values |
| 0x11A, | 2:3 | DCLKX_Y_DDLY[9:8] | | 0 (0x00) | Reserved |
| 0x122, 0x12A, 0x132 | | | | 1 (0x01) | Reserved |
| UX 12A, UX 132 | | | | | |
| | | | 10 (0x0A) | 7 (0x07) | Reserved |
| 0x101, | 7:0 | 0 DCLKX_Y_DDLY[7:0] | | 8 (0x08) | 8 |
| 0x109, 0x111, 0x119, | | | | 9 (0x09) | 9 |
| 0x121, | | | | | |
| 0x129, 0x131 | | | | 1022 (0x3FE) | 1022 |
| | | | | 1023 (0x3FF) | 1023 |

Depending on the DCLK divide value, there may be an adjustment in phase delay required. Table 8-19 illustrate the impact of different divide values on the final digital delay.

Table 8-19. Digital Delay Adjustment based on Divide Values

| DIVIDE VALUE | DIGITAL DELAY ADJUSTMENT | |
|--------------|--------------------------|--|
| 2, 3 | -2 ⁽¹⁾ | |
| 4, 7 to 1023 | 0 | |
| 5 | +2 | |
| 6 | +1 | |

⁽¹⁾ Before SYNC, program divider to Divide-by-4, then back to Divide-by-2 or Divide-by-3 to ensure '-2' delay relationship.

For example, Table 8-20 illustrates a system with clock outputs having divide values $\frac{12}{4}$, and $\frac{16}{6}$ to share a common edge.

Table 8-20. Digital Delay Adjustment Illustration

| DIVIDE VALUE | PROGRAMMED DDLY | ACTUAL DDLY |
|--------------|-----------------|-------------|
| 2 | 13 | 11 |
| 4 | 11 | 11 |
| 5 | 8 | 11 |
| 6 | 10 | 11 |

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8.6.2.2.3 CLKoutX_Y_PD, CLKoutX_Y_ODL, CLKoutX_Y_IDL, DCLKX_Y_DDLY_PD, DCLKX_Y_DDLY[9:8], DCLKX_Y_DIV[9:8]

Table 8-21. Registers 0x102, 0x10A, 0x112, 0x11A, 0x122, 0x12A, 0x132

| BIT | NAME | POR DEFAULT | DESCRIPTION | |
|-----|-------------------|-------------|-----------------------------------------------------------------------------------------------------------------------------------------------------------------------------|--|
| 7 | CLKoutX_Y_PD | 1 | Power down the clock group defined by X and Y. 0: Enabled 1: Power down entire clock group including both CLKoutX and CLKoutY. | |
| 6 | CLKoutX_Y_ODL | 0 | Sets output drive level for clocks. This has no impact for the even clock output in bypass mode. 0: Normal operation 1: Higher current consumption and lower noise floor. | |
| 5 | CLKoutX_Y_IDL | 0 | Sets input drive level for clocks. 0: Normal operation 1: Higher current consumption and lower noise floor. | |
| 4 | DCLKX_Y_DDLY_PD | 0 | Powerdown the device clock digital delay circuitry. 0: Enabled 1: Power down static digital delay for device clock divider. | |
| 3:2 | DCLKX_Y_DDLY[9:8] | 0 | MSB of static digital delay, see Section 8.6.2.2.2. | |
| 1:0 | DCLKX_Y_DIV[9:8] | 0 | MSB of device clock divide value, see Table 8-16. | |

$8.6.2.2.4\ CLKoutX_SRC_MUX,\ CLKoutX_Y_PD,\ DCLKX_Y_BYP,\ DCLKX_Y_DCC,\ DCLKX_Y_POL,\ DCLKX_Y_HS$

These registers control the analog delay properties for the device clocks.

Table 8-22. Registers 0x103, 0x10B, 0x113, 0x11B, 0x123, 0x12B, 0x133

| BIT | NAME | POR DEFAULT | DESCRIPTION | |
|-----|-----------------|-------------|--------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|--|
| 7 | NA | 0 | Reserved | |
| 6 | NA | 1 | Reserved | |
| 5 | CLKoutX_SRC_MUX | 0 | Select CLKoutX clock source. Source must also be powered up. 0: Device Clock 1: SYSREF | |
| 4 | CLKoutX_Y_PD | 0 | Power down the clock group defined by X and Y. 0: Enabled 1: Power down enter clock group X_Y. | |
| 3 | DCLKX_BYP | 0 | Enable high performance bypass path for even clock outputs. 0: CLKoutX not in high performance bypass mode. CML is not valid for CLKoutX_FMT. 1: CLKoutX in high performance bypass mode. Only CML clock format is valid. | |
| 2 | DCLKX_Y_DCC | 0 | Duty cycle correction for device clock divider. Required for half step. 0: No duty cycle correction. 1: Duty cycle correction enabled. | |
| 1 | DCLKX_Y_POL | 0 | Invert polarity of device clock output. This also applies to CLKoutX in high performance bypass mode. Polarity invert is a method to get a half-step phadjustment in high performance bypass mode or /1 divide value. 0: Normal polarity 1: Invert polarity | |
| 0 | DCLKX_Y_HS | 0 | Sets the device clock half step value. Must be set to zero (0) for a divide of 1. No effect if DCLKX_Y_DCC = 0. 0: No phase adjustment 1: Adjust device clock phase –0.5 clock distribution path cycles. | |

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$8.6.2.2.5~CLKoutY_SRC_MUX,~SCLKX_Y_PD,~SCLKX_Y_DIS_MODE,~SCLKX_Y_POL,~SCLKX_Y_HS$

These registers set the half step for the device clock, the SYSREF output MUX, the SYSREF clock digital delay, and half step.

Table 8-23. Registers 0x104, 0x10C, 0x114, 0x11C, 0x124, 0x12C, 0x134

| BIT | NAME | POR DEFAULT | DESCR | RIPTION | |
|-----|------------------|-------------|----------------------------------------------------------------------------------------------------------------------------------------|--------------------------------------------------------------------------------------------------------------------------------------------------------|--|
| 7:6 | NA | 0 | Reserved | | |
| 5 | CLKoutY_SRC_MUX | 0 | Select CLKoutX clock source. Source must also be powered up. 0: Device Clock 1: SYSREF | | |
| 4 | SCLKX_Y_PD | 1 | Power down the SYSREF clock output 0: SYSREF enabled 1: Power down SYSREF path for clock | , | |
| | | | Set disable mode for clock outputs contassert when SYSREF_GBL_PD = 1. | trolled by SYSREF. Some cases will | |
| | | 0 | Field Value | Disable Mode | |
| | | | 0 (0x00) | Active in normal operation | |
| 3:2 | SCLKX_Y_DIS_MODE | | 1 (0x01) | If SYSREF_GBL_PD = 1, the output is a logic low, otherwise it is active. | |
| | | | 2 (0x02) | If SYSREF_GBL_PD = 1, the output is a nominal Vcm voltage for odd clock channels ⁽¹⁾ and low for even clocks. Otherwise outputs are active. | |
| | | | 3 (0x03) | Output is a nominal Vcm voltage ⁽¹⁾ | |
| 1 | SCLKX_Y_POL | 0 | Sets the polarity of clock on SCLKX_Y when SYSREF clock output is selected with CLKoutX_MUX or CLKoutY_MUX. 0: Normal 1: Inverted | | |
| 0 | SCLKX_Y_HS | 0 | Sets the local SYSREF clock half step value. 0: No phase adjustment 1: Adjust device SYSREF phase -0.5 clock distribution path cycles. | | |

⁽¹⁾ If LVPECL mode is used with emitter resistors to ground, the output Vcm will be approximately 0 V, each pin will be approximately 0 V. If CML mode is used with pullups to V_{CC} , the output V_{CM} will be approximately V_{CC} V, each pin will be approximately V_{CC} V.



8.6.2.2.6 SCLKX_Y_ADLY_EN, SCLKX_Y_ADLY

These registers set the analog delay parameters for the SYSREF outputs.

Table 8-24. Registers 0x105, 0x10D, 0x115, 0x11D, 0x125, 0x12D, 0x135

| BIT | NAME | POR DEFAULT | DESCR | IPTION | | |
|-----|---------------------|-------------|------------------------------------------------------------------------------|----------------------------|--|--|
| 7:6 | NA | 0 | Reserved | Reserved | | |
| 5 | SCLKX_Y _ADLY_EN | 0 | Enables analog delay for the SYSREF output. 0: Disabled 1: Enabled | | | |
| | SCLKX_Y _ADLY | 0 | SYSREF analog delay in approximately adds an additional 125 ps in propagatio | | | |
| | | | Field Value | Delay Value | | |
| | | | 0 (0x0) | 125 ps | | |
| | | | 1 (0x1) | 146 ps (+21 ps from 0x00) | | |
| 4:0 | | | 2 (0x2) | 167 ps (+42 ps from 0x00) | | |
| | | | 3 (0x3) | 188 ps (+63 ps from 0x00) | | |
| | | | | | | |
| | | | 14 (0xE) | 587 ps (+462 ps from 0x00) | | |
| | | | 15 (0xF) | 608 ps (+483 ps from 0x00) | | |

8.6.2.2.7 SCLKX_Y_DDLY

Table 8-25. Registers 0x106, 0x10E, 0x116, 0x11E, 0x126, 0x12E, 0x136

| BIT | NAME | POR DEFAULT | DESCRIPTION |
|-----|--------------|-------------|------------------------------------------------------|
| 7:4 | NA | 0 | Reserved |
| 3:0 | SCLKX_Y_DDLY | 0 | Set digital delay value for SYSREF clock (minimum 8) |

8.6.2.2.8 CLKoutY_FMT, CLKoutX_FMT

The difference in the tables is that some of the clock outputs have inverted CMOS polarity settings.

Table 8-26. Registers 0x107 (CLKout0_1), 0x11F (CLKout6_7), 0x12F (CLKout10_11)

| BIT | NAME | POR DEFAULT | DESCRIPTION | | | | |
|-----|--------------|-------------|--------------------------|---------------------------------|--------------------------------|--|--|
| | | | Set CLKoutY clock format | | | | |
| | | | Field Value | Outp | ut Format | | |
| | | | 0 (0x00) | Pov | verdown | | |
| | | | 1 (0x01) | | LVDS | | |
| | | | 2 (0x02) | HSI | DS 6 mA | | |
| | | | 3 (0x03) | HSI | DS 8 mA | | |
| | | | 4 (0x04) | LVPEC | CL 1600 mV | | |
| | | | 5 (0x05) | LVPEC | CL 2000 mV | | |
| 7.4 | CLI/outV FMT | 0 | 6 (0x06) | LC | CPECL | | |
| 7:4 | CLKoutY_FMT | 0 | 7 (0x07) | CM | L 16 mA | | |
| | | | 8 (0x08) | CM | L 24 mA | | |
| | | | 9 (0x09) | СМ | L 32 mA | | |
| | | | 10 (0x0A) | СМО | S (Off/Inv) | | |
| | | | 11 (0x0B) | CMOS | (Norm/Off) | | |
| | | | 12 (0x0C) | СМО | OS (Inv/Inv) | | |
| | | | 13 (0x0D) | CMOS | (Inv/Norm) | | |
| | | | 14 (0x0E) | CMOS | (Norm/Inv) | | |
| | | | 15 (0x0F) | CMOS | (Norm/Norm) | | |
| | | | Set CLKoutX clock format | | | | |
| | | | Field Value | Output Format DCLKX_BYP = 0 | Output Format DCLKX_BYP = 1 | | |
| | | | 0 (0x00) | Powerdown | Reserved | | |
| | | | 1 (0x01) | LVDS | Reserved | | |
| | | | 2 (0x02) | HSDS 6 mA | Reserved | | |
| | | | 3 (0x03) | HSDS 8 mA | Reserved | | |
| | | | 4 (0x04) | LVPECL 1600 mV | Reserved | | |
| | | | 5 (0x05) | LVPECL 2000 mV | Reserved | | |
| 3:0 | CLKoutX_FMT | 0 | 6 (0x06) | LCPECL | Reserved | | |
| | | - | 7 (0x07) | Reserved | CML 16 mA | | |
| | | | 8 (0x08) | Reserved | CML 24 mA | | |
| | | | 9 (0x09) | Reserved | CML 32 mA | | |
| | | | 10 (0x0A) | CMOS (Off/Inv) ⁽¹⁾ | Reserved | | |
| | | | 11 (0x0B) | CMOS (Norm/Off) ⁽¹⁾ | Reserved | | |
| | | | 12 (0x0C) | CMOS (Inv/Inv) ⁽¹⁾ | Reserved | | |
| | | | 13 (0x0D) | CMOS (Inv/Norm) ⁽¹⁾ | Reserved | | |
| | | | 14 (0x0E) | CMOS (Norm/Inv) ⁽¹⁾ | Reserved | | |
| | | | 15 (0x0F) | CMOS (Norm/Norm) ⁽¹⁾ | Reserved | | |

⁽¹⁾ Only valid for CLKout10.



Table 8-27. Registers 0x10F (CLKout2_3), 0x117 (CLKout4_5), 0x127 (CLKout8_9), 0x137 (CLKout12_13)

| BIT | NAME | POR DEFAULT | | DESCRIPTION | <u>,, (</u> | |
|-----|--------------|-------------|--------------------------|---------------------------------|--------------------------------|--|
| | | | Set CLKoutY clock format | | | |
| | | | Field Value | Outp | ut Format | |
| | | | 0 (0x00) | Pov | verdown | |
| | | | 1 (0x01) | I | LVDS | |
| | | | 2 (0x02) | HSI | DS 6 mA | |
| | | | 3 (0x03) | HSI | DS 8 mA | |
| | | | 4 (0x04) | LVPEC | CL 1600 mV | |
| | | | 5 (0x05) | LVPEC | CL 2000 mV | |
| 7.4 | CL KoutV FMT | 0 | 6 (0x06) | LC | CPECL | |
| 7:4 | CLKoutY_FMT | 0 | 7 (0x07) | СМ | L 16 mA | |
| | | | 8 (0x08) | CM | L 24 mA | |
| | | | 9 (0x09) | СМ | L 32 mA | |
| | | | 10 (0x0A) | CMOS | (Off/Norm) | |
| | | | 11 (0x0B) | СМО | S (Inv/Off) | |
| | | | 12 (0x0C) | CMOS (| (Norm/Norm) | |
| | | | 13 (0x0D) | CMOS | (Norm/Inv) | |
| | | | 14 (0x0E) | CMOS | (Inv/Norm) | |
| | | | 15 (0x0F) | СМО | S (Inv/Inv) | |
| | | 0 | Set CLKoutX clock format | | | |
| | | | Field Value | Output Format DCLKX_BYP = 0 | Output Format DCLKX_BYP = 1 | |
| | | | 0 (0x00) | Powerdown | Reserved | |
| | | | 1 (0x01) | LVDS | Reserved | |
| | | | 2 (0x02) | HSDS 6 mA | Reserved | |
| | | | 3 (0x03) | HSDS 8 mA | Reserved | |
| | | | 4 (0x04) | LVPECL 1600 mV | Reserved | |
| | | | 5 (0x05) | LVPECL 2000 mV | Reserved | |
| 3:0 | CLKoutX_FMT | | 6 (0x06) | LCPECL | Reserved | |
| | | | 7 (0x07) | Reserved | CML 16 mA | |
| | | | 8 (0x08) | Reserved | CML 24 mA | |
| | | | 9 (0x09) | Reserved | CML 32 mA | |
| | | | 10 (0x0A) | CMOS (Off/Norm) ⁽¹⁾ | Reserved | |
| | | | 11 (0x0B) | CMOS (Inv/Off) ⁽¹⁾ | Reserved | |
| | | | 12 (0x0C) | CMOS (Norm/Norm) ⁽¹⁾ | Reserved | |
| | | | 13 (0x0D) | CMOS (Norm/Inv) ⁽¹⁾ | Reserved | |
| | | | 14 (0x0E) | CMOS (Inv/Norm) ⁽¹⁾ | Reserved | |
| | | | 15 (0x0F) | CMOS (Inv/Inv) ⁽¹⁾ | Reserved | |

⁽¹⁾ Only valid for CLKout8.



8.6.2.3 SYSREF, SYNC, and Device Config 8.6.2.3.1 VCO_MUX, OSCout_MUX, OSCout_FMT

Table 8-28. Register 0x138

| DIT | I able 8-28. Register UX138 BIT NAME POR DEFAULT DESCRIPTION | | | | | | |
|-----|---------------------------------------------------------------|---|-------------------------------------------------------------------------------------|------------------------------|--|--|--|
| | | | | IF HON | | | |
| 7 | NA | 0 | Reserved | | | | |
| | | | Selects clock distribution path source from VCO0, VCO1, or CLKin (extern VCO) | | | | |
| | | | Field Value | VCO Selected | | | |
| 6:5 | VCO_MUX | 2 | 0 (0x00) | VCO 0 | | | |
| | | | 1 (0x01) | VCO 1 | | | |
| | | | 2 (0x02) | Fin1 / CLKin1 (external VCO) | | | |
| | | | 3 (0x03) | Fin0 | | | |
| 4 | OSCout_MUX | 0 | Select the source for OSCout: 0: Buffered OSCin 1: Feedback Mux | | | | |
| | | | Selects the output format of OSCout. When powered down, these pins mused as CLKin2. | | | | |
| | | | Field Value | OSCout Format | | | |
| | | | 0 (0x00) | Power down (CLKin2) | | | |
| | | | 1 (0x01) | LVDS | | | |
| | | | 2 (0x02) | Reserved | | | |
| | | | 3 (0x03) | Reserved | | | |
| | | | 4 (0x04) | LVPECL 1600 mVpp | | | |
| | | | 5 (0x05) | LVPECL 2000 mVpp | | | |
| 3:0 | OSCout_FMT | 4 | 6 (0x06) | LVCMOS (Norm / Inv) | | | |
| | | | 7 (0x07) | LVCMOS (Inv / Norm) | | | |
| | | | 8 (0x08) | LVCMOS (Norm / Norm) | | | |
| | | | 9 (0x09) | LVCMOS (Inv / Inv) | | | |
| | | | 10 (0x0A) | LVCMOS (Off / Norm) | | | |
| | | | 11 (0x0B) | LVCMOS (Off / Inv) | | | |
| | | | 12 (0x0C) | LVCMOS (Norm / Off) | | | |
| | | | 13 (0x0D) | LVCMOS (Inv / Off) | | | |
| | | | 14 (0x0E) | LVCMOS (Off / Off) | | | |

8.6.2.3.2 SYSREF_REQ_EN, SYNC_BYPASS, SYSREF_MUX

This register sets the source for the SYSREF outputs. Refer to Figure 8-3 and Section 8.3.2.

Table 8-29. Register 0x139

| BIT | NAME | POR DEFAULT | DESCR | RIPTION | |
|-----|---------------|--------------|---------------------------------------------------------------------------------------|-----------------------------------------------------------------------------------------------------------------------------------------------------------|--|
| 7:6 | NA | 0 | Reserved | | |
| 5 | NA | 0 | Reserved | | |
| 4 | SYSREF_REQ_EN | 0 | | Enables the SYNC/SYSREF_REQ pin to force the SYSREF_MUX = 3 for continuous pulses. When using this feature enable pulser and set SYSREF_MUX = 2 (Pulser). | |
| 3 | SYNC_BYPASS | 0 | Bypass SYNC polarity invert and other circuitry. 0: Normal 1: SYNC signal is bypassed | | |
| 2 | NA | 0 | Reserved | Reserved | |
| | | | Selects the SYSREF source. | | |
| | | SYSREF_MUX 0 | Field Value | SYSREF Source | |
| 1:0 | CVCDEE MILV | | 0 (0x00) | Normal SYNC | |
| 1.0 | SYSKEF_WUX | | 1 (0x01) | Re-clocked | |
| | | | 2 (0x02) | SYSREF Pulser | |
| | | | 3 (0x03) | SYSREF Continuous | |



8.6.2.3.3 SYSREF_DIV

These registers set the value of the SYSREF output divider.

Table 8-30. SYSREF_DIV[12:0]

| MSB | LSB | |
|---------------------------------|------------------------------|--|
| $0x13A[4:0] = SYSREF_DIV[12:8]$ | 0x13B[7:0] = SYSREF_DIV[7:0] | |

Table 8-31. Registers 0x13A and 0x13B

| Table of The Togletone of Toff and of Tob | | | | | | | | |
|-------------------------------------------|-----|-------------------|-------------|---------------------------------|--------------|--|--|--|
| REGISTER | BIT | NAME | POR DEFAULT | DESCRIPTION | | | | |
| 0x13A | 7:5 | NA | 0 | Reserved | | | | |
| | | | | Divide value for the SYSREF out | puts. | | | |
| 0x13A | 4:0 | CVCDEE DIV(40.01 | 40 | Field Value | Divide Value | | | |
| UXTSA | 4.0 | SYSREF_DIV[12:8] | 12 | 0 to 7 (0x00 to 0x07) | Reserved | | | |
| | | | | 8 (0x08) | 8 | | | |
| | | | | 9 (0x09) | 9 | | | |
| 0.420 | 7:0 | 0 SYSREF_DIV[7:0] | 0 | | | | | |
| 0x13B | | | | 8190 (0x1FFE) | 8190 | | | |
| | | | | 8191 (0X1FFF) | 8191 | | | |

8.6.2.3.4 SYSREF_DDLY

These registers set the delay of the SYSREF digital delay value.

Table 8-32. SYSREF Digital Delay Register Configuration, SYSREF_DDLY[12:0]

| MSB | LSB |
|--------------------------------|-------------------------------|
| 0x13C[4:0] / SYSREF_DDLY[12:8] | 0x13D[7:0] / SYSREF_DDLY[7:0] |

Table 8-33. Registers 0X13C and 0X13D

| REGISTER | BIT | NAME | POR DEFAULT | DESCRIPTION | |
|----------|-----|----------------------|-------------|------------------------------|----------------|
| 0x13C | 7:5 | NA | 0 | Reserved | |
| | | | | Sets the value of the SYSREF | digital delay. |
| 0x13C | 4:0 | SYSREF DDLY[12:8] | 0 | Field Value | Delay Value |
| UX13C | 4.0 | STOREF_DDLT[12.0] | | 0x00 to 0x07 | Reserved |
| | | | | 8 (0x08) | 8 |
| | | 7:0 SYSREF_DDLY[7:0] | 8 | 9 (0x09) | 9 |
| 0x13D | 7:0 | | | | |
| OXISD | | | | 8190 (0x1FFE) | 8190 |
| | | | | 8191 (0X1FFF) | 8191 |



8.6.2.3.5 SYSREF_PULSE_CNT

This register sets the number of SYSREF pulses if SYSREF is not in continuous mode. See Section 8.6.2.3.2 for further description of SYSREF's outputs.

Programming the register causes the specified number of pulses to be output if "SYSREF Pulses" is selected by SYSREF_MUX and SYSREF functionality is powered up.

Table 8-34. Register 0x13E

| BIT | NAME | POR DEFAULT | DESCRIPTION | |
|-----|------------------|------------------|--------------------------------------------------------------------------------------------------------------------------------------|------------------|
| 7:2 | NA | 0 | Reserved | |
| | | | Sets the number of SYSREF pulses generated when not in continuous mode. See Section 8.6.2.3.2 for more information on SYSREF modes. | |
| | SYSREF_PULSE_CNT | SREF_PULSE_CNT 3 | Field Value | Number of Pulses |
| 1:0 | | | 0 (0x00) | 1 pulse |
| | | | 1 (0x01) | 2 pulses |
| | | | 2 (0x02) | 4 pulses |
| | | | 3 (0x03) | 8 pulses |

8.6.2.3.6 PLL2_RCLK_MUX, PLL2_NCLK_MUX, PLL1_NCLK_MUX, FB_MUX, FB_MUX_EN

This register controls the feedback feature.

Table 8-35. Register 0x13F

| | Table 0-33. Neglater 0X13F | | | | | |
|-----|----------------------------|-------------|----------------------------------------------------------------------------------------------------------------------------------|------------------------------------|--|--|
| BIT | NAME | POR DEFAULT | DESCRIF | DESCRIPTION | | |
| 7 | PLL2_RCLK_MUX | 0 | Selects the source for PLL2 reference. 0: OSCin 1: Currently selected CLKin. | | | |
| 6 | NA | 0 | Reserved | | | |
| 5 | PLL2_NCLK_MUX | 0 | Selects the input to the PLL2 N Divider 0: PLL2 Prescaler 1: Feedback Mux | | | |
| 4:3 | PLL1_NCLK_MUX | 0 | Selects the input to the PLL1 N Divider. 0: OSCin 1: Feedback Mux 2: PLL2 Prescaler | | | |
| | | | When in 0-delay mode, the feedback must back into the PLL1 N Divider. | selects the clock output to be fed | | |
| | | | Field Value | Source | | |
| 2:1 | FB_MUX | 0 | 0 (0x00) | CLKout6 | | |
| | _ | | 1 (0x01) | CLKout8 | | |
| | | | 2 (0x02) | SYSREF Divider | | |
| | | | 3 (0x03) | External | | |
| 0 | FB_MUX_EN | 0 | When using 0-delay, FB_MUX_EN must be set to 1 power up the feedback mux. 0: Feedback mux powered down 1: Feedback mux enabled | | | |

$8.6.2.3.7~PLL1_PD,~VCO_LDO_PD,~VCO_PD,~OSCin_PD,~SYSREF_GBL_PD,~SYSREF_PD,~SYSREF_DDLY_PD,~SYSREF_PLSR_PD$

This register contains power down controls for OSCin and SYSREF functions.

Table 8-36. Register 0x140

| BIT | NAME | POR DEFAULT | DESCRIPTION |
|-----|----------------|-------------|---------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| 7 | PLL1_PD | 1 | Power down PLL1 0: Normal operation 1: Power down |
| 6 | VCO_LDO_PD | 1 | Power down VCO_LDO 0: Normal operation 1: Power down |
| 5 | VCO_PD | 1 | Power down VCO 0: Normal operation 1: Power down |
| 4 | OSCin_PD | 0 | Power down the OSCin port. 0: Normal operation 1: Power down |
| 3 | SYSREF_GBL_PD | 0 | Power down individual SYSREF outputs depending on the setting of SCLKX_Y_DIS_MODE for each SYSREF output. SYSREF_GBL_PD allows many SYSREF outputs to be controlled through a single bit. 0: Normal operation 1: Activate Power down Mode |
| 2 | SYSREF_PD | 0 | Power down the SYSREF circuitry and divider. If powered down, SYSREF output mode cannot be used. SYNC cannot be provided either. 0: SYSREF can be used as programmed by individual SYSREF output registers. 1: Power down |
| 1 | SYSREF_DDLY_PD | 0 | Power down the SYSREF digital delay circuitry. 0: Normal operation, SYSREF digital delay may be used. Must be powered up during SYNC for deterministic phase relationship with other clocks. 1: Power down |
| 0 | SYSREF_PLSR_PD | 0 | Powerdown the SYSREF pulse generator. 0: Normal operation 1: Powerdown |



8.6.2.3.8 DDLYdSYSREF_EN, DDLYdX_EN

This register enables dynamic digital delay for enabled device clocks and SYSREF when DDLYd_STEP_CNT is programmed.

Table 8-37. Register 0x141

| BIT | NAME | POR DEFAULT | DESCR | RIPTION |
|-----|------------------|-------------|-------------------------------------------------|-------------|
| 7 | DDLYd _SYSREF_EN | 0 | Enables dynamic digital delay on SYSREF outputs | |
| 6 | DDLYd12_EN | 0 | Enables dynamic digital delay on DCLKout12 | |
| 5 | DDLYd10_EN | 0 | Enables dynamic digital delay on DCLKout10 | |
| 4 | DDLYd8_EN | 0 | Enables dynamic digital delay on DCLKout8 | 0: Disabled |
| 3 | DDLYd6_EN | 0 | Enables dynamic digital delay on DCLKout6 | 1: Enabled |
| 2 | DDLYd4_EN | 0 | Enables dynamic digital delay on DCLKout4 | |
| 1 | DDLYd2_EN | 0 | Enables dynamic digital delay on DCLKout2 | |
| 0 | DDLYd0_EN | 0 | Enables dynamic digital delay on DCLKout0 | |

8.6.2.3.9 DDLYd_STEP_CNT

This register sets the number of dynamic digital delay adjustments occur. Upon programming, the dynamic digital delay adjustment begins for each clock output with dynamic digital delay enabled. Dynamic digital delay can only be started by SPI.

Other registers must be set: SYNC_MODE = 3

Table 8-38. Register 0x142

| BIT | NAME | POR DEFAULT | DESCRIPTION | |
|-----|----------------|-------------|-----------------------------------------|-----------------------------------|
| | | | Sets the number of dynamic digital dela | ay adjustments that will occur. |
| | | | Field Value | Dynamic Digital Delay Adjustments |
| | | | 0 (0x00) | No Adjust |
| | | | 1 (0x01) | 1 step |
| 7:0 | DDLYd_STEP_CNT | 0 | 2 (0x02) | 2 steps |
| | | | 3 (0x03) | 3 steps |
| | | | | |
| | | | 254 (0xFE) | 254 steps |
| | | | 255 (0xFF) | 255 steps |



$8.6.2.3.10 \; {\tt SYSREF_CLR}, \; {\tt SYNC_ISHOT_EN}, \; {\tt SYNC_POL}, \; {\tt SYNC_EN}, \; {\tt SYNC_PLL2_DLD}, \; {\tt SYNC_PLL1_DLD}, \; {\tt SYNC_MODE}$

This register sets general SYNC parameters such as polarization, and mode. Refer to Figure 8-3 for block diagram. Refer to Table 8-2 for using SYNC_MODE for specific SYNC use cases.

Table 8-39. Register 0x143

| | Table 8-39. Register 0x143 | | | | | |
|-----|----------------------------|---------------------------|--------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|------------------------------------------------------------------------------------------------------------------------------------------------------------------|--|--|
| BIT | NAME | POR DEFAULT | DESCRIPTION | | | |
| 7 | SYSREF_CLR | 0 | Except during SYSREF Setup Procedure (see Section 8.3.2), this bit should always be programmed to 0. While this bit is set, extra current is used. | | | |
| 6 | SYNC_1SHOT_EN | 0 | SYNC one shot enables edge sensitive SYNC. 0: SYNC is level sensitive and outputs will be held in SYNC as long as SYNC is asserted. 1: SYNC is edge sensitive, outputs will be SYNCed on rising edge of SYNC. This results in the clock being held in SYNC for a minimum amount of time. | | | |
| 5 | SYNC_POL | 0 | Sets the polarity of the SYNC pin. 0: Normal 1: Inverted | | | |
| 4 | SYNC_EN | 0 | Enables the SYNC functionality. 0: Disabled 1: Enabled | | | |
| 3 | SYNC_PLL2_DLD | 0 | 0: Off 1: Assert SYNC until PLL2 DLD = 1 | | | |
| 2 | SYNC_PLL1_DLD | 0 | 0: Off 1: Assert SYNC until PLL1 DLD = 1 | | | |
| | | | Sets the method of generating a SYNC event. | | | |
| | | | Field Value | SYNC Generation | | |
| | | | 0 (0x00) | Prevent SYNC Pin, SYNC_PLL1_DLD flag, or SYNC_PLL2_DLD flag from generating a SYNC event. | | |
| 1:0 | CVAIC MODE | 1 (0x01) 1 2 (0x02) | 1 (0x01) | SYNC event generated from SYNC pin or if enabled the SYNC_PLL1_DLD flag or SYNC_PLL2_DLD flag. | | |
| 1.0 | SYNC_MODE | | 2 (0x02) | For use with pulser - SYNC/SYSREF pulses are generated by pulser block via SYNC Pin or if enabled SYNC_PLL1_DLD flag or SYNC_PLL2_DLD flag. | | |
| | | | 3 (0x03) | For use with pulser - SYNC/SYSREF pulses are generated by pulser block when programming register 0x13E (SYSREF_PULSE_CNT) is written to (see Section 8.6.2.3.5). | | |

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8.6.2.3.11 SYNC_DISSYSREF, SYNC_DISX

SYNC_DISX will prevent a clock output from being synchronized or interrupted by a SYNC event or when outputting SYSREF.

Table 8-40. Register 0x144

| BIT | NAME | POR DEFAULT | DESCRIPTION |
|-----|----------------|-------------|------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| 7 | SYNC_DISSYSREF | 0 | Prevent the SYSREF clocks from becoming synchronized during a SYNC event. If SYNC_DISSYSREF is enabled it will continue to operate normally during a SYNC event. |
| 6 | SYNC_DIS12 | 0 | |
| 5 | SYNC_DIS10 | 0 | |
| 4 | SYNC_DIS8 | 0 | Prevent the device clock output from becoming synchronized during a SYNC |
| 3 | SYNC_DIS6 | 0 | event or SYSREF clock. If SYNC_DIS bit for a particular output is enabled then |
| 2 | SYNC_DIS4 | 0 | it will continue to operate normally during a SYNC event or SYSREF clock. |
| 1 | SYNC_DIS2 | 0 | |
| 0 | SYNC_DIS0 | 0 | |

8.6.2.3.12 PLL1R_SYNC_EN, PLL1R_SYNC_SRC, PLL2R_SYNC_EN, FIN0_DIV2_EN, FIN0_INPUT_TYPE

These bits are used when synchronizing PLL1 and PLL2 R dividers. Refer to (TBD) for more information on the process to synchronize the PLL R dividers.

Table 8-41. Register 0x145

| BIT | NAME | POR DEFAULT | DESCI | RIPTION | |
|-----|-----------------|-------------|--------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|----------------------------|--|
| 7 | NA | 0 | Reserved | | |
| 6 | PLL1R_SYNC_EN | 0 | Enable synchronization for PLL1 R divider 0: Not enabled 1: Enabled | | |
| | | | Select the source for PLL1 R divider sy | nchronization | |
| | | | Field Value | Definition | |
| 5:4 | PLL1R SYNC SRC | 0 | 0 (0x00) | Reserved | |
| 5.4 | PLLIK_STNC_SKC | 0 | 1 (0x01) | SYNC Pin | |
| | | | 2 (0x02) | CLKin0 | |
| | | | 3 (0x03) Reserved | | |
| 3 | PLL2R_SYNC_EN | 0 | Enable synchronization for PLL2 R divider. Synchronization for PLL2 R always comes from the SYNC pin. 0: Not enabled 1: Enabled | | |
| 2 | FIN0_DIV2_EN | 0 | Sets the input path to use or bypass the divide-by-2. 0: Bypassed (÷1) 1: Divided (÷2) | | |
| | | | Program input type to hardware interfa | ce used. | |
| | | | Field Value | Definition | |
| 1:0 | FIN0_INPUT_TYPE | 0 | 0 0: Not enabled 1: Enabled Select the source for PLL1 R divider synchronization Field Value 0 (0x00) Reserved 1 (0x01) SYNC Pin 2 (0x02) CLKin0 3 (0x03) Reserved Enable synchronization for PLL2 R divider. Synchronization for PLL2 R alway comes from the SYNC pin. 0: Not enabled 1: Enabled Sets the input path to use or bypass the divide-by-2. 0: Bypassed (÷1) 1: Divided (+2) Program input type to hardware interface used. Field Value Definition 0 (0x00) Differential Input 1 (0x01) Single Ended Input (Fin0) | | |
| 1.0 | FINU_INFUI_ITPE | U | 1 (0x01) | Single Ended Input (Fin0) | |
| | | | 2 (0x02) | Single Ended Input (Fin0*) | |
| | | | 3 (0x03) | Reserved | |



8.6.2.4 (0x146 - 0x149) CLKin Control

8.6.2.4.1 CLKin_SEL_PIN_EN, CLKin_SEL_PIN_POL, CLKin2_EN, CLKin1_EN, CLKin0_EN, CLKin2_TYPE, CLKin1_TYPE, CLKin0_TYPE

This register has CLKin enable and type controls. See Section 8.3.6 for more info on how clock input selection works.

Table 8-42. Register 0x146

| BIT | NAME | POR DEFAULT | DESCR | RIPTION | | |
|-----|-------------------|-------------|-------------------------------------------------------------------------------------------------------------------------|---------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|--|--|
| 7 | CLKin_SEL_PIN_EN | 0 | Enables pin control according to Figure | Enables pin control according to Figure 8-7. | | |
| 6 | CLKin_SEL_PIN_POL | 0 | Inverts the CLKin polarity for use in pin 0: Active High 1: Active Low | select mode. | | |
| 5 | CLKin2_EN | 0 | Enable CLKin2 to be used during auto- 0: Not enabled for auto mode 1: Enabled for auto clock switching mo | | | |
| 4 | CLKin1_EN | 1 | Enable CLKin1 to be used during auto-switching. 0: Not enabled for auto mode 1: Enabled for auto clock switching mode | | | |
| 3 | CLKin0_EN | 1 | Enable CLKin0 to be used during auto-switching. 0: Not enabled for auto mode 1: Enabled for auto clock switching mode | | | |
| 2 | CLKin2_TYPE | 0 | | There are two buffer types for CLKin0, | | |
| 1 | CLKin1_TYPE | 0 | | 1, and 2: bipolar and CMOS. Bipolar is recommended for differential inputs | | |
| 0 | CLKin0_TYPE | 0 | 0: Bipolar 1: MOS | like LVDS or LVPECL. CMOS is recommended for DC-coupled single ended inputs. When using bipolar, CLKinX and CLKinX* must be AC-coupled. When using CMOS, CLKinX and CLKinX* may be AC or DC-coupled if the input signal is differential. If the input signal is single-ended the used input may be either AC or DC-coupled and the unused input must AC grounded. | | |

$8.6.2.4.2~CLK in_SEL_AUTO_REVERT_EN,~CLK in_SEL_AUTO_EN,~CLK in_SEL_MANUAL,~CLK in1_DEMUX,~CLK in0_DEMUX$

Table 8-43. Register 0x147

| BIT | NAME | POR DEFAULT | DESCR | RIPTION | |
|-----|------------------------------|-------------|-------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|------------|--|
| 7 | CLKin_SEL_ AUTO_REVERT_EN | 0 | priority clock, the clock input is immediately switched. Highest priority input is | | |
| 6 | CLKin_SEL_AUTO_EN | 0 | Enables pin control according to Figure 8-7. | | |
| | | | Selects the clock input when in manual mode according to Figure 8-7. | | |
| | | | Field Value | Definition | |
| 5:4 | CLKin SEL MANUAL | 1 | 0 (0x00) | CLKin0 | |
| 3.4 | CERII_SEL_WANDAL | ı | When in auto clock switching mode. If active clock is detected on higher priority clock, the clock input is immediately switched. Highest priority input lowest numbered active clock input. Enables pin control according to Figure 8-7. Selects the clock input when in manual mode according to Figure 8-7. Field Value Definition | CLKin1 | |
| | | | 2 (0x02) | CLKin2 | |
| | | | 3 (0x03) | Holdover | |

Table 8-43. Register 0x147 (continued)

| BIT | NAME | POR DEFAULT | DESCRIPTION | | |
|-----|----------------|-------------|------------------------------------------------------------|-----------------------------|--|
| | | | Selects where the output of the CLKin1 buffer is directed. | | |
| | | | Field Value | CLKin1 Destination | |
| 2.2 | CLIZEA DEMILY | 0 | 0 (0x00) | Fin | |
| 3:2 | CLKin1_DEMUX | 0 | 1 (0x01) | Feedback Mux (0-delay mode) | |
| | | | 2 (0x02) | PLL1 | |
| | | | 3 (0x03) | Off | |
| | | | Selects where the output of the CLKin0 | buffer is directed. | |
| | | | Field Value | CLKin0 Destination | |
| 1:0 | CLIZIO DEMILIZ | 3 | 0 (0x00) | SYSREF Mux | |
| 1:0 | CLKin0_DEMUX | 3 | 1 (0x01) | Reserved | |
| | | | 2 (0x02) | PLL1 | |
| | | | 3 (0x03) | Off | |

8.6.2.4.3 CLKin_SEL0_MUX, CLKin_SEL0_TYPE

This register has CLKin_SEL0 controls.

Table 8-44. Register 0x148

| Table 8-44. Register 0x148 | | | | | | |
|----------------------------|-----------------|-------------|------------------------------------------------|---------------------------------|----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|--|
| BIT | NAME | POR DEFAULT | DESCRIPTION | | | |
| 7:6 | NA | 0 | Reserved | Reserved | | |
| | | | This set the output value CLKin_SEL0_TYPE is s | | s register only applies if | |
| | | | Field Value | Output | DAC Low DAC High SPI Readback Reserved Din. Itation Uttliup resistor pullidown etter Ush-pull) Ted (push-li) Date Dow Date Date Description of lingual modes; the CLKin_SEL0_MUX register for description of lingual mode. Date Date Date Date Date Date Date Date | |
| | | | 0 (0x00) | Logic | c Low | |
| | | | 1 (0x01) | CLKir | 0 LOS | |
| 5:3 | CLKin SEL0 MUX | 0 | 2 (0x02) | CLKin0 | Selected | |
| | | | 3 (0x03) | DAC I | _ocked | |
| | | | 4 (0x04) | DAC | Low | |
| | | | 5 (0x05) | DAC | High | |
| | | | 6 (0x06) | SPI Re | t Format ic Low n0 LOS Selected Locked C Low C High eadback served Function Input mode, see Section 8.3.6.2 for description of input mode. Output modes; the CLKin_SEL0_MUX | |
| | | | 7 (0x07) | Res | erved | |
| | | | This sets the IO type of the CLKin_SEL0 pin. | | | |
| | | | Field Value | Configuration | Function | |
| | | | 0 (0x00) | Input | | |
| | | | 1 (0x01) | Input with pullup resistor | | |
| 2:0 | CLKin_SEL0_TYPE | 2 | 2 (0x02) | Input with pulldown resistor | Format c Low no LOS Selected Locked C Low High eadback erved Function Input mode, see Section 8.3.6.2 for description of input mode. Output modes; the CLKin_SEL0_MUX | |
| | | | 3 (0x03) | Output (push-pull) | | |
| | | | 4 (0x04) | Output inverted (push- pull) | CLKin_SEL0_MUX | |
| | | | 5 (0x05) | Reserved | | |
| | | | 6 (0x06) | Output (open-drain) | · | |

8.6.2.4.4 SDIO_RDBK_TYPE, CLKin_SEL1_MUX, CLKin_SEL1_TYPE

This register has CLKin_SEL1 controls and register readback SDIO pin type.

Table 8-45. Register 0x149

| BIT | NAME | POR DEFAULT | | DESCRIPTION | |
|-----|-----------------|-------------|----------------------------------------------------------------------------------------------------------------------|----------------------------------------------------|---------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| 7 | NA | 0 | Reserved | | |
| 6 | SDIO_RDBK_TYPE | 1 | Sets the SDIO pin to open drain when during SPI readback in 3 wire mode. 0: Output, push-pull 1: Output, open drain. | | |
| | | | This set the output value CLKin_SEL1_TYPE is se | of the CLKin_SEL1 pin. Thi t to an output mode. | s register only applies if |
| | | | Field Value | Output | Format |
| | | | 0 (0x00) | Logic | Low |
| | | | 1 (0x01) | CLKin | 1 LOS |
| 5:3 | CLKin_SEL1_MUX | 0 | 2 (0x02) | CLKin1 | Selected |
| | | | 3 (0x03) | DAC L | this register only applies if ut Format gic Low Gin1 LOS 1 Selected C Locked AC Low AC High Readback eserved Function Input mode, see Section 8.3.6.2 for description of input mode. |
| | | | 4 (0x04) | DAC Low | |
| | | | 5 (0x05) | DAC High | |
| | | | 6 (0x06) | SPI Readback | |
| | | | 7 (0x07) | Rese | erved |
| | | | This sets the IO type of the | ne CLKin_SEL1 pin. | |
| | | | Field Value | Configuration | Function |
| | | | 0 (0x00) | Input | This register only applies if out Format ogic Low Kin1 LOS n1 Selected C Locked AC Low AC High Readback eserved Function Input mode, see Section 8.3.6.2 for description of input mode. Output modes; see the CLKin_SEL1_MUX register for description of |
| | | | 1 (0x01) | Input with pullup resistor | |
| 2:0 | CLKin_SEL1_TYPE | 2 | 2 (0x02) | Input with pulldown resistor | |
| | | | 3 (0x03) | Output (push-pull) | |
| | | | 4 (0x04) | Output inverted (push-pull) | |
| | | | 5 (0x05) | Reserved | |
| | | | 6 (0x06) | Output (open-drain) | |

8.6.2.5 RESET_MUX, RESET_TYPE

This register contains control of the RESET pin.

Table 8-46. Register 0x14A

| BIT | NAME | POR DEFAULT | e 6-46. Register ux i | DESCRIPTION | | | |
|-----|------------|-------------|-----------------------------------------------|--------------------------------------------------|----------------------------------------------------------------------------------------------------------------------------------------------------------|--|--|
| 7:6 | NA | 0 | Reserved | | | | |
| | | | This sets the output val RESET_TYPE is set to | ue of the RESET pin. This req an output mode. | gister only applies if | | |
| | | | | Output | Format | | |
| | | | 0 (0x00) | Logic | c Low | | |
| | | | 1 (0x01) | Res | erved | | |
| 5:3 | RESET_MUX | 0 | 2 (0x02) | CLKin2 | Selected | | |
| | | | 3 (0x03) | DAC I | _ocked | | |
| | | | 4 (0x04) | DAC | t Format ic Low served 2 Selected Locked C Low C High eadback Function Reset Mode Reset pin high = Reset Output modes; see the | | |
| | | | 5 (0x05) | DAC | High | | |
| | | | 6 (0x06) | SPI Re | eadback | | |
| | | | This sets the IO type of | the RESET pin. | | | |
| | | | Field Value | Configuration | Function | | |
| | | | 0 (0x00) | Input | t Format ic Low served 2 Selected Locked C Low C High eadback Function Reset Mode Reset pin high = Reset Output modes; see the RESET_MUX register for | | |
| | | | 1 (0x01) | Input with pullup resistor | | | |
| 2:0 | RESET_TYPE | 2 | 2 (0x02) | Input with pulldown resistor | | | |
| | | | 3 (0x03) | Output (push-pull) | | | |
| | | | 4 (0x04) | Output inverted (push- pull) | | | |
| | | | 5 (0x05) | Reserved | description of outputs. | | |
| | | | 6 (0x06) | Output (open-drain) |] | | |



8.6.2.6 (0x14B - 0x152) Holdover

8.6.2.6.1 LOS_TIMEOUT, LOS_EN, TRACK_EN, HOLDOVER_FORCE, MAN_DAC_EN, MAN_DAC[9:8]

This register contains the holdover functions.

Table 8-47. Register 0x14B

| BIT | NAME | POR DEFAULT | DESCR | RIPTION | |
|-----|--------------------|-------------|-----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|------------------------------------------|--|
| | | | This controls the amount of time in which switch event. | ch no activity on a CLKin forces a clock | |
| | | | Field Value | Timeout | |
| 7:6 | LOS_TIMEOUT | 0 | 0 (0x00) | 5 MHz typical | |
| | _ | | 1 (0x01) | 25 MHz typical | |
| | | | 2 (0x02) | 100 MHz typical | |
| | | | 3 (0x03) | 200 MHz typical | |
| 5 | LOS_EN | 0 | Enables the LOS (Loss-of-Signal) timeout control. Valid for MOS clock inputs. 0: Disabled 1: Enabled | | |
| 4 | TRACK_EN | 0 | Enable the DAC to track the PLL1 tuning voltage, optionally for use in holdover mode. After device reset, tracking starts at DAC code = 512. Tracking can be used to monitor PLL1 voltage in any mode. 0: Disabled 1: Enabled, will only track when PLL1 is locked. | | |
| 3 | HOLDOVER _FORCE | 0 | This bit forces holdover mode. When holdover mode is forced, if MAN_DAC_EN = 1, then the DAC will set the programmed MAN_DAC value. Otherwise the tracked DAC value will set the DAC voltage. 0: Disabled 1: Enabled. | | |
| 2 | MAN_DAC_EN | 1 | This bit enables the manual DAC mode. 0: Automatic 1: Manual | | |
| 1:0 | MAN_DAC[9:8] | 2 | See Section 8.6.2.6.2 for more information | tion on the MAN_DAC settings. | |

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8.6.2.6.2 MAN_DAC

These registers set the value of the DAC in holdover mode when used manually.

Table 8-48. MAN_DAC[9:0]

| MSB | LSB | |
|------------|------------|--|
| 0x14B[1:0] | 0x14C[7:0] | |

| REGISTER | BIT | NAME | POR DEFAULT | DESCRIPTION | |
|----------|-----|--------------|-------------|-----------------------------------------------------------|----------------------|
| 0x14B | 7:2 | | | See Section 8.6.2.6.1 for inform | ation on these bits. |
| | | | | Sets the value of the manual DAC when in manual DAC mode. | |
| 0x14B | 1:0 | MAN_DAC[9:8] | 2 | Field Value | DAC Value |
| | | | | 0 (0x00) | 0 |
| | | | | 1 (0x01) | 1 |
| | | | | 2 (0x02) | 2 |
| 0x14C | 7:0 | MAN DACIZO | 0 | | |
| 0.8140 | 7.0 | MAN_DAC[7:0] | 0 | 1022 (0x3FE) | 1022 |
| | | | | 1023 (0x3FF) | 1023 |

8.6.2.6.3 DAC_TRIP_LOW

This register contains the high value at which holdover mode is entered.

Table 8-49. Register 0x14D

| BIT | NAME | POR DEFAULT | DESCRIF | DESCRIPTION | | |
|-----|--------------|--------------|--------------------------------------------------------------------------------|----------------|--|--|
| 7:6 | NA | 0 | Reserved | | | |
| | | | Voltage from GND at which holdover is entered if HOLDOVER_VTUNE_DE is enabled. | | | |
| | | | Field Value | DAC Trip Value | | |
| | DAC_TRIP_LOW | C_TRIP_LOW 0 | 0 (0x00) | 1 x Vcc / 64 | | |
| | | | 1 (0x01) | 2 x Vcc / 64 | | |
| 5:0 | | | 2 (0x02) | 3 x Vcc / 64 | | |
| | | | 3 (0x03) | 4 x Vcc / 64 | | |
| | | | | | | |
| | | | 61 (0x17) | 62 x Vcc / 64 | | |
| | | | 62 (0x18) | 63 x Vcc / 64 | | |
| | | | 63 (0x19) | 64 x Vcc / 64 | | |



8.6.2.6.4 DAC_CLK_MULT, DAC_TRIP_HIGH

This register contains the multiplier for the DAC clock counter and the low value at which holdover mode is entered.

Table 8-50. Register 0x14E

| BIT | NAME | POR DEFAULT | DESCRIF | DESCRIPTION | | |
|-----|---------------|-----------------|-----------------------------------------------------------------|--------------------------------------|--|--|
| | | | This is the multiplier for the DAC_CLK_Cl DAC value is tracked. | NTR which sets the rate at which the | | |
| | | | Field Value | DAC Multiplier Value | | |
| 7:6 | DAC_CLK_MULT | 0 | 0 (0x00) | 4 | | |
| | | | 1 (0x01) | 64 | | |
| | | | 2 (0x02) | 1024 | | |
| | | | 3 (0x03) | 16384 | | |
| | DAC TRIP HIGH | DAC_TRIP_HIGH 0 | Voltage from Vcc at which holdover is ent enabled. | ered if HOLDOVER_VTUNE_DET is | | |
| | | | Field Value | DAC Trip Value | | |
| | | | 0 (0x00) | 1 x Vcc / 64 | | |
| | | | 1 (0x01) | 2 x Vcc / 64 | | |
| 5:0 | | | 2 (0x02) | 3 x Vcc / 64 | | |
| | | | 3 (0x03) | 4 x Vcc / 64 | | |
| | | | | | | |
| | | | 61 (0x17) | 62 x Vcc / 64 | | |
| | | | 62 (0x18) | 63 x Vcc / 64 | | |
| | | | 63 (0x19) | 64 x Vcc / 64 | | |

8.6.2.6.5 DAC_CLK_CNTR

This register contains the value of the DAC when in tracked mode.

Table 8-51. Register 0x14F

| BIT | NAME | POR DEFAULT | DESCRIPTION | | | |
|-----|--------------|-------------|------------------------------------------------------------------------|-----------|--|--|
| | | | This with DAC_CLK_MULT set the rate update rate is = DAC_CLK_MULT * DA | | | |
| | | | Field Value | DAC Value | | |
| | | 127 | 0 (0x00) | 0 | | |
| | DAC_CLK_CNTR | | 1 (0x01) | 1 | | |
| 7:0 | | | 2 (0x02) | 2 | | |
| | | | 3 (0x03) | 3 | | |
| | | | | | | |
| | | | 253 (0xFD) | 253 | | |
| | | | 254 (0xFE) | 254 | | |
| | | | 255 (0xFF) | 255 | | |

$8.6.2.6.6 \ CLK in _OVERRIDE, HOLDOVER_EXIT_MODE, HOLDOVER_PLL1_DET, LOS_EXTERNAL_INPUT, HOLDOVER_VTUNE_DET, CLK in _SWITCH_CP_TRI, HOLDOVER_EN$

This register has controls for enabling clock in switch events.

Table 8-52. Register 0x150

| BIT | NAME | POR DEFAULT | DESCRIPTION |
|-----|------------------------|-------------|--------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| 7 | NA | 0 | Reserved |
| 6 | CLKin _OVERRIDE | 0 | When manual clock select is enabled, then CLKin_SEL_MANUAL = 0/1/2 selects a manual clock input. CLKin_OVERRIDE = 1 will force that clock input. CLKin_OVERRIDE = 1 is used with clock distribution mode for best performance. 0: Normal, no override. 1: Force select of only CLKin0/1/2 as specified by CLKin_SEL_MANUAL in manual mode. Dynamic digital delay will not operate. |
| 5 | HOLDOVER_ EXIT_MODE | 0 | Exit based on LOS status. If clock is active by LOS, then begin exit. Exit based on PLL1 DLD. When the PLL1 phase detector confirming valid clock. |
| 4 | HOLDOVER _PLL1_DET | 0 | This enables the HOLDOVER when PLL1 lock detect signal transitions from high to low. 0: PLL1 DLD does not cause a clock switch event 1: PLL1 DLD causes a clock switch event |
| 3 | LOS_EXTERNAL_INPUT | 0 | Use external signals for LOS status instead of internal LOS circuitry. CLKin_SEL0 pin is used for CLKin0 LOS, CLKin_SEL1 pin is used for CLKin1 LOS, and Status_LD1 is used for CLKin2 LOS. For any of these pins to be valid, the corresponding _TYPE register must be programmed as an input. 0: Disabled 1: Enabled |
| 2 | HOLDOVER_ VTUNE_DET | 0 | Enables the DAC Vtune rail detector. When the DAC achieves a specified Vtune, if this bit is enabled, the current clock input is considered invalid and an input clock switch event is generated. 0: Disabled 1: Enabled |
| 1 | CLKin_SWITCH_CP_TRI | 0 | Enable clock switching with tri-stated charge pump. 0: Not enabled. 1: PLL1 charge pump tri-states during clock switching. |
| 0 | HOLDOVER_EN | 0 | Sets whether holdover mode is active or not. 0: Disabled 1: Enabled |



8.6.2.6.7 HOLDOVER_DLD_CNT

Table 8-53. HOLDOVER_DLD_CNT[13:0]

| MSB | LSB |
|-------------------------------------|------------------------------------|
| 0x151[5:0] / HOLDOVER_DLD_CNT[13:8] | 0x152[7:0] / HOLDOVER_DLD_CNT[7:0] |

This register has the number of valid clocks of PLL1 PDF before holdover is exited.

Table 8-54. Registers 0x151 and 0x152

| REGISTER | BIT | NAME | POR DEFAULT | DESCRIPTION | | |
|----------|-----|-------------------------------|-------------|--------------------------------------------------|------------------------|--|
| 0x151 | 7:6 | NA | 0 | Reserved | | |
| | | HOLDOVER _DLD_CNT[13:8] | 2 | The number of valid clocks of Pl mode is exited. | L1 PDF before holdover | |
| 0x151 | 5:0 | | | Field Value | Count Value | |
| | | | | 0 (0x00) | 0 | |
| | | | | 1 (0x01) | 1 | |
| | | | | 2 (0x02) | 2 | |
| 0.450 | 7:0 | 7:0 HOLDOVER _DLD_CNT[7:0] | 0 | | ••• | |
| 0x152 | | | | 16382 (0x3FFE) | 16382 | |
| | | | | 16383 (0x3FFF) | 16383 | |

8.6.2.7 (0x153 - 0x15F) PLL1 Configuration 8.6.2.7.1 CLKin0_R

Table 8-55. CLKin0_R[13:0]

| MSB | LSB | |
|-----------------------------|----------------------------|--|
| 0x153[5:0] / CLKin0_R[13:8] | 0x154[7:0] / CLKin0_R[7:0] | |

These registers contain the value of the CLKin0 divider.

Table 8-56. Registers 0x153 and 0x154

| Table 0-00. Registers 0x100 and 0x104 | | | | | | |
|---------------------------------------|--------------------------|-------------------|-------------|-------------------------------|-------------------------|--|
| REGISTER | BIT | NAME | POR DEFAULT | DESCRIPTION | | |
| 0x153 | 7:6 | NA | 0 | Reserved | | |
| | | | | The value of PLL1 N counter w | hen CLKin0 is selected. | |
| 0x153 | 5:0 | CLKin0 R[13:8] | 0 | Field Value | Divide Value | |
| 0.000 | | .u CENIIU_R[13.6] | | 0 (0x00) | Reserved | |
| | | | | 1 (0x01) | 1 | |
| | | CLKin0_R[7:0] | 120 | 2 (0x02) | 2 | |
| 0x154 | 54 7:0 CLKin0_R[7:0] 120 | | | | | |
| UX 154 | | | | 16382 (0x3FFE) | 16382 | |
| | | 16383 (0x3FFF) | 16383 | | | |

8.6.2.7.2 CLKin1_R

Table 8-57. CLKin1_R[13:0]

| MSB | | LSB | |
|-----|-----------------------------|----------------------------|--|
| | 0x155[5:0] / CLKin1_R[13:8] | 0x156[7:0] / CLKin1_R[7:0] | |

These registers contain the value of the CLKin1 R divider.

Table 8-58. Registers 0x155 and 0x156

| REGISTER | BIT | NAME | POR DEFAULT | DESCRIPTION | |
|----------|-----|-----------------|-------------|--------------------------------|-------------------------|
| 0x155 | 7:6 | NA | 0 | Reserved | |
| | | | | The value of PLL1 N counter wh | nen CLKin1 is selected. |
| 0x155 | 5:0 | CL Kin1 D[12:0] | 0 | Field Value | Divide Value |
| 0.000 | 3.0 | CLKin1_R[13:8] | | 0 (0x00) | Reserved |
| | | | | 1 (0x01) | 1 |
| | | | | 2 (0x02) | 2 |
| 0x156 | 7:0 | 0 CLKin1_R[7:0] | 150 | | |
| 0.00 | | | | 16382 (0x3FFE) | 16382 |
| | | | | 16383 (0x3FFF) | 16383 |



8.6.2.7.3 CLKin2_R

Table 8-59. CLKin2_R[13:0]

| MSB | LSB |
|-----------------------------|----------------------------|
| 0x157[5:0] / CLKin2_R[13:8] | 0x158[7:0] / CLKin2_R[7:0] |

Table 8-60. Registers 0x157 and 0x158

| i dalio o con regiono exter una exter | | | | | | |
|---------------------------------------|-----|-------------------------------|-------------------------|----------------|--------------|--|
| REGISTER | BIT | NAME | POR DEFAULT | DESCRIPTION | | |
| 0x157 | 7:6 | NA | 0 | Reserved | | |
| Т | | The value of PLL1 N counter w | hen CLKin2 is selected. | | | |
| 0v4E7 | 5:0 | CL Kin2 D[42.0] | 0 | Field Value | Divide Value | |
| 0x157 | | CLKin2_R[13:8] | | 0 (0x00) | Reserved | |
| | | | | 1 (0x01) | 1 | |
| | | | | 2 (0x02) | 2 | |
| 0.450 | 7.0 | CL Kin2 D[7:0] | 150 | | | |
| 0x158 | 7:0 | 7:0 CLKin2_R[7:0] | | 16382 (0x3FFE) | 16382 | |
| | | | | 16383 (0x3FFF) | 16383 | |
| | | | | | | |

8.6.2.7.4 PLL1_N

Table 8-61. PLL1_N[13:0]

| MSB | LSB | | | |
|---------------------------|--------------------------|--|--|--|
| 0x159[5:0] / PLL1_N[13:8] | 0x15A[7:0] / PLL1_N[7:0] | | | |

These registers contain the N divider value for PLL1.

Table 8-62. Registers 0x159 and 0x15A

| REGISTER | BIT | NAME | POR DEFAULT | DESCRIPTION | |
|----------|-----|--------------|-------------|------------------------------|--------------|
| 0x159 | 7:6 | NA | 0 | Reserved | |
| 0x159 | 5:0 | PLL1_N[13:8] | 0 | The value of PLL1 N counter. | |
| | | | | Field Value | Divide Value |
| | | | | 0 (0x00) | Not Valid |
| | | | | 1 (0x01) | 1 |
| 0x15A | 7:0 | PLL1_N[7:0] | 120 | 2 (0x02) | 2 |
| | | | | | |
| | | | | 4,095 (0xFFF) | 4,095 |

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$8.6.2.7.5~{\tt PLL1_WND_SIZE},~{\tt PLL1_CP_TRI},~{\tt PLL1_CP_POL},~{\tt PLL1_CP_GAIN}$

This register controls the PLL1 phase detector.

Table 8-63. Register 0x15B

| BIT | IT NAME POR DEFAULT DESCRIPTION | | | | | |
|-----|---------------------------------|---------------|-------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|-------------------------|--|--|
| ы | NAME | I ON BELLAGET | PLL1_WND_SIZE sets the window size used for digital lock detect for PLL1. If the phase error between the reference and feedback of PLL1 is less than specified time, then the PLL1 lock counter increments. | | | |
| | | | Field Value | Definition | | |
| 7:6 | PLL1_WND_SIZE | 3 | 0 (0x00) | 4 ns | | |
| | | | 1 (0x01) | 9 ns | | |
| | | | 2 (0x02) | 19 ns | | |
| | | | 3 (0x03) | 43 ns | | |
| 5 | PLL1_CP_TRI | 0 | This bit allows for the PLL1 charge pump output pin, CPout1, to be placed into TRI-STATE. 0: PLL1 CPout1 is active 1: PLL1 CPout1 is at TRI-STATE | | | |
| 4 | PLL1_CP_POL | 1 | PLL1_CP_POL sets the charge pump polarity for PLL1. Many VCXOs use positive slope. A positive slope VCXO increases output frequency with increasing voltage. A negative slope VCXO decreases output frequency with increasing voltage. 0: Negative Slope VCO/VCXO 1: Positive Slope VCO/VCXO | | | |
| | | | This bit programs the PLL1 charge pum | p output current level. | | |
| | | | Field Value | Gain | | |
| | | | 0 (0x00) | 50 μA | | |
| | | | 1 (0x01) | 150 μΑ | | |
| 3:0 | PLL1_CP_GAIN | 4 | 2 (0x02) | 250 μΑ | | |
| 3.0 | PLLI_CP_GAIN | 4 | 3 (0x03) | 350 μΑ | | |
| | | | 4 (0x04) | 450 μA | | |
| | | | 14 (0x0E) | 1450 µA | | |
| | | | 15 (0x0F) | 1550 µA | | |



8.6.2.7.6 PLL1_DLD_CNT

Table 8-64. PLL1_DLD_CNT[13:0]

| MSB | LSB | |
|---------------------------------|--------------------------------|--|
| 0x15C[5:0] / PLL1_DLD_CNT[13:8] | 0x15D[7:0] / PLL1_DLD_CNT[7:0] | |

This register contains the value of the PLL1 DLD counter.

Table 8-65. Registers 0x15C and 0x15D

| Table 0-03. Registers 0x100 and 0x10D | | | | | |
|---------------------------------------|-----|------------------------|-------------|-----------------------------------------------------------------------------------------------------------------|---------------------------|
| REGISTER | BIT | NAME | POR DEFAULT | DESCR | IPTION |
| 0x15C | 7:6 | NA | 0 | Reserved | |
| 0x15C | 5:0 | PLL1_DLD _CNT[13:8] | | The reference and feedback of window of phase error as speci this many phase detector cycle detect is asserted. | fied by PLL1_WND_SIZE for |
| 0.150 | 3.0 | | | Field Value | Delay Value |
| | | | | 0 (0x00) | Reserved |
| | | | | 1 (0x01) | 1 |
| | | | | 2 (0x02) | 2 |
| | | | | 3 (0x03) | 3 |
| 0x15D | 7:0 | PLL1_DLD CNT[7:0] | 0 | | |
| | | _GN1[7.0] | | 16,382 (0x3FFE) | 16,382 |
| | | | | 16,383 (0x3FFF) | 16,383 |

8.6.2.7.7 HOLDOVER_EXIT_NADJ

Table 8-66. Register 0x15E

| BIT | NAME | POR DEFAULT | DESCRIPTION |
|-----|--------------------|-------------|--------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| 7:5 | NA | 0 | Reserved |
| 4:0 | HOLDOVER_EXIT_NADJ | 30 | When holdover exists, PLL1 R counter and PLL1 N counter are reset. HOLDOVER_EXIT_NADJ is a 2s complement number which provides a relative timing offset between PLL1 R and PLL1 N divider. |

8.6.2.7.8 PLL1_LD_MUX, PLL1_LD_TYPE

This register configures the PLL1 LD pin.

Table 8-67. Register 0x15F

| BIT | NAME | POR DEFAULT | DESCR | RIPTION |
|-----|--------------|-------------|------------------------------------------|-----------------------------------------|
| | | | This sets the output value of the Status | _LD1 pin. |
| | | | Field Value | MUX Value |
| | | | 0 (0x00) | Logic Low |
| | | | 1 (0x01) | PLL1 DLD |
| | | | 2 (0x02) | PLL2 DLD |
| | | | 3 (0x03) | PLL1 & PLL2 DLD |
| | | | 4 (0x04) | Holdover Status |
| | | | 5 (0x05) | DAC Locked |
| | | | 6 (0x06) | Reserved |
| | | | 7 (0x07) | SPI Readback |
| 7:3 | PLL1_LD_MUX | 1 | 8 (0x08) | DAC Rail |
| | | | 9 (0x09) | DAC Low |
| | | | 10 (0x0A) | DAC High |
| | | | 11 (0x0B) | PLL1_N |
| | | | 12 (0x0C) | PLL1_N/2 |
| | | 13 (0x0D) | PLL2_N | |
| | | | 14 (0x0E) | PLL2_N/2 |
| | | | 15 (0x0F) | PLL1_R |
| | | | 16 (0x10) | PLL1_R/2 |
| | | | 17 (0x11) | PLL2_R ⁽¹⁾ |
| | | | 18 (0x12) | PLL2_R/2 ⁽¹⁾ |
| | | | Sets the IO type of the Status_LD1 pin | - |
| | | | Field Value | TYPE |
| | | | 0 (0x00) | Input for External CLKin2 LOS |
| | | | 1 (0x01) | Input for External CLKin2 LOS (pullup) |
| 2:0 | PLL1_LD_TYPE | 6 | 2 (0x02) | Input for External CLKin2 LOS (pulldwn) |
| | | | 3 (0x03) | Output (push-pull) |
| | | | 4 (0x04) | Output inverted (push-pull) |
| | | | 5 (0x05) | Reserved |
| | | | 6 (0x06) | Output (open-drain) |

⁽¹⁾ Only valid when PLL2_LD_MUX is not set to 2 (PLL2_DLD) or 3 (PLL1 & PLL2 DLD).



8.6.2.8 (0x160 - 0x16E) PLL2 Configuration 8.6.2.8.1 PLL2_R

Table 8-68. PLL2_R[11:0]

| MSB | LSB |
|---------------------------|--------------------------|
| 0x160[3:0] / PLL2_R[11:8] | 0x161[7:0] / PLL2_R[7:0] |

This register contains the value of the PLL2 R divider.

Table 8-69. Registers 0x160 and 0x161

| REGISTER | BIT | NAME | POR DEFAULT | DESCRI | PTION |
|----------|-------------------|---------------|-------------|-----------------------------------|--------------|
| 0x160 | 7:4 | NA | 0 | Reserved | |
| | | | | Valid values for the PLL2 R divid | ler. |
| 0×160 | 3:0 | DL LO D[44.0] | 0 | Field Value | Divide Value |
| 0x160 | 3.0 | PLL2_R[11:8] | 0 | 0 (0x00) | Not Valid |
| | | | | 1 (0x01) | 1 |
| | | | | 2 (0x02) | 2 |
| | | | 3 (0x03) | 3 | |
| 0x161 | 7:0 PLL2_R[7:0] 2 | 2 | | | |
| | | | | 4,094 (0xFFE) | 4,094 |
| | | | | 4,095 (0xFFF) | 4,095 |

8.6.2.8.2 PLL2_P, OSCin_FREQ, PLL2_REF_2X_EN

This register sets other PLL2 functions.

Table 8-70. Register 0x162

| BIT | NAME | POR DEFAULT | DESCRIPTION | | |
|-----|----------------|-------------|----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|--------------------------------|--|
| | | | The PLL2 N Prescaler divides the output of the VCO as selected by Mode_MUX1 and is connected to the PLL2 N divider. | | |
| | | | Field Value | Value | |
| | | | 0 (0x00) | 8 | |
| | | | 1 (0x01) | 2 | |
| 7:5 | PLL2_P | 2 | 2 (0x02) | 2 | |
| | _ | | 3 (0x03) | 3 | |
| | | | 4 (0x04) | 4 | |
| | | | 5 (0x05) | 5 | |
| | | | 6 (0x06) | 6 | |
| | | | 7 (0x07) | 7 | |
| | | 3 | The frequency of the PLL2 reference in (OSCin/OSCin* port) must be program operation of the frequency calibration rethe target frequency. | med in order to support proper | |
| | | | Field Value | OSCin Frequency | |
| 4:2 | OSCin FREQ | | 0 (0x00) | 0 to 63 MHz | |
| 4.2 | OSCIII_FREQ | 3 | 1 (0x01) | >63 MHz to 127 MHz | |
| | | | 2 (0x02) | >127 MHz to 255 MHz | |
| | | | 3 (0x03) | Reserved | |
| | | | 4 (0x04) | >255 MHz to 500 MHz | |
| | | | 5 (0x05) to 7(0x07) | Reserved | |
| 1 | NA | 0 | Reserved | | |
| 0 | PLL2_REF_2X_EN | 1 | Enabling the PLL2 reference frequency doubler allows for higher phase detector frequencies on PLL2 than would normally be allowed with the given VCXO frequency. Higher phase detector frequencies reduces the PLL2 N values which makes the design of wider loop bandwidth filters possible. 0: Doubler Disabled 1: Doubler Enabled | | |

8.6.2.8.3 PLL2_N_CAL

PLL2_N_CAL[17:0]

PLL2 never uses 0-delay during frequency calibration. These registers contain the value of the PLL2 N divider used with PLL2 pre-scaler during calibration for cascaded 0-delay mode. Once calibration is complete, PLL2 will use PLL2_N value. Cascaded 0-delay mode occurs when PLL2_NCLK_MUX = 1.

Table 8-71. PLL2_N_CAL[17:0]

| MSB | _ | LSB | |
|--------------------------------|-------------------------------|------------------------------|--|
| 0x163[1:0] / PLL2_N_CAL[17:16] | 0x164[7:0] / PLL2_N_CAL[15:8] | 0x165[7:0] / PLL2_N_CAL[7:0] | |

Table 8-72. Registers 0x163, 0x164, and 0x165

| REGISTER | BIT | NAME | POR DEFAULT | DESCRIPTION | |
|----------|----------------------|--------------------|-------------|-------------------|-----------|
| 0x163 | 7:2 | NA | 0 | Reserved | |
| 0x163 | 4.0 PH 0 N CALIATACI | | Field Value | Divide Value | |
| 0.000 | 1:0 | PLL2_N _CAL[17:16] | 0 | 0 (0x00) | Not Valid |
| 0x164 | 7:0 | PLL2 N CAL[15:8] | 0 | 1 (0x01) | 1 |
| 0.7104 | 7.0 | FLLZ_N_CAL[13.0] | U | 2 (0x02) | 2 |
| 0x165 | 7:0 | PLL2_N_CAL[7:0] | 12 | | |
| 0.103 | 7.0 PLLZ_N_CAL[| FLLZ_N_OAL[1.0] | 7.0] 12 | 262,143 (0x3FFFF) | 262,143 |

8.6.2.8.4 PLL2_N

This register disables frequency calibration and sets the PLL2 N divider value. Programming register 0x168 starts a VCO calibration routine if PLL2_FCAL_DIS = 0.

Table 8-73. PLL2_N[17:0]

| MSB | _ | LSB |
|----------------------------|---------------------------|--------------------------|
| 0x166[1:0] / PLL2_N[17:16] | 0x167[7:0] / PLL2_N[15:8] | 0x168[7:0] / PLL2_N[7:0] |

Table 8-74. Registers 0x166, 0x167, and 0x168

| REGISTER | BIT | NAME | POR DEFAULT | DESCRIPTION | |
|----------|---------------------|-----------------------------------------|-------------|-------------------|--------------|
| 0x166 | 7:3 | NA | 0 | Reserved | |
| 0x166 | 1.0 | DLI 2 NI(47,461 | | Field Value | Divide Value |
| 0.00 | 1:0 PLL2_N[17:16] 0 | 0 | 0 (0x00) | Not Valid | |
| 0x167 | 7.0 | 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 | 0 | 1 (0x01) | 1 |
| 0.07 | 7:0 | PLL2_N[15:8] | 0 | 2 (0x02) | 2 |
| 0x168 | 7:0 | DLL2 N[7:0] | 12 | | |
| 0.108 | 7.0 | PLL2_N[7:0] | 12 | 262,143 (0x3FFFF) | 262,143 |

$8.6.2.8.5~{\tt PLL2_WND_SIZE},~{\tt PLL2_CP_GAIN},~{\tt PLL2_CP_POL},~{\tt PLL2_CP_TRI}$

This register controls the PLL2 phase detector.

Table 8-75. Register 0x169

| BIT | NAME | POR DEFAULT | DESCR | RIPTION | |
|-----|----------------|-------------|-------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|---------------------------------------------------------------------------|--|
| 7 | NA | 0 | Reserved | | |
| | | | PLL2_WND_SIZE sets the window size the phase error between the reference a specified time, then the PLL2 lock countries. | and feedback of PLL2 is less than | |
| 6:5 | PLL2 WND SIZE | 2 | Field Value | Maximum Phase Detector Frequency / Window Size | |
| 0.5 | FLLZ_WIND_SIZE | 2 | 0 (0x00) | Reserved | |
| | | | 1 (0x01) | 320 MHz / 1 ns | |
| | | | 2 (0x02) | 240 MHz / 1.8 ns | |
| | | | 3 (0x03) | 160 MHz / 2.6 ns | |
| | | | This bit programs the PLL2 charge pum also illustrates the impact of the PLL2 T PLL2_CP_GAIN. | | |
| | | 3 | Field Value | Definition | |
| 4:3 | PLL2_CP_GAIN | | 0 (0x00) | Reserved | |
| | | | 1 (0x01) | Reserved | |
| | | | 2 (0x02) | 1600 μΑ | |
| | | | 3 (0x03) | 3200 μΑ | |
| 2 | PLL2 CP POL | L 0 | PLL2_CP_POL sets the charge pump prequires the negative charge pump polar positive slope. A positive slope VCO increases output negative slope VCO decreases output from the property of the | arity to be selected. Many VCOs use frequency with increasing voltage. A | |
| | | | Field Value | Description | |
| | | | 0 | Negative Slope VCO/VCXO | |
| | | | 1 | Positive Slope VCO/VCXO | |
| 1 | PLL2_CP_TRI | 0 | PLL2_CP_TRI TRI-STATEs the output of the PLL2 charge pump. 0: Disabled 1: TRI-STATE | | |
| 0 | PLL2_DLD_EN 0 | | PLL2 DLD circuitry is enabled when the to a lock detect status pin. PLL2_DLD_I circuitry without needing to provide PLL PLL2 DLD status to be read back using be used for other purposes. 0: PLL2 DLD circuitry is on only of PLL2 output from a Status_LD_MUX. 1: PLL2 DLD circuitry is forced on. | 2 DLD to a status pin. This enables SPI while allowing the Status pins to | |



8.6.2.8.6 PLL2_DLD_CNT

Table 8-76. PLL2_DLD_CNT[13:0]

| MSB | LSB | |
|---------------------------------|--------------------------------|--|
| 0x16A[5:0] / PLL2_DLD_CNT[13:8] | 0x16B[7:0] / PLL2_DLD_CNT[7:0] | |

This register has the value of the PLL2 DLD counter.

Table 8-77. Registers 0x16A and 0x16B

| REGISTER | BIT | NAME | POR DEFAULT | DESCRI | IPTION |
|----------|-----|------------------------|-------------|----------------------------------------------------------------------------------------------------|--------------------------|
| 0x16A | 7 | NA | 0 | Reserved | |
| 0x16A | 5:0 | PLL2_DLD _CNT[13:8] | | The reference and feedback of window of phase error as specif PLL2_DLD_CNT cycles before asserted. | ied by PLL2_WND_SIZE for |
| OXTOA | 3.0 | | | Field Value | Divide Value |
| | | | | 0 (0x00) | Not Valid |
| | | | | 1 (0x01) | 1 |
| | | 7:0 PLL2_DLD_CNT | 0 | 2 (0x02) | 2 |
| | 7:0 | | | 3 (0x03) | 3 |
| 0x16B | | | | | |
| | | | | 16,382 (0x3FFE) | 16,382 |
| | | | | 16,383 (0x3FFF) | 16,383 |

8.6.2.8.7 PLL2_LD_MUX, PLL2_LD_TYPE

This register sets the output value of the Status_LD2 pin.

Table 8-78. Register 0x16E

| BIT | NAME | POR DEFAULT | DESCR | RIPTION |
|-----|--------------|-------------|------------------------------------------|-----------------------------|
| | | | This sets the output value of the Status | _LD2 pin. |
| | | | Field Value | MUX Value |
| | | | 0 (0x00) | Logic Low |
| | | | 1 (0x01) | PLL1 DLD |
| | | | 2 (0x02) | PLL2 DLD |
| | | | 3 (0x03) | PLL1 & PLL2 DLD |
| | | | 4 (0x04) | Holdover Status |
| | | | 5 (0x05) | DAC Locked |
| | | | 6 (0x06) | Reserved |
| | | | 7 (0x07) | SPI Readback |
| 7:3 | PLL2_LD_MUX | 0 | 8 (0x08) | DAC Rail |
| | | | 9 (0x09) | DAC Low |
| | | | 10 (0x0A) | DAC High |
| | | | 11 (0x0B) | PLL1_N |
| | | | 12 (0x0C) | PLL1_N/2 |
| | | | 13 (0x0D) | PLL2_N |
| | | | 14 (0x0E) | PLL2_N/2 |
| | | | 15 (0x0F) | PLL1_R |
| | | | 16 (0x10) | PLL1_R/2 |
| | | | 17 (0x11) | PLL2_R ⁽¹⁾ |
| | | | 18 (0x12) | PLL2_R/2 ⁽¹⁾ |
| | | | Sets the IO type of the Status_LD2 pin. | |
| | | | Field Value | TYPE |
| | | | 0 (0x00) | Reserved |
| | | | 1 (0x01) | Reserved |
| 2:0 | PLL2_LD_TYPE | 6 | 2 (0x02) | Reserved |
| | | | 3 (0x03) | Output (push-pull) |
| | | | 4 (0x04) | Output inverted (push-pull) |
| | | | 5 (0x05) | Reserved |
| | | | 6 (0x06) | Output (open drain) |

⁽¹⁾ Only valid when PLL1_LD_MUX is not set to 2 (PLL2_DLD) or 3 (PLL1 & PLL2 DLD).



8.6.2.9 (0x16F - 0x555) Misc Registers 8.6.2.9.1 PLL2_PRE_PD, PLL2_PD, FIN0_PD

Table 8-79. Register 0x173

| BIT | NAME | POR DEFAULT | DESCRIPTION |
|-----|-------------|-------------|-----------------------------------------------------------|
| 7 | N/A | 0 | Reserved |
| 6 | PLL2_PRE_PD | 1 | Powerdown PLL2 prescaler 0: Normal Operation 1: Powerdown |
| 5 | PLL2_PD | 1 | Powerdown PLL2 0: Normal Operation 1: Powerdown |
| 4 | FIN0_PD 1 | | Powerdown Fin0 0: Normal Operation 1: Powerdown |
| 3:0 | N/A | 0 | Reserved |

8.6.2.9.2 PLL1R_RST

Refer to Section 8.3.1.1 for more information on synchronizing PLL1 R divider.

Table 8-80. Register 0x177

| BIT | NAME | POR DEFAULT | DESCRIPTION |
|-----|-----------|-------------|----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| 7:6 | NA | 0 | Reserved |
| 5 | PLL1R_RST | 0 | When set, PLL1 R divider will be held in reset. PLL1 will never lock with PLL1R_RST = 1. This bit is used in when synchronizing the PLL1 R divider. 0: PLL1 R divider normal operation. 1: PLL1 R divider held in reset. |
| 4:0 | NA | 0 | Reserved |

8.6.2.9.3 CLR_PLL1_LD_LOST, CLR_PLL2_LD_LOST

Table 8-81. Register 0x182

| BIT | NAME | POR DEFAULT | DESCRIPTION |
|-----|--------------------|-------------|--------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| 7:2 | NA | 0 | Reserved |
| 1 | CLR_PLL1_LD_LOST 0 | | To reset RB_PLL1_LD_LOST, write CLR_PLL1_LD_LOST with 1 and then 0. 0: RB_PLL1_LD_LOST will be set on next falling PLL1 DLD edge. 1: RB_PLL1_LD_LOST is held clear (0). User must clear this bit to allow RB_PLL1_LD_LOST to become set again. |
| 0 | CLR_PLL2_LD_LOST | 0 | To reset RB_PLL2_LD_LOST, write CLR_PLL2_LD_LOST with 1 and then 0. 0: RB_PLL2_LD_LOST will be set on next falling PLL2 DLD edge. 1: RB_PLL2_LD_LOST is held clear (0). User must clear this bit to allow RB_PLL2_LD_LOST to become set again. |

8.6.2.9.4 RB_PLL1_LD_LOST, RB_PLL1_LD, RB_PLL2_LD_LOST, RB_PLL2_LD

For PLL2 DLD read back to be valid, either PLL2 DLD or PLL1 + PLL2 DLD signal must be output from the status pins, or PLL2_DLD_EN bit must be set = 1.

Table 8-82. Register 0x183

| | Table 6 621 Hogister 6X100 | | | | | |
|-----|----------------------------|-------------|-----------------------------------------------------------------------------------------------------------------------------------------------------------|--|--|--|
| BIT | NAME | POR DEFAULT | DESCRIPTION | | | |
| 7:4 | N/A | 0 | Reserved | | | |
| 3 | RB_PLL1_LD_LOST | 0 | This is set when PLL1 DLD edge falls. Does not set if cleared while PLL1 DLD is low. | | | |
| 2 | RB_PLL1_LD | 0 | Read back 0: PLL1 DLD is low. Read back 1: PLL1 DLD is high. | | | |
| 1 | RB_PLL2_LD_LOST | 0 | This is set when PLL2 DLD edge falls. Does not set if cleared while PLL2 DLD is low. | | | |
| 0 | RB_PLL2_LD | 0 | PLL1_LD_MUX or PLL2_LD_MUX must select setting 2 (PLL2 DLD) for valid reading of this bit. Read back 0: PLL2 DLD is low. Read back 1: PLL2 DLD is high. | | | |



8.6.2.9.5 RB_DAC_VALUE (MSB), RB_CLKinX_SEL, RB_CLKinX_LOS

This register provides read back access to CLKinX selection indicator and CLKinX LOS indicator. The 2 MSBs are shared with the RB_DAC_VALUE. See RB_DAC_VALUE section.

Table 8-83. Register 0x184

| BIT | NAME | POR DEFAULT | DESCRIPTION |
|-----|-------------------|-------------|-----------------------------------------------------------------------------------------------------------|
| 7:6 | RB_DAC_VALUE[9:8] | | See RB_DAC_VALUE section. |
| 5 | RB_CLKin2_SEL | | Read back 0: CLKin2 is not selected for input to PLL1. Read back 1: CLKin2 is selected for input to PLL1. |
| 4 | RB_CLKin1_SEL | | Read back 0: CLKin1 is not selected for input to PLL1. Read back 1: CLKin1 is selected for input to PLL1. |
| 3 | RB_CLKin0_SEL | | Read back 0: CLKin0 is not selected for input to PLL1. Read back 1: CLKin0 is selected for input to PLL1. |
| 2 | N/A | | |
| 1 | RB_CLKin1_LOS | | Read back 1: CLKin1 LOS is active. Read back 0: CLKin1 LOS is not active. |
| 0 | RB_CLKin0_LOS | | Read back 1: CLKin0 LOS is active. Read back 0: CLKin0 LOS is not active. |

8.6.2.9.6 RB_DAC_VALUE

Contains the value of the DAC for user readback.

Table 8-84. RB_DAC_VALUE[9:0]

| MSB | LSB | |
|---------------------------------|---------------------------------|--|
| 0x184 [7:6] / RB_DAC_VALUE[9:8] | 0x185 [7:0] / RB_DAC_VALUE[7:0] | |

Table 8-85. Registers 0x184 and 0x185

| | | | • | |
|----------|-----|-----------------------|-------------|--------------------------------------------------------|
| REGISTER | BIT | NAME | POR DEFAULT | |
| 0x184 | 7:6 | RB_DAC_ VALUE[9:8] | 2 | DAC value is 512 on power on reset, if PLL1 locks upon |
| 0x185 | 7:0 | RB_DAC_ VALUE[7:0] | 0 | power-up the DAC value will change. |

8.6.2.9.7 RB_HOLDOVER

Table 8-86. Register 0x188

| BIT | NAME | POR DEFAULT | DESCRIPTION |
|-----|-------------|-------------|---------------------------------------------------------|
| 7:5 | N/A | | Reserved |
| 4 | RB_HOLDOVER | | Read back 0: Not in HOLDOVER. Read back 1: In HOLDOVER. |
| 3:0 | N/A | | Reserved |

8.6.2.9.8 SPI_LOCK

Prevents SPI registers from being written to, except for 0x555.

This register cannot be read back.

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Table 8-87. Register 0x555

| BIT | BIT NAME POR DEFAULT | | DESCRIPTION | | | |
|-----|----------------------|---|-------------------------------------------------------|--|--|--|
| 7:0 | SPI_LOCK | 0 | 0: Registers unlocked. 1 to 255: Registers locked. | | | |

9 Application and Implementation

Note

Information in the following applications sections is not part of the TI component specification, and TI does not warrant its accuracy or completeness. TI's customers are responsible for determining suitability of components for their purposes, as well as validating and testing their design implementation to confirm system functionality.

9.1 Application Information

To assist customers in frequency planning and design of loop filters, Texas Instruments provides Clock Architect and PLLatinum Sim and on ti.com.

9.1.1 Treatment of Unused Pins

Not all pins are needed for every application. In general, power down the unused feature in software. The unused pin may be left floating or grounded through a 1-k Ω resistor.

| PINS | TREATMENT IF UNUSED | | | | | | | |
|-----------------------|--------------------------|--|--|--|--|--|--|--|
| CLKoutX/CLKoutX* | 1 kΩ to GND or float pin | | | | | | | |
| RESET/GPO | 1 kΩ to GND or float pin | | | | | | | |
| SYNC/SYSREF_REQ | 1 kΩ to GND or float pin | | | | | | | |
| Fin0/Fin0* | 1 kΩ to GND or float pin | | | | | | | |
| Status_LD1,Status_LD2 | 1 kΩ to GND or float pin | | | | | | | |
| CPout1/CPout2 | 1 kΩ to GND or float pin | | | | | | | |
| OSCout/CLKin2 | 1 kΩ to GND or float pin | | | | | | | |
| OSCout*/CLKin2* | 1 kΩ to GND or float pin | | | | | | | |

Table 9-1. Treatment of Unused Pins

9.1.2 Digital Lock Detect Frequency Accuracy

The digital lock detect circuit is used to determine PLL1 locked, PLL2 locked, and holdover exit events. A window size and lock count register are programmed to set a ppm frequency accuracy of reference to feedback signals of the PLL for each event to occur. When a PLL digital lock event occurs, the digital lock detect of the PLL is asserted true. When the holdover exit event occurs, the device will exit holdover mode when HOLDOVER_EXIT_MODE = 1 (Exit based on DLD).

| Table 3-2. Digital Lock Detect Related Fields | | | | | | | | |
|-----------------------------------------------|------|---------------|------------------|--|--|--|--|--|
| EVENT | PLL | WINDOW SIZE | LOCK COUNT | | | | | |
| PLL1 Locked | PLL1 | PLL1_WND_SIZE | PLL1_DLD_CNT | | | | | |
| PLL2 Locked | PLL2 | PLL2_WND_SIZE | PLL2_DLD_CNT | | | | | |
| Holdover exit | PLL1 | PLL1_WND_SIZE | HOLDOVER_DLD_CNT | | | | | |

Table 9-2. Digital Lock Detect Related Fields

For a digital lock detect event to occur, there must be a *lock count* number of phase detector cycles of PLLX during which the time and phase error of the PLLX_R reference and PLLX_N feedback signal edges are within the user programmable *window size*. Because there must be at least one *lock count* phase detector event before a lock event occurs, a minimum digital lock event time can be calculated as *lock count* / f_{PDX} where X = 1 for PLL1 or 2 for PLL2.

By using Equation 4, values for a *lock count* and *window size* can be chosen to set the frequency accuracy required by the system in ppm before the digital lock detect event occurs:

$$ppm = \frac{1e6 \times PLLX_WND_SIZE \times f_{PDX}}{PLLX_DLD_CNT}$$
(4)

The effect of the *lock count* value is that it shortens the effective lock window size by dividing the *window size* by *lock count*.

If at any time the PLLX_R reference and PLLX_N feedback signals are outside the time window set by window size, then the lock count value is reset to 0.

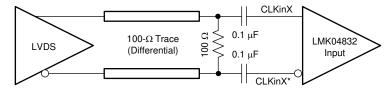
9.1.2.1 Minimum Lock Time Calculation Example

To calculate the minimum PLL2 *digital* lock time given a PLL2 phase detector frequency of 40 MHz and PLL2_DLD_CNT = 10,000. Then, the minimum lock time of PLL2 will be 10,000 / 40 MHz = $250 \mu s$.

9.1.3 Driving CLKin AND OSCin Inputs

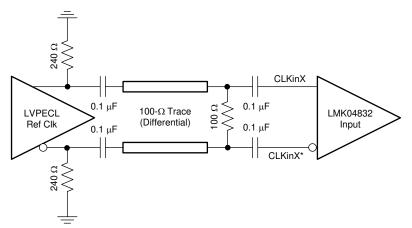
9.1.3.1 Driving CLKin and OSCin PINS With a Differential Source

CLKin and OSCin pins can be driven by differential signals. TI recommends setting the input mode to bipolar (CLKinX_BUF_TYPE = 0) when using differential reference clocks. The device internally biases the input pins so the differential interface should be AC-coupled. The recommended circuits for driving the CLKin pins with either LVDS or LVPECL are shown in Figure 9-1 and Figure 9-2.



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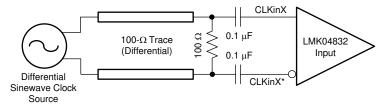
Figure 9-1. CLKinX/X* or OSCin Termination for an LVDS Reference Clock Source



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Figure 9-2. CLKinX/X* or OSCin Termination for an LVPECL Reference Clock Source

Finally, a reference clock source that produces a differential sine wave output can drive the CLKin pins using the following circuit. Note: the signal level must conform to the requirements for the CLKin pins listed in the Section 6.5.



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Figure 9-3. CLKinX/X* or OSCin Termination for a Differential Sinewave Reference Clock Source

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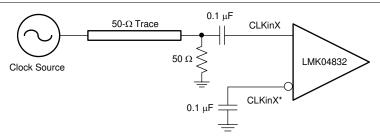
9.1.3.2 Driving CLKin Pins With a Single-Ended Source

The CLKin and OSCin pins can be driven using a single-ended reference clock source, for example, either a sine wave source or an LVCMOS/LVTTL source. CLKin supports both AC coupling or DC coupling. OSCin must use AC coupling. In the case of the sine wave source that is expecting a $50-\Omega$ load, TI recommends using AC coupling as shown in Figure 9-4 with a $50-\Omega$ termination.

Note

The signal level must conform to the requirements for the CLKin or OSCin pins listed in the Section 6.5.

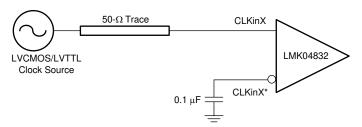
To support LOS functionality, CLKinX_BUF_TYPE must be set to MOS mode (CLKinX_BUF_TYPE = 1) when AC-coupled. When AC coupling, if the $100-\Omega$ termination is placed on the IC side of the blocking capacitors, then the LOS functionality will not be valid.



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Figure 9-4. CLKinX/X* Single-Ended Termination

If the CLKin pins are being driven with a single-ended LVCMOS/LVTTL source, either DC coupling or AC coupling may be used. If DC coupling is used, the CLKinX_BUF_TYPE should be set to MOS buffer mode (CLKinX_BUF_TYPE = 1) and the voltage swing of the source must meet the specifications for DC -oupled, MOS-mode clock inputs given in the Section 6.5. If AC coupling is used, the CLKinX_BUF_TYPE should be set to the bipolar buffer mode (CLKinX_BUF_TYPE = 0). The voltage swing at the input pins must meet the specifications for AC-coupled, bipolar mode clock inputs given in the Section 6.5. In this case, some attenuation of the clock input level may be required. A simple resistive divider circuit before the AC-coupling capacitor is sufficient.



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Figure 9-5. DC-Coupled LVCMOS/LVTTL Reference Clock

9.1.4 OSCin Doubler for Best Phase Noise Performance

PLL2 OSCin input path includes an on-chip Frequency Doubler. To have the best phase noise performance, TI recommends to maximize the PLL2 phase detector frequency. For example, using 122.88-MHz VCXO, PLL2 phase detector frequency can be increased to 245.76 MHz by setting PLL2_REF_2X_EN. Doubler path is a high performance path for OSCin clock. For configuration where doubler cannot be used, TI recomends to use Doubler and PLL2_RDIV = 2. To have deterministic phase relationship between input clock and output clocks, 0-delay modes should be used (nested 0-delay mode for dual loop configuration instead of cascaded 0-delay mode).

9.1.5 Radiation Environments

9.1.5.1 Total Ionizing Dose

Radiation Hardness assured (RHA) products are those part numbers with a total ionizing dose (TID) level specified in the ordering information. Testing and qualification of these product is done on a wafer level according to MIL-STD-883, test method 1019. Wafer level TID data are available with lot shipments.

9.1.5.2 Single Event Effect

One time single event effect (SEE), including single event latch-up (SEL), single event functional interrupt (SEFI) and single event upset (SEU), testing was performed according to EIA/JEDEC Standard, EIA/JEDEC57. A test report is available upon request.

9.2 Typical Application

This design example highlights using the available tools to design loop filters and create programming map.

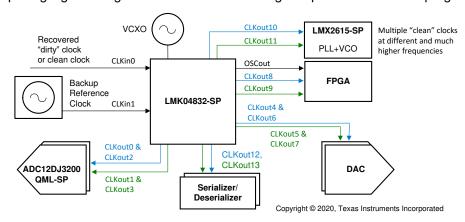


Figure 9-6. Typical Application

9.2.1 Design Requirements

Clocks outputs:

- 1x 245.76-MHz clock for JESD204B ADC, LVPECL.
 - This clock requires the best performance in this example.
- 2x 2949.12-MHz clock for JESD204B DAC, CML.
- 1x 122.88-MHz clock for JESD204B FPGA block, LVDS.
- 3x 10.24-MHz SYSREF for ADC (LVPECL), DAC (LVPECL), FPGA (LVDS).
- 2x 122.88-MHz clock for FPGA, LVDS.

For best performance, the highest possible phase detector frequency is used at PLL2. As such, a 122.88-MHz VCXO is used.

9.2.2 Detailed Design Procedure

Note

This information is current as of the date of the release of this data sheet. Design tools receive continuous improvements to add features and improve model accuracy. Refer to the software instructions or training for latest features.

9.2.2.1 Device Selection

Enter the required frequencies into the tools. In this design, VCO0 and VCO1 both meet the design requirements. VCO0 offers a relatively improved VCO performance over VCO1. In this case, choose VCO0 for improved RMS jitter in the 12-kHz to 20-MHz integration range.

9.2.2.1.1 Clock Architect

Under the advanced tab of the Clock Architect, filtering of specific parts can be done using regular expressions in the Part Filter box. [LMK04832.*] will filter for only the LMK04832 device (without brackets). More detailed filters can be given such as the entire part name LMK04832_VCO0 to force an LMK04832 using VCO0 solution if one is available.

9.2.2.2 Device Configuration and Simulation

The tools automatically configure the simulation to meet the input and output frequency requirements given, and make assumptions about other parameters to give some default simulations. However, the user may chose to make adjustments for more accurate simulations to their application. For example:

- Entering the VCO Gain of the external VCXO or possible external VCO used device.
- Adjust the charge pump current to help with loop filter component selection. Lower charge pump currents
 result in smaller components but may increase impacts of leakage and at the lowest values reduce PLL
 phase nosie performance.
- Clock Architect allows loading a custom phase noise plot for reference or VCXO block. Typically, a custom phase noise plot is entered for CLKin to match the reference phase noise to device; a phase noise plot for the VCXO can additionally be provided to match the performance of VCXO used. For improved accuracy in simulation and optimum loop filter design, be sure to load these custom noise profiles for use in application.
- PLLatinum Sim can also be used to design and simulate a loop filter.

9.2.2.3 Device Programming

Using the clock design tools configuration the TICS Pro software is manually updated with this information to meet the required application.

Frequency planning for assignment of outputs:

- To minimize crosstalk perform frequency planning / CLKout assignments to keep common frequencies on outputs close together.
- It is best to place common device clock output frequencies on outputs sharing the same V_{CC} group. For example, these outputs share Vcc4 CG2. Refer to Section 5 to see the V_{CC} groupings the clock outputs.

In this example, the 245.76-MHz ADC output needs the best performance. CLKout2 provides the best noise floor / performance. The 245.76 MHz is placed on CLKout2 with 10.24-MHz SYSREF on CLKout3.

- For best performance the input and output drive level bits may be set. Best noise floor performance is achieved with CLKout2 3 IDL = 1 and CLKout2 3 ODL = 1.
- The CLKoutX Y ODL bit has no impact on even clock outputs in high performance bypass mode.

In this example, the 983.04-MHz DAC output is placed on CLKout4 and CLKout6 with 10.24-MHz SYSREF on paired CLKout5 and CLKout7 outputs.

· These outputs share Vcc4 CG2.

In this example, the 122.88-MHz FPGA JESD204B output is placed on CLKout10 with 10.24-MHz SYSREF on paired CLKout11 output.

Additionally, the 122.88-MHz FPGA non-JESD204B outputs are placed on CLKout8 and CLKout9.

• When frequency planning, consider PLL2 as a clock output at the phase detector frequency. As such, these 122.88-MHz outputs have been placed on the outputs close to the PLL2 and Charge Pump power supplies.

Once the device programming is completed as desired in the TICS Pro software, it is possible to export the register settings from the Register tab for use in application.

9.2.3 Application Curves

Required Section for RTM



10 Power Supply Recommendations

10.1 Current Consumption

TI recommends using the TICS Pro software to calculate the current consumption estimate based on programmed configuration.

11 Layout

11.1 Layout Guidelines

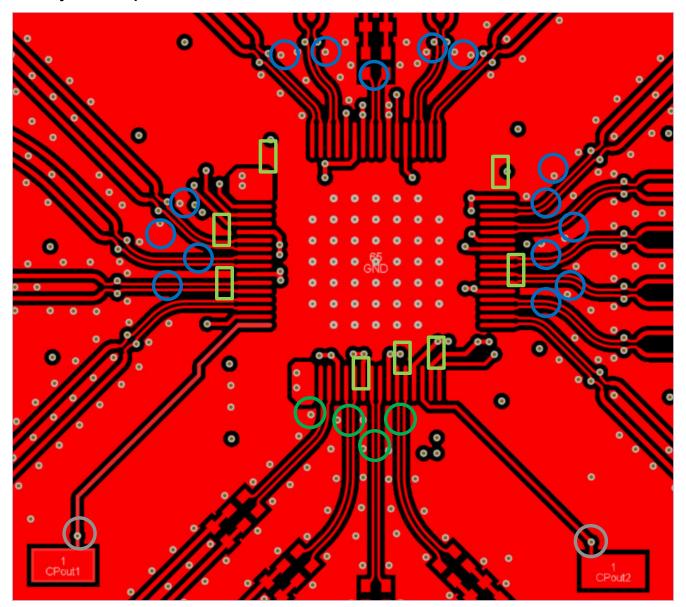
11.1.1 Thermal Management

Power consumption of the LMK04832-SP can be high enough to require attention from thermal management. For reliability and performance reasons the die temperature should be limited to a maximum of 125°C. That is, as an estimate, T_A (ambient temperature) plus device power consumption times $R_{\theta JA}$ should not exceed 125°C.

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11.2 Layout Example



CLKouts/OSCouts - Differential signals should be routed tightly coupled to minimize PCB crosstalk.

For LVPECL/LCPECL/CML place components resistors close to IC.

OSCout shares pins with CLKin2 and is programmable for input or output.

CLKin and OSCin - If differential input (preferred) route traces tightly coupled. If single ended, have at least 3-trace width (of CLKin/OSCin trace) separation from other RF traces. Place terminations close to IC. CLKin2 and

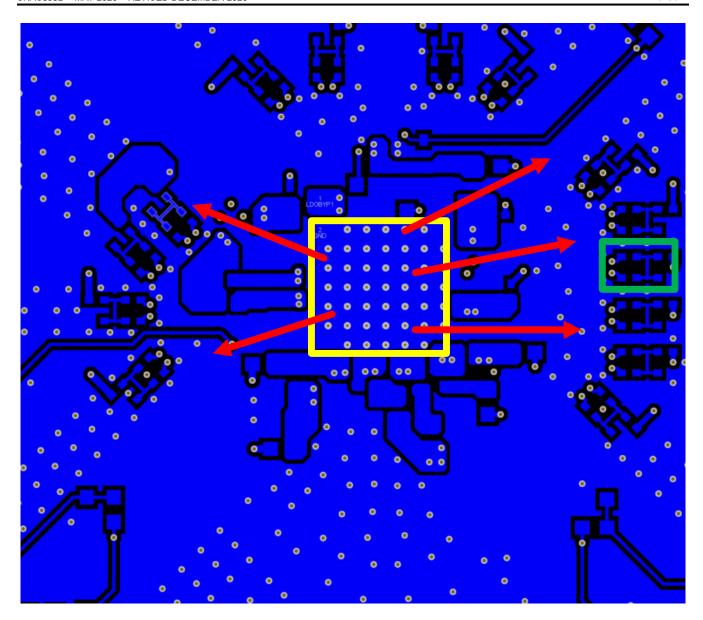
OSCout share pins and are programmable for input or output.

For CLKout Vccs in JESD204B application, Place the ferrite beads then a 1-μF capacitor. The 1-μF capacitor supports low-frequency SYSREF switching/turning on. For CLKout Vccs in traditional applications, place a ferrite bead on top layer close to pins to choke high-frequency noise from the via.

Charge pump output - shorter traces are better. Place all resistors and caps close to the IC.

Figure 11-1. Top Layer







Expose copper under the PCB to provide direct copper-to-air interface to dissipate heat.



A flexible termination / PCB layout for either CML requiring a pullup to Vcc or LVPECL/LCPECL requiring a pulldown to ground, or the H configuration for any other format as illustrated in layout above.



Provide areas of connect copper to allow heat to escape from directly below PCB. Do not let components block all thermal escape from the ground pad.

Figure 11-2. Bottom Layer

12 Device and Documentation Support

12.1 Device Support

12.1.1 Development Support

12.1.1.1 Clock Architect

Part selection, loop filter design, simulation.

To run the online Clock Architect tool, go to www.ti.com/clockarchitect.

12.1.1.2 PLLatinum Sim

Supports loop filter design and simulation. All simulation is for a single loop, to perform dual loop simulations, the result of the first PLL sim must be loaded as a reference to the second PLL sim.

To download PLLatinum Sim tool, go to www.ti.com/tool/PLLATINUMSIM-SW

12.1.1.3 TICS Pro

EVM programming software. Can also be used to generate register map for programming and calculate current consumption estimate.

For TICS Pro, go to www.ti.com/tool/TICSPRO-SW

12.2 Documentation Support

12.2.1 Related Documentation

For releated documentation, see the following:

• AN-912 Common Data Transmission Parameters and their Definitions (SNLA036)

12.3 Receiving Notification of Documentation Updates

To receive notification of documentation updates, navigate to the device product folder on ti.com. Click on *Subscribe to updates* to register and receive a weekly digest of any product information that has changed. For change details, review the revision history included in any revised document.

12.4 Support Resources

TI E2E™ support forums are an engineer's go-to source for fast, verified answers and design help — straight from the experts. Search existing answers or ask your own question to get the quick design help you need.

Linked content is provided "AS IS" by the respective contributors. They do not constitute TI specifications and do not necessarily reflect TI's views; see TI's Terms of Use.

12.5 Trademarks

TI E2E[™] is a trademark of Texas Instruments.

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12.6 Electrostatic Discharge Caution



This integrated circuit can be damaged by ESD. Texas Instruments recommends that all integrated circuits be handled with appropriate precautions. Failure to observe proper handling and installation procedures can cause damage.

ESD damage can range from subtle performance degradation to complete device failure. Precision integrated circuits may be more susceptible to damage because very small parametric changes could cause the device not to meet its published specifications.

12.7 Glossary

TI Glossary

This glossary lists and explains terms, acronyms, and definitions.



13 Mechanical, Packaging, and Orderable Information

The following pages include mechanical, packaging, and orderable information. This data is subject to change without notice and revision of this document.

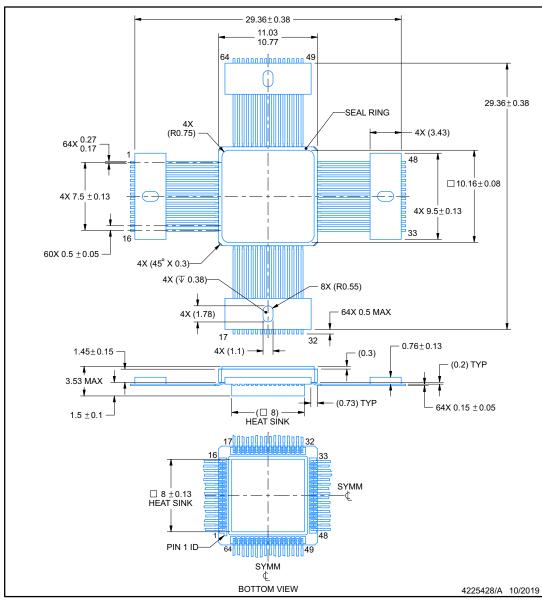
13.1 Package Outline

HBE0064B

PACKAGE OUTLINE

CFP - 3.53 mm max height

CERAMIC FLATPACK



NOTES:

- 1. All linear dimensions are in millimeters. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.

 2. This drawing is subject to change without notice.

 3. This package is hermetically sealed with a metal lid.

 4. Ground pad to be electronic connected to heat sink and seal ring.

- 5. The leads are gold plated and can be solder dipped.





PACKAGE OPTION ADDENDUM

9-Mar-2021

PACKAGING INFORMATION

| Orderable Device | Status (1) | Package Type | Package Drawing | Pins | Package Qty | Eco Plan | Lead finish/ Ball material | MSL Peak Temp | Op Temp (°C) | Device Marking (4/5) | Samples |
|------------------|------------|--------------|--------------------|------|----------------|--------------|-------------------------------|---------------|--------------|--------------------------------|---------|
| 5962R1723701VXC | ACTIVE | CFP | HBE | 64 | 1 | RoHS & Green | Call TI | Call TI | -55 to 125 | 5962R1723701VXC LMK04832-SP | Samples |
| LMK04832W/EM | ACTIVE | CFP | HBE | 64 | 1 | RoHS & Green | Call TI | Call TI | 25 to 25 | LMK04832W/EM | Samples |
| SN0064HBE | ACTIVE | CFP | HBE | 64 | 1 | TBD | Call TI | Call TI | 25 to 25 | SN0064 ES MECHANICAL | Samples |

(1) The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.

(2) RoHS: TI defines "RoHS" to mean semiconductor products that are compliant with the current EU RoHS requirements for all 10 RoHS substances, including the requirement that RoHS substance do not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, "RoHS" products are suitable for use in specified lead-free processes. TI may reference these types of products as "Pb-Free".

RoHS Exempt: TI defines "RoHS Exempt" to mean products that contain lead but are compliant with EU RoHS pursuant to a specific EU RoHS exemption.

Green: TI defines "Green" to mean the content of Chlorine (CI) and Bromine (Br) based flame retardants meet JS709B low halogen requirements of <=1000ppm threshold. Antimony trioxide based flame retardants must also meet the <=1000ppm threshold requirement.

- (3) MSL, Peak Temp. The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.
- (4) There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.
- (5) Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.
- (6) Lead finish/Ball material Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

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PACKAGE OPTION ADDENDUM

9-Mar-2021

In no event shall TI's liability arising out of such information exceed the total purchase price of the TI part(s) at issue in this document sold by TI to Customer on an annual basis.

OTHER QUALIFIED VERSIONS OF LMK04832-SP:

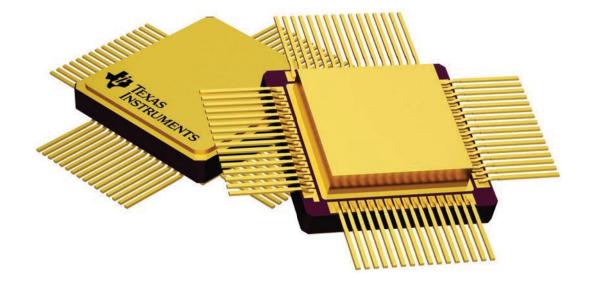
NOTE: Qualified Version Definitions:

• Catalog - TI's standard catalog product

10.9 x 10.9, 0.5 mm pitch

CERAMIC FLATPACK

This image is a representation of the package family, actual package may vary. Refer to the product data sheet for package details.



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